

# Flexible Resistive Input, Anti-Alias, 24-Bit, 1 MSPS, µModule DAQ Solution

#### **FEATURES**

- ▶ Highly integrated data acquisition solution
- ▶ 3 pin-selectable gain options: 1 (IN1), 0.364 (IN2), or 0.143 (IN3)
- ▶ Maximum input range of ±28.672 V differential (IN3)
- ▶ Wide input common-mode range: -16 V to +12 V (IN3)
- ▶ Fourth-order AAF with maximum flatness and linear phase
  - ▶ Anti-aliasing protection with 105 dB typical rejection (IN1)
- Excellent device-to-device phase matching and drift
- ▶ Combined precision AC and DC performance
  - ▶ Total system dynamic range up to 124.5 dB
  - ▶ -118 dB typical THD at ±28.672 V input range (IN3)
  - ▶ 78.0 dB typical DC CMRR at ±28.672 V input range (IN3)
  - ▶ ±3.8 ppm of FSR typical INL
  - ▶ 3.1 ppm/°C maximum gain error drift
  - ▶ ±0.096 maximum device-to-device phase angle mismatch at 20 kHz
- ▶ Programmable output data rate, filter type, and latency
  - ▶ Linear phase digital filter options:
    - ▶ Wideband low ripple FIR filter (256 kSPS, 110 kHz maximum input bandwidth)
    - Sinc5 filter (1024 kSPS, 208.9 kHz maximum input bandwidth, 4 μs maximum group delay)

- ► Sinc3 filter (50 Hz/60 Hz rejection)
- ▶ Integrated LDO
- ▶ Built-in supply decoupling capacitors
- ► Configuration through pin strapping or SPI
- ▶ Digital interface optimized for isolated applications
- ▶ Suite of diagnostic check mechanisms
- ▶ Operating temperature range: -40°C to +105°C
- ▶ Packaging: 12 mm × 6 mm × 1.6 mm, 84-ball CSP\_BGA with 0.8 mm ball pitch
  - ▶ 8× footprint reduction vs. discrete solution

#### **APPLICATIONS**

- ▶ Universal input measurement platform
- ▶ Electrical test and measurement
- Sound and vibration, acoustic and material science, research and development
- ► Control and hardware in loop verification
- ► Condition monitoring for predictive maintenance
- Audio test

#### **FUNCTIONAL BLOCK DIAGRAM**

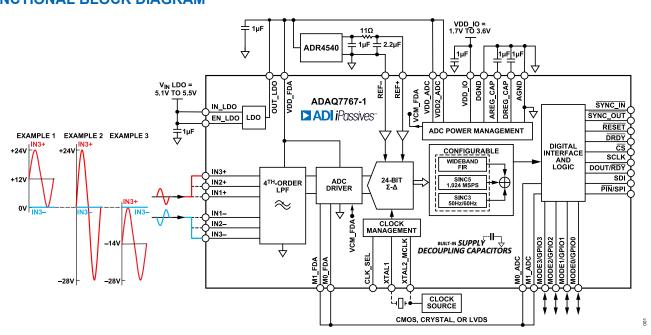


Figure 1. Functional Block Diagram

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ADC Diagnostics Output Register			

# **REVISION HISTORY**

3/2024—Revision 0: Initial Version

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#### **GENERAL DESCRIPTION**

The ADAQ7767-1<sup>1</sup> is a 24-bit precision data acquisition (DAQ) µModule® system that encapsulates signal conditioning, conversion, and processing blocks into one system in package (SiP) design that enables rapid development of highly compact, high performance precision DAQ systems.

The ADAQ7767-1 consists of the following:

- ▶ A fourth-order, low noise, linear phase anti-aliasing filter (AAF)
- ▶ A low noise, low distortion, high bandwidth, gain-selectable ADC driver plus an optional linearity boost buffer
- A high-performance medium bandwidth 24-bit Σ-Δ ADC with programmable digital filter
- ▶ A low noise, low dropout (LDO) linear regulator
- ▶ Reference buffers
- ▶ Critical passive components required for the signal chain

The ADAQ7767-1 supports a wide variety of input types, which include unipolar and bipolar single-ended, pseudo differential, and differential signals, with a maximum differential range of ±28.672 V and a common-mode voltage range of −16 V to +12 V using IN3. With the precision of Analog Devices iPASSIVES technology, the ADAQ7767-1 performs with excellent common-mode rejection ratio (CMRR). The three pairs of pin-selectable gain settings offer additional system dynamic range and improved signal chain noise performance with input signals of lower amplitude. In applications requiring high input impedance, the ADAQ7767-1 allows the customer to choose their preferred input amplifier.

A fourth-order low-pass analog filter combined with the user-programmable digital filter ensures that the signal chain is protected against the high frequency noise and out of band tones presented at the input node from aliasing back into the band of interest. The analog low pass filter is carefully designed to achieve high phase linearity and maximum in-band magnitude response flatness. Constructed with iPASSIVES technology, the resistor network used within the analog low-pass filter possess superior resistance matching in both absolute values and over temperature. As a result, the signal chain performance is maintained with minimum drift over temperature, and the ADAQ7767-1 has an excellent device-to-device phase matching performance.

A high-performance analog-to-digital (ADC) driver amplifier ensures the full settling of the ADC input at the maximum sampling rate. The driver circuit is designed to have minimum additive noise, error, and distortion while maintaining stability. The fully differential architecture helps maximizing the signal chain dynamic range.

The ADC inside the ADAQ7767-1 is a high performance, 24-bit precision, single-channel,  $\Sigma$ - $\Delta$  converter with excellent AC performance and DC precision, and a throughput rate of 1 MSPS from a 16.384 MHz MCLK. The device includes an optional linearity boost buffer that can further improve the signal chain linearity.

The ADAQ7767-1 is specified with an input reference voltage of 4.096 V, but the device can support reference voltages ranging from VDD ADC down to 1 V.

The ADAQ7767-1 has two types of reference buffers: a precharge reference buffer to ease the reference input driving requirement, or a full reference buffer to provide a high impedance reference input. Both buffers are optional and can be turned off through register configuration.

The ADAQ7767-1 supports three clock input types: crystal, complementary metal-oxide semiconductor (CMOS), or low voltage differential signaling (LVDS).

Three types of digital low pass filters are available on the ADAQ7767-1. The wideband, low ripple, finite impulse response (FIR) filter has a filter profile similar to an ideal brick wall filter. making it a great fit for doing frequency analysis. The sinc5 filter has a low latency path with a smooth step response while maintaining a good level of aliasing rejection. This filter supports an output data rate up to 1.024 MSPS from a 16.384 MHz MCLK, making the sinc5 filter ideal for low latency data capturing and time domain analysis. The sinc3 filter supports a wide decimation ratio and can produce output data rates down to 50 SPS from a 16.384 MHz controller clock signal (MCLK). This combined with the simultaneous 50 Hz/60 Hz rejection post filter makes the sinc3 filter especially useful for precision DC measurement. All three digital filters on the ADAQ7767-1 are FIR filters with linear phase response. The bandwidth of the filters, which directly corresponds to the bandwidth of the DAQ signal chain, are fully programmable through register configuration.

The ADAQ7767-1 supports two device configuration methods. The user has the option to choose to configure the device via register write through its serial peripheral interface (SPI) or through a simple hardware pin strapping method to configure the device to operate under a number of predefined modes.

A single SPI supports both the register access and the sample data readback functions. The ADAQ7767-1 always acts as a SPI target. Multiple interface modes are supported with a minimum of three input and output channels required to communicate with the device.

The ADAQ7767-1 features a suite of internal diagnostic functions that can detect a broad range of errors during operation to help improve system reliability.

The ADAQ7767-1 supply connections can be simplified by using its internal low dropout (LDO) regulator. Note that, 0.1  $\mu$ F decoupling capacitors are also integrated to further reduce the number of discrete components.

Each functional block of the device can be put into standby mode or power-down mode, enabling the ADAQ7767-1 to have a total power consumption less than 0.5 mW.

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<sup>&</sup>lt;sup>1</sup> Protected by U.S. Patents 10,680,633 B1 and 10,979,062 B2.

# **GENERAL DESCRIPTION**

The ADAQ7767-1 has an operating temperature range of -40°C to +105°C and is available in a 12 mm x 6 mm, 84-ball CSP\_BGA package with 0.8 mm ball pitch, making it suitable for multiple-channel applications. The footprint of the ADAQ7767-1 is eight times smaller compared to the footprint of the same solution using discrete components.

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### **SPECIFICATIONS**

AGND = DGND = 0 V, input common-mode voltage = 0 V, IN\_LDO = EN\_LDO = 5.1 V to 5.5 V, OUT\_LDO = VDD\_FDA = VDD\_ADC, VDD2\_ADC = 2 V to 5.5 V, VDD\_IO = 1.7 V to 3.6 V, REF+ = 4.096 V, REF- = 0 V, main clock (MCLK) = SCLK = 16.384 MHz, 50:50 duty cycle,  $\Sigma$ - $\Delta$  modulator clock rate of the core ADC (f<sub>MOD</sub>)= MCLK/2, filter = wideband low ripple, decimation = 32, output data rate (ODR) = 256 kSPS, linearity boost buffer on, reference precharge buffers on, fully differential amplifier (FDA) = full power mode, and T<sub>A</sub> = -40°C to +105°C, unless otherwise noted. Typical values are at T<sub>A</sub> = 25°C.

Table 1. Specifications

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
ANALOG INPUT CHARACTERISTICS					
Full-Scale Input Range (FSR)	Differential INx+ to INx-, FSR = ±reference voltage (±V <sub>REF</sub> )/analog front-end gain (AFE_GAIN)				
	Differential IN1		±4.096		V
	Differential IN2		±11.264		V
	Differential IN3		±28.672		V
Input Common-Mode Voltage Range (V <sub>ICM</sub> )	IN1+ and IN1-	-2.1	120.072	+4.5	V
input common wode voltage range (V <sub>ICM</sub> )	IN2+ and IN2-	-6.1		+6.2	V
	IN3+ and IN3-	-16		+12	V
AFE_GAIN	IN1, G = 1	10	1	. 12	V/V
711 2_071111	IN2, G = 0.364		4/11		V/V
	IN3, G = 0.143		1/7		V/V
Common-Mode Rejection DC	DC to 60 Hz, relative to input (RTI)		.,,		""
	IN1, V <sub>ICM</sub> = -2.1 V to +4.5 V	70.0	80.5		dB
	$IN2, V_{ICM} = -6.1 \text{ V to } +6.2 \text{ V}$	66.0	75.0		dB
	IN3, V <sub>ICM</sub> = -12 V to +12 V	66.0	78.0		dB
Common-Mode Rejection AC	f = 10 kHz, RTI		. 5.5		"-
Common Mode Pojection 7.0	IN1		90		dB
	IN2		77		dB
	IN3		81		dB
Input Resistance, R <sub>IN</sub>	Fully Differential Configuration				
	IN1+ and IN1-		4		kΩ
	IN2+ and IN2-		11		kΩ
	IN3+ and IN3-		28		kΩ
	Single-ended to differential configuration				
	IN1+ = input and IN1- = GND		2.67		kΩ
	IN2+ = input and IN2- = GND		6.35		kΩ
	IN3+ = input and IN3- = GND		14.93		kΩ
VERALL SYSTEM DC ACCURACY					
Gain Error	RTI				
	IN1	-0.23	-0.06	+0.08	%
	IN2	-0.15	-0.03	+0.08	%
	IN3	-0.08	+0.01	+0.09	%
Gain Error Drift <sup>1</sup>	RTI, endpoint method				
	IN1	-0.8	+1.1	+3.1	ppm/°C
	IN2	-1.5	+0.18	+1.9	ppm/°C
	IN3	-2.3	+0.33	+3.0	ppm/°C
Offset Error	RTI				
	IN1		±0.5	±1.4	mV
	IN2		±0.8	±2.5	mV
	IN3		±1.1	±4.7	mV

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## **SPECIFICATIONS**

Table 1. Specifications (Continued)

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
Offset Error Drift <sup>1</sup>	RTI, endpoint method				
	IN1	-14.2	-3.2	+7.7	μV/°C
	IN2	-26.8	-5.9	+15.1	μV/°C
	IN3	-56.8	-12.6	+31.4	μV/°C
Integral Nonlinearity (INL) <sup>1, 2</sup>	All FSR, endpoint method, differential input,		±3.8	±8.5	ppm of FSR
3 , ( )	-40°C < T <sub>A</sub> < +105°C				''
Low Frequency Noise	Sinc3 filter, ODR = 50 SPS, bandwidth = 15 Hz,				
	shorted input, RTI				
	IN1		0.47		μV RMS
	IN2		1.19		μV RMS
	IN3		3.22		μV RMS
Peak-to-Peak Resolution <sup>3</sup>	All FSR, sinc3 filter, ODR = 50 SPS, bandwidth = 15 Hz, shorted input		21.3		Bits
OVERALL SYSTEM AC PERFORMANCE	Wideband low ripple FIR filter, ODR = 256 kSPS, DEC_RATE = 32, bandwidth = 110.8 kHz				
Dynamic Range <sup>4</sup>	Shorted input, T <sub>A</sub> = 25°C				
-	IN1, differential input range	105.5	107.6		dB
	IN2, differential input range	105.5	107.8		dB
	IN3, differential input range	105.0	107.8		dB
	Total system, differential input range	122.4	124.5		dB
Noise Spectral Density	RTI, shorted input at 1 kHz				
,	IN1		37		nV/√Hz
	IN2		98		nV/√Hz
	IN3		248		nV/√Hz
Total RMS Noise	RTI, shorted input		2.0		,=
Total Time Holds	IN1		12.1		μV RMS
	IN2		32.5		μV RMS
	IN3		82.6		μV RMS
Signal-to-Noise Ratio (SNR)	Differential sine-wave input, 1 kHz tone, T <sub>A</sub> = 25°C		02.0		μν πινιο
	IN1, -0.5 dBFS (3.9 V <sub>P</sub> )	102.8	105.6		dB
	IN2, -0.5 dBFS (10.6 V <sub>P</sub> )	101.7	105.8		dB
	IN3, -0.5 dBFS (27.0 V <sub>P</sub> )		106.0		dB
	IN3, -1.54 dBFS (24.0 V <sub>P</sub> )	102.2			dB
Total Harmonic Distortion (THD)	-0.5 dBFS, differential sine-wave input, 1 kHz				
	tone				
	IN1, 3.9 V <sub>P</sub>		-120		dB
	IN2, 10.6 V <sub>P</sub>		-118		dB
	IN3, 27.0 V <sub>P</sub>		-118		dB
Signal-to-Noise and Distortion Ratio (SINAD)	Differential sine-wave input, 1 kHz tone, T <sub>A</sub> = 25°C				
	IN1, -0.5 dBFS (3.9 V <sub>P</sub> )	102.7	105.4		dB
	IN2, -0.5 dBFS (10.6 V <sub>P</sub> )	101.7	105.5		dB
	IN3, -0.5 dBFS (27.0 V <sub>P</sub> )		105.7		dB
	IN3, -1.54 dBFS (24.0 V <sub>P</sub> )	101.9			dB
Spurious-Free Dynamic Range (SFDR)	-0.5 dBFS, differential sine-wave input, 1 kHz tone				
	IN1		-123		dBc
	IN2		-122		dBc
	IN3		-121		dBc

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## **SPECIFICATIONS**

Table 1. Specifications (Continued)

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
Intermodulation Distortion (IMD)	Input Frequency A ( $f_{IN\_A}$ ) = 9 kHz, Input Frequency B ( $f_{IN\_B}$ ) = 10 kHz				
	IN1, second order		-123		dBc
	IN1, third order		-125		dBc
	IN2, second order		-123		dBc
	IN2, third order		-120		dBc
	IN3, second order		-124		dBc
	IN3, third order		-114		dBc
NALOG FRONT-END MAGNITUDE AND PHASE PERFORMANCE	into, unita order		1117		ubo
Anti-Aliasing Filter Bandwidth	-3 dB relative to signal amplitude at DC				
, and , and only , mer Danaman	IN1		365		kHz
	IN2		304		kHz
	IN3		283		kHz
Analog Group Delay	f <sub>IN</sub> = 20 kHz		200		MIZ
, alalog Group Bolay	IN1		0.81		lie
	IN2		1.02		μs
	IN3		1.02		μs
Phase Angle Drift <sup>1, 5, 6</sup>			1.13		μs
Filase Aligie Diliting 5	f <sub>IN</sub> = 20 kHz   IN1	0.02	n 22	0.41	m°/°C
	I .	1	0.22		l l
	IN2	0.09	0.28	0.47	m°/°C
Device-to-Device Phase Angle Mismatch <sup>1, 5, 6</sup>	IN3 Input frequency $(f_{IN}) = 20 \text{ kHz}$ , typical = $\pm 1  \sigma$ , $T_A$ = $25^{\circ}\text{C}$	0.15	0.50	0.85	m°/°C
	IN1	-0.078	±0.013	+0.078	Degrees
	IN2	-0.090	±0.015	+0.090	Degrees
	IN3	-0.096	±0.013	+0.096	Degrees
Device-to-Device Phase Angle Mismatch Drift <sup>1</sup> , 5, 6	f <sub>IN</sub> = 20 kHz, typical = change in  1σ  per °C	0.090	10.010	10.030	Degrees
	IN1		-3.0	-18.0	μ°/°C
	IN2		-2.9	-17.4	μ°/°C
	IN3		-3.2	-19.2	μ°/°C
Magnitude Flatness	f <sub>IN</sub> = 20 kHz, IN1		0.005		dB
	f <sub>IN</sub> = 100 kHz, IN1		0.050		dB
	f <sub>IN</sub> = 20 kHz, IN2		0.005		dB
	f <sub>IN</sub> = 100 kHz, IN2		-0.020		dB
	f <sub>IN</sub> = 20 kHz, IN3		0.020		dB
	f <sub>IN</sub> = 100 kHz, IN3		-0.090		dB
Alias Rejection	-10 dBFS input signal		0.030		QD
Alias Nojeolion	IN1 at MCLK = 16.384 MHz		105		dB
	IN2 at MCLK = 16.384 MHz		84		dB
	IN3 at MCLK = 16.384 MHz		65		dB
DC SPEED AND PERFORMANCE	INS at WICEN - 10.304 WITZ				UB
ODR <sup>7</sup>	Widehand law ripple EIP	0		256	kene
	Wideband low ripple FIR	8		256	kSPS
	Sinc5	8		1024	kSPS
N. W	Sinc3	0.05		256	kSPS
No Missing Codes	Wideband low ripple FIR, decimation ratio ≥ 32	24			Bits
	Sinc5 filter, decimation ratio ≥ 32	24			Bits

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# **SPECIFICATIONS**

Table 1. Specifications (Continued)

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
	Sinc3 filter, decimation ratio ≥ 64	24			Bits
Data Output Coding		T\	wos complement, MS	SB first	
REFERENCE INPUT CHARACTERISTICS					
REFIN Voltage	REFIN = (REF+) - (REF-)	1		VDD_ADC - AGND	V
Absolute REFIN Voltage Limit	Reference unbuffered	AGND - 0.05		VDD_ADC + 0.05	V
•	Reference buffer on	AGND		VDD_ADC	V
	Reference precharge buffer on	AGND		VDD_ADC	V
Average REFIN Current	Reference unbuffered		±80	_	μΑ/V
,	Reference precharge buffer on		±20		μA
	Reference buffer on		±300		nA
Average REFIN Current Drift	Reference unbuffered		±1.7		nA/V/°C
7.1.0.2go 1.2	Reference precharge buffer on		125		nA/°C
	Reference buffer on		4		nA/°C
Common Mode Rejection	Up to 10 MHz		100		dB
DIGITAL FILTER RESPONSE	OP 10 10 11112		100		45
Wideband Low Ripple FIR Filter					
Decimation Rate	Six selectable decimation rates	32		1024	
Output Data Rate	OIX Selectable declination rates	32		256	kSPS
Group Delay	Latency		34/ODR	230	Sec
Settling Time	Complete settling		68/ODR		Sec
Pass-Band Ripple	Complete setting		00/ODK	±0.005	dB
• •	0.005 4D		0.4 % ODD	10.003	
Pass Band	-0.005 dB		0.4 × ODR		Hz
	-0.1dB pass band		0.409 × ODR		Hz
01 B 15	-3 dB bandwidth		0.433 × ODR		Hz
Stop-Band Frequency	Attenuation > 105 dB	405	0.499 × ODR		Hz
Stop-Band Attenuation		105			dB
Sinc5 Filter					
Decimation Rate	Eight selectable decimation rates	8		1024	
Output Data Rate				1.024	MSPS
Group Delay	Latency		<3/ODR		Sec
Settling Time	Complete settling		<6/ODR		Sec
Pass Band	−0.1 dB bandwidth		0.0376 × ODR		Hz
	−3 dB bandwidth		0.204 × ODR		Hz
Sinc3 Filter					
Decimation Rate	1024 decimation rates	32		185,280	
Output Data Rate				256	kSPS
Group Delay	Latency		2/ODR		Sec
Settling Time	Complete settling to reject 50 Hz		60		ms
Pass Band	−0.1 dB bandwidth		0.0483 × ODR		Hz
	−3 dB bandwidth		0.2617 × ODR		Hz
CLOCK					
External Clock MCLK		0.6	16.384	17	MHz
Internal Clock MCLK			16.384		MHz
Input High Voltage	See to logic input parameter				
Duty Cycle	16.384 MHz MCLK	25:75	50:50	25:75	%
MCLK Logic Low Pulse Width		16			ns
MCLK Logic High Pulse Width		16			ns
Crystal Frequency		8	16	17	MHz

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## **SPECIFICATIONS**

Table 1. Specifications (Continued)

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
Crystal Start-Up Time	Clock output valid		2		ms
ADC RESET					
ADC Start-Up Time after Reset	Reset rising edge to first $\overline{DRDY}$ , $\overline{PIN}$ mode, decimate by 8		100		μs
Minimum RESET Low Pulse Width		0.0001		100	ms
LOGIC INPUTS	Applies to all logic inputs, unless otherwise noted, and voltage referenced to AGND				
Input High Voltage, V <sub>INH</sub>	1.7 V ≤ VDD IO ≤ 1.9 V	0.65 × VDD 10			V
parring remage, rinn	2.22 V ≤ VDD IO ≤ 3.6 V	0.65 × VDD IO			V
Input Low Voltage, V <sub>INL</sub>	1.7 V ≤ VDD IO ≤ 1.9 V			0.35 × VDD 1O	V
1 3 / INL	2.22 V ≤ VDD IO ≤ 3.6 V			0.7	V
Hysteresis	2.22 V ≤ VDD_IO ≤ 3.6 V	0.08		0.25	V
,	1.7 V ≤ VDD_IO ≤ 1.9 V	0.04		0.2	V
Leakage Current	Excluding RESET pin	-10	+0.05	+10	μA
	RESET pin pull-up resistor		1		kΩ
M0_FDA and M1_FDA	Voltage referenced to AGND				
Input High Voltage		1.4			V
Input Low Voltage				1	V
Input Current	M0_FDA or M1_FDA = 0 V to 5 V		-10		μA
EN_LDO	Voltage referenced to AGND				
Input High Voltage	5.1 V ≤ IN_LDO ≤ 5.5 V	1.2			V
Input Low Voltage				0.4	V
Input Current	EN LDO = IN LDO or GND		0.1		μA
LOGIC OUTPUTS					
Output High Voltage	2.2 V ≤ VDD_IO < 3.6 V, source current (I <sub>SOURCE</sub> ) = 500 µA, LV_BOOST off	0.8 × VDD_IO			V
	1.7 V ≤ VDD_IO ≤ 1.9 V, I <sub>SOURCE</sub> = 200 μA, LV_BOOST on	0.8 × VDD_IO			V
Output Low Voltage	2.2 V ≤ VDD_IO < 3.6 V, sink current (I <sub>SINK</sub> ) = 1 mA, LV_BOOST off			0.4	V
	1.7 V $\leq$ VDD_IO $\leq$ 1.9 V, I <sub>SINK</sub> = 400 $\mu$ A, LV_BOOST on			0.4	V
Leakage Current	Floating state	-10		+10	μA
Output Capacitance	Floating state		10		pF
LDO CHARACTERISTIC					
Input Voltage (V <sub>IN</sub> ) Range		5.1		5.5	V
IN_LDO Supply Current	OUT_LDO load current = 20 mA		80		μA
OUT_LDO Voltage		4.80	4.90	5.03	V
Load Regulation	Output current (I <sub>OUT</sub> ) = 1 mA to 20 mA		0.0005		%/mA
Dropout Voltage <sup>8</sup>	I <sub>OUT</sub> = 20 mA		3		mV
Start-Up Time <sup>9</sup>			350		μs
Current-Limit Threshold			500		mA
Thermal Shutdown Threshold			150		°C
Thermal Shutdown Hysteresis			15		°C
POWER REQUIREMENTS					
VDD_FDA	Referenced to AGND	4.75	5	5.5	V
VDD_ADC	Referenced to AGND	4.75	5	5.5	V
VDD2_ADC	Referenced to AGND	2	2.5	5.5	V
VDD_IO	Referenced to AGND	1.7	1.8	3.6	V

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### **SPECIFICATIONS**

Table 1. Specifications (Continued)

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
POWER SUPPLY REJECTION	Referred to output (RTO), DC to 100 Hz				
VDD_FDA	Step voltage (V <sub>STEP</sub> ) = 0.2 V p-p		105		dB
VDD_ADC	V <sub>STEP</sub> = 0.2 V p-p		85		dB
VDD2_ADC	V <sub>STEP</sub> = 0.2 V p-p		105		dB
VDD_IO	V <sub>STEP</sub> = 0.2 V p-p		100		dB
LDO	V <sub>STEP</sub> = 0.2 V p-p		130		dB
POWER SUPPLY CURRENT	1 1 2				
VDD_FDA	1 kHz sine input with common mode = AGND				
_	IN1, 4 V <sub>P</sub>		5.2		mA RMS
	IN2, 11 V <sub>P</sub>		4.9		mA RMS
	IN3, 24 V <sub>P</sub>		4.5		mA RMS
	DC input with common mode = AGND				
	IN1, 4 V DC		5.4		mA
	IN2, 11 V DC		5.1		mA
	IN3, 24 V DC		4.7		mA
	INx+ = INx- = AGND				
	IN1+ = IN1- = AGND		4.8		mA
	IN2+ = IN2- = AGND		4.4		mA
	IN3+ = IN3- = AGND		4.2		mA
	Standby		90		μA
VDD_ADC	Linearity boost buffer on, reference precharge		6.3		mA
_	buffer on				
	Linearity boost buffer off, reference precharge buffers off		2.4		mA
	Standby		205		μA
VDD2_ADC			4.7		mA
	Standby		30		μA
VDD_IO					
Sinc3 Filter			3.7		mA
Sinc5 Filter			3.7		mA
Wideband Low Ripple FIR Filter			9.5		mA
Standby			380		μA
POWER DISSIPATION	IN_LDO = EN_LDO = 5.3 V, OUT_LDO =				
	VDD_FDA = VDD_ADC = VDD2_ADC, VDD_IO				
	= 3.3 V, linearity boost buffer on, reference				
Full On continue Made	precharge buffer on, external CMOS MCLK				
Full Operating Mode	INI. INI. ACAID		00		\^/
Sinc3 Filter	INx + = INx - = AGND		96		mW
Sinc5 Filter	INX+ = INX- = AGND		96		mW
Wideband Low Ripple FIR Filter	INx+ = INx- = AGND		115		mW
	Full scale 1 kHz sine input with common mode = AGND		117		mW
Standby Mode	FDA in standby mode, and ADC in standby mode		2.98		mW
ADC Power-Down	FDA in standby mode, and ADC in power-down mode		0.5		mW

 $<sup>^{1}</sup>$  Limits calculated based on the characterization data of 105 samples from three nominal wafers from  $-40^{\circ}$ C to  $+105^{\circ}$ C.

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<sup>&</sup>lt;sup>2</sup> Specification is not production tested but is supported by characterization data at initial product release.

<sup>&</sup>lt;sup>3</sup> See Terminology for peak-to-peak resolution. Noise used in calculation is listed under the low frequency noise specification.

#### **SPECIFICATIONS**

- 4 See the Noise Performance section for further information on dynamic range and noise across different gain and filter configurations.
- <sup>5</sup> See the Calculations on AFE Phase Performance section for analog front-end (AFE) performance, terminology, and calculation.
- <sup>6</sup> Tester repeatability and reproducibility guard band is not included.
- ODR ranges refer to the programmable decimation rates available on the ADAQ7767-1 for a fixed MCLK of 16.384 MHz across varying MCLK\_DIV and decimation rates. See the ADC Speed and Performance section for suggestion on the ODR speed to achieve optimum performance.
- Dropout voltage is defined as the input-to-output voltage differential when the input voltage is set to the nominal output voltage. This voltage applies only for output voltages greater than 2.3 V.
- 9 Start-up time is defined as the time between the rising edge of EN\_LDO to output voltage (OUT\_LDO) being at 90% of its nominal value.

#### **TIMING SPECIFICATIONS**

VDD\_ADC = 4.5 V to 5.5 V, VDD2\_ADC = 2.0 V to 5.5 V, VDD\_IO = 2.2 V to 3.6 V, AGND = DGND = 0 V, Input Logic 0 = 0 V, Input Logic 1 = VDD\_IO, load capacitance (C<sub>LOAD</sub>) = 20 pF, and LV\_BOOST bit (Bit 7, INTERFACE\_FORMAT register, Register 0x14) disabled, unless otherwise noted.

These specifications were sample tested during the initial release to ensure compliance. All input signals are specified with rise time ( $t_R$ ) = fall time ( $t_F$ ) = 5 ns (10% to 90% of VDD IO and timed from a voltage level of VDD IO/2). See Figure 2 to Figure 8 for the timing diagrams.

These specifications are not production tested but are supported by characterization data at initial product release.

Table 2. Timing Specifications

Parameter	Description	Test Conditions/Comments	Min	Тур	Max	Unit
MCLK	Controller clock frequency			16.384	17	MHz
MCLK_HIGH	MCLK high time		16			ns
MCLK_LOW	MCLK low time		16			ns
MOD	Modulator frequency	MCLK_DIV = 11		MCLK/2		Hz
		MCLK_DIV = 10		MCLK/4		Hz
		MCLK_DIV = 01		MCLK/8		Hz
		MCLK_DIV = 00		MCLK/16		Hz
DRDY	Conversion period	Rising DRDY edge to next rising DRDY edge, continuous conversion mode		f <sub>MOD</sub> /DEC_RATE		Hz
DRDY_HIGH	DRDY high time	t <sub>MCLK</sub> = 1/MCLK	t <sub>MCLK</sub> - 5	1 × t <sub>MCLK</sub>		ns
t <sub>MCLK_DRDY</sub>	MCLK to DRDY	Rising MCLK edge to DRDY rising edge	10	13	18	ns
t <sub>MCLK_RDY</sub>	MCLK to $\overline{\text{RDY}}$ indicator on the DOUT/ $\overline{\text{RDY}}$ pin	Rising MCLK edge to RDY falling edge	10	13	18	ns
UPDATE	ADC data update	Time prior to DRDY rising edge where the ADC conversion register updates, single conversion read		1 × t <sub>MCLK</sub>		ns
START	START pulse width		1.5 × t <sub>MCLK</sub>			ns
MCLK_SYNC_OUT	MCLK to SYNC_OUT	Falling MCLK to falling SYNC_OUT			t <sub>MCLK</sub> + 16	ns
SCLK	SCLK period		50			ns
1	CS falling to SCLK falling		0			ns
2	CS falling to data output enable				6	ns
3	SCLK falling edge to data output valid			10	15	ns
4	Data output hold time after SCLK falling edge		4			ns
5	SDI setup time before SCLK rising edge		3			ns
6	SDI hold time after SCLK rising edge		8			ns
7	CS high time	4-wire interface	10			ns
8	SCLK high time		20			ns
9	SCLK low time		20			ns
10	SCLK rising edge to DRDY high	Single conversion read only; time from last SCLK rising edge to DRDY high	1 × t <sub>MCLK</sub>			ns

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#### **SPECIFICATIONS**

Table 2. Timing Specifications (Continued)

Parameter	Description	Test Conditions/Comments	Min	Тур	Max	Unit
t <sub>11</sub>	SCLK rising edge to CS rising edge		6			ns
t <sub>12</sub>	CS rising edge to DOUT/RDY output disable		4		7	ns
t <sub>13</sub>	DOUT/RDY indicator pulse width	In continuous read mode with RDY on, DOUT enabled, with SCLK idling high		1 × t <sub>MCLK</sub>		ns
14	CS falling edge to SCLK rising edge		2			ns
t <sub>15</sub>	SYNC_IN setup time before MCLK rising edge		2			ns
t <sub>16</sub>	SYNC_IN pulse width		1.5 × t <sub>MCLK</sub>			ns
t <sub>17</sub>	SCLK rising edge to RDY indicator rising edge	In continuous read mode with RDY enabled on DOUT	1			ns
t <sub>18</sub>	DRDY rising edge to SCLK falling edge	In continuous read mode with $\overline{\text{RDY}}$ enabled on DOUT	8			ns

#### 1.8 V TIMING SPECIFICATIONS

VDD\_ADC = 4.5 V to 5.5 V, VDD2\_ADC = 2 V to 5.5 V, VDD\_IO = 1.7 V to 1.9 V, AGND = DGND = AGND2\_ADC = 0 V, Input Logic 0 = 0 V, Input Logic 1 = VDD\_IO, C<sub>LOAD</sub> = 20 pF, and LV\_BOOST bit (Bit 7, INTERFACE\_FORMAT register, Register 0x14) enabled, unless otherwise noted.

These specifications were sample tested during the initial release to ensure compliance. All input signals are specified with  $t_R = t_F = 5$  ns (10% to 90% of VDD\_IO and timed from a voltage level of VDD\_IO/2. See Figure 2 to Figure 8 for the timing diagrams.

These specifications are not production tested but are supported by characterization data at initial product release.

Table 3. 1.8 V Timing Specifications

Parameter	Description	Test Conditions/Comments	Min	Тур	Max	Unit
MCLK	Frequency			16.384	17	MHz
t <sub>MCLK_HIGH</sub>	MCLK high time		16			ns
t <sub>MCLK_LOW</sub>	MCLK low time		16			ns
$f_{MOD}$	Modulator frequency	MCLK_DIV = 11		MCLK/2		Hz
		MCLK_DIV = 10		MCLK/4		Hz
		MCLK_DIV = 01		MCLK/8		Hz
		MCLK_DIV = 00		MCLK/16		Hz
t <sub>DRDY</sub>	Conversion period	Rising DRDY edge to next rising DRDY edge, continuous conversion mode		f <sub>MOD</sub> /DEC_RATE		Hz
t <sub>DRDY_HIGH</sub>	DRDY high time	t <sub>MCLK</sub> = 1/MCLK	t <sub>MCLK</sub> - 5	1 × t <sub>MCLK</sub>		ns
t <sub>MCLK_DRDY</sub>	MCLK to DRDY	Rising MCLK edge to DRDY rising edge	13	19	25	ns
t <sub>MCLK_RDY</sub>	MCLK to RDY indicator on the DOUT/RDY pin	Rising MCLK edge to RDY falling edge	13	19	25	ns
t <sub>UPDATE</sub>	ADC data update	Time prior to DRDY rising edge where the ADC conversion register updates		1 × t <sub>MCLK</sub>		ns
t <sub>START</sub>	START pulse width		1.5 × t <sub>MCLK</sub>			ns
t <sub>MCLK_SYNC_OUT</sub>	MCLK to SYNC_OUT	Falling MCLK to falling SYNC_OUT, see the Synchronization of Multiple ADAQ7767-1 Devices section			t <sub>MCLK</sub> + 31	ns
t <sub>SCLK</sub>	SCLK period		50			ns
t <sub>1</sub>	CS falling to SCLK falling		0			ns
t <sub>2</sub>	CS falling to data output enable				11	ns
t <sub>3</sub>	SCLK falling edge to data output valid			14	19	ns
t <sub>4</sub>	Data output hold time after SCLK falling edge		7			ns

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### **SPECIFICATIONS**

Table 3. 1.8 V Timing Specifications (Continued)

Parameter	Description	Test Conditions/Comments	Min Typ	Max	Unit
t <sub>5</sub>	SDI setup time before SCLK rising edge		3		ns
$t_6$	SDI hold time after SCLK rising edge		8		ns
t <sub>7</sub>	CS high time	4-wire interface	10		ns
t <sub>8</sub>	SCLK high time		23		ns
t <sub>9</sub>	SCLK low time		23		ns
t <sub>10</sub>	SCLK rising edge to DRDY high	Time from last SCLK rising edge to DRDY high; if this is exceeded, conversion N + 1 is missed; single conversion read	1 × t <sub>MCLK</sub>		ns
t <sub>11</sub>	SCLK rising edge to $\overline{\text{CS}}$ rising edge		6		ns
t <sub>12</sub>	CS rising edge to DOUT/RDY output disable		7.5	13	ns
t <sub>13</sub>	DOUT/RDY indicator pulse width	In continuous read mode with RDY on, DOUT enabled, with SCLK idling high	1 × t <sub>MCLK</sub>		ns
t <sub>14</sub>	CS falling edge to SCLK rising edge		2.5		ns
15	SYNC_IN setup time before MCLK		2		ns
	rising edge				
t <sub>16</sub>	SYNC_IN pulse width		1.5 × t <sub>MCLK</sub>		ns
t <sub>17</sub>	SCLK rising edge to $\overline{RDY}$ indicator rising edge	In continuous read mode with $\overline{\text{RDY}}$ on, DOUT enabled	5.5		ns
t <sub>18</sub>	DRDY rising edge to SCLK falling edge	In continuous read mode with $\overline{\text{RDY}}$ on, DOUT enabled	15		ns

# **Timing Diagrams**

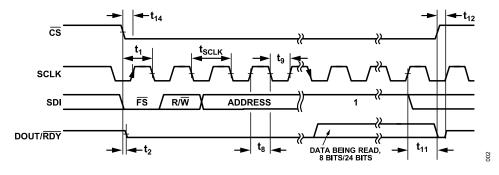


Figure 2. SPI Read Timing Diagram

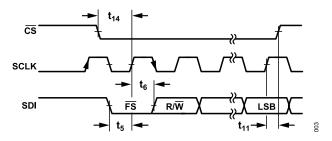


Figure 3. SPI Write Timing Diagram

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### **SPECIFICATIONS**

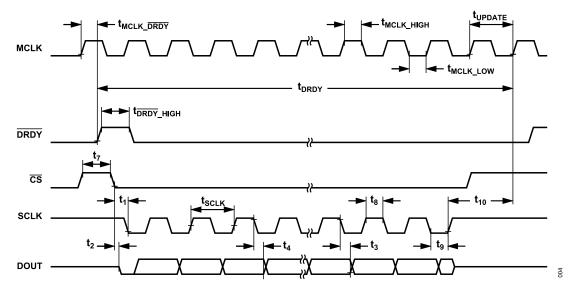


Figure 4. Reading Conversion Result in Continuous Conversion Mode (CS Toggling)

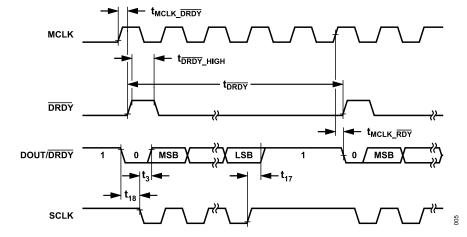


Figure 5. Reading Conversion Result in Continuous Conversion Mode, Continuous Read Mode with RDY Enabled (CS Held Low)

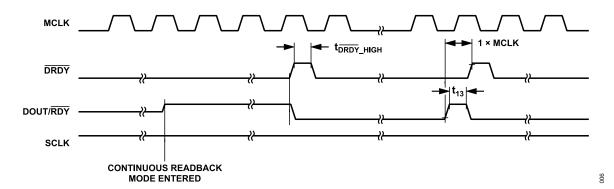


Figure 6. DOUT/ $\overline{RDY}$  Behavior Without SCLK Applied

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## **SPECIFICATIONS**

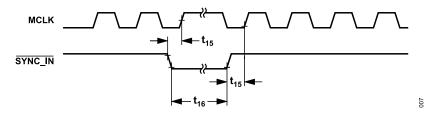


Figure 7. Synchronous SYNC\_IN Pulse

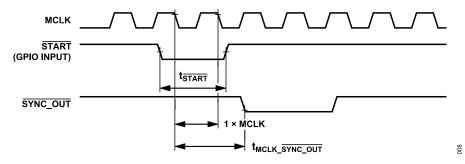


Figure 8. Asynchronous START and SYNC\_OUT

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#### **ABSOLUTE MAXIMUM RATINGS**

Table 4. Absolute Maximum Ratings

Parameter	Rating
IN1+ and IN1- to AGND	±15 V
IN2+ and IN2- to AGND	±15 V
IN3+ and IN3- to AGND	±36 V
VDD_FDA to VDD_ADC	-0.3 V to +0.3 V
VDD_FDA to AGND	-0.3 V to +6.5 V
M0_FDA and M1_FDA to AGND	-0.3 V to VDD_FDA + 0.3 V
IN_LDO to AGND	-0.3 V to +6.5 V
EN_LDO to AGND	-0.3 V to +6.5 V
OUT_LDO to AGND	-0.3 V to IN_LDO
VDD_ADC to AGND	-0.3 V to +6.5 V
VDD2_ADC to AGND	-0.3 V to +6.5 V
VDD_IO to DGND	-0.3 V to +6.5 V
DGND to AGND	-0.3 V to +0.3 V
VDDIO, DREG_CAP to DGND	-0.3 V to +2.25 V
(VDD_IO tied to DREG_CAP for 1.8 V	
Operation)	
REF+ and REF- to AGND	-0.3 V to VDD_ADC + 0.3 V
Digital Input Voltage to DGND	-0.3 V to VDD_IO + 0.3 V
Digital Output Voltage to DGND	-0.3 V to VDD_IO + 0.3 V
XTAL1 to DGND	-0.3 V to +2.1 V
Temperature	
Operating Range	-40°C to +105°C
Storage Range	-65°C to +150°C
Pb-Free, Soldering Reflow (10 sec to 30 sec)	260°C
Maximum Package Classification	260°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

#### THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

 $\theta_{JA}$  is the natural convection junction-to-ambient thermal resistance measured in a one cubic foot sealed enclosure.  $\theta_{JC\_TOP}$  is the top junction-to-case thermal resistance, and  $\theta_{JC\_BOTTOM}$  is the bottom junction-to-case thermal resistance.  $\Psi_{JT}$  is the junction-to-top thermal characterization, and  $\Psi_{JB}$  is the junction-to-board thermal characterization.

Table 5. Thermal Resistance

Package Type <sup>1</sup>	$\theta_{JA}$	θ <sub>JC_TOP</sub>	θ <sub>JC_BOTTOM</sub>	$\theta_{JB}$	$\Psi_{JT}$	$\Psi_{JB}$	Unit
BC-84-4	29.3	14.7	18.1	21.8	2.4	22.2	°C/W

<sup>&</sup>lt;sup>1</sup> Test Condition 1: Thermal impedance simulated values are based on the use of a 2S2P with vias JEDEC PCB, excluding  $\theta_{JC\_TOP}$ , which uses a 1S0P JEDEC PCB.

Thermal resistance values specified in Table 5 are simulated based on JEDEC specs (unless specified otherwise) and must be used in compliance with JESD51-12.

#### **ELECTROSTATIC DISCHARGE (ESD) RATINGS**

The following ESD information is provided to handle ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

Field-induced charged device model (FICDM) per ANSI/ESDA/JEDEC JS-002.

## **ESD Ratings for ADAQ7767-1**

Table 6. ADAQ7767-1, 84-Ball CSP\_BGA

ESD Model	Withstand Voltage (V)	Class
HBM	±2000	2
FICDM	±500	C2A

#### **ESD CAUTION**

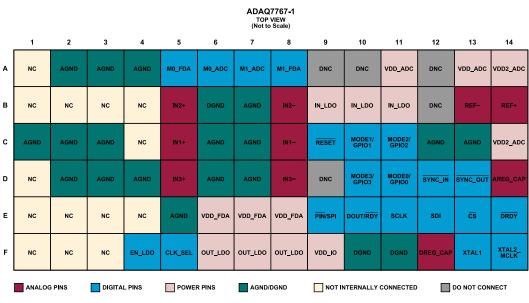


ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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**ADAQ7767-1 Data Sheet** 

### PIN CONFIGURATION AND FUNCTION DESCRIPTION



NOTES:

1. NC = NOT (INTERNALLY) CONNECTED. LEAVE FLOATING OR CONNECT TO GROUND REFERENCE.
2. DNC = DO NOT CONNECT. LEAVE THE NODE FLOATING FOR NORMAL OPERATION.

Figure 9. Pin Configuration

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Type <sup>1</sup>	Description	
A1	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
A2	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
A3	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to syste ground for normal operation.	
A4	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
A5	M0_FDA	DI	FDA Mode Control Input 0. Connect M0_FDA to M0_ADC for normal operation.	
A6	M0_ADC	DO	FDA Mode Control Output 0. Connect M0_ADC to M0_FDA for normal operation.	
A7	M1_ADC	DO	FDA Mode Control Output 1. Connect M1_ADC to M1_FDA for normal operation.	
A8	M1_FDA	DI	FDA Mode Control Input 1. Connect M1_FDA to M1_ADC for normal operation.	
A9	DNC	N/A	Do Not Connect. Leave the node floating for normal operation.	
A10	DNC	N/A	Do Not Connect. Leave the node floating for normal operation.	
A11	VDD_ADC	P	ADC Analog Supply Voltage. Referenced to AGND. Connect VDD_ADC to OUT_LDO if using the on-device LDO regulator, or connect VDD_ADC to a single power source that also supplies the VDD_FDA pin.	
A12	DNC	N/A	Do Not Connect. Leave the node floating for normal operation.	
A13	VDD_ADC	P	ADC Analog Supply Voltage. Referenced to AGND. Connect to OUT_LDO if using on-device LDO regulator, connect VDD_ADC to a single power source that also supplies the VDD_FDA pin.	
A14	VDD2_ADC	P	ADC Secondary Analog Supply Voltage. Referenced to AGND.	
B1	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
B2	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
B3	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
B4	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
B5	IN2+	Al	Signal Input, Noninverting, Gain of 0.364. Maximum differential input of 22 V p-p.	
B6	DGND	P	Ground Reference for VDD_IO Supplies. Connect DGND to system ground for normal operation.	
B7	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
B8	IN2-	Al	Signal Input, Inverting, Gain of 0.364. Maximum differential input of 22 V p-p.	

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## PIN CONFIGURATION AND FUNCTION DESCRIPTION

Table 7. Pin Function Descriptions (Continued)

Pin No.	Mnemonic	Type <sup>1</sup>	Description	
B9	IN_LDO	Р	On-Device LDO Regulator Supply Input. Bypass IN_LDO to AGND with a capacitor of at least 1 µF.	
B10	IN_LDO	P	On-Device LDO Regulator Supply Input. Bypass IN_LDO to AGND with a capacitor of at least 1 µF.	
B11	IN_LDO	P	On-Device LDO Regulator Supply Input. Bypass IN_LDO to AGND with a capacitor of at least 1 µF.	
B12	DNC	N/A	Do Not Connect. Leave the node floating for normal operation.	
B13	REF-	Al	ADC Reference Input Negative Node. Connect REF- to AGND for normal operation.	
B14	REF+	Al	ADC Reference Input Positive Node. Apply an external reference between REF+ and REF- with the voltage level ranging from VDD_ADC to AGND + 1 V.	
C1	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C2	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C3	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C4	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
C5	IN1+	Al	Signal Input, Noninverting, Gain of 1. Maximum differential input of 8 V p-p.	
C6	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C7	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C8	IN1-	Al	Signal Input, Inverting, Gain of 1. Maximum differential input of 8 V p-p.	
C9	RESET	DI	ADC Hardware Asynchronous Reset Input. After the ADAQ7767-1 is fully powered up, it is recommended to do a hardware or software reset.	
C10	MODE1/GPIO1	DI/O	A Multifunction Pin.	
			In PIN control mode, MODE1 is the PIN Control Operating Profile Selection Input 1.	
			In SPI control mode, GPIO1 is the general-purpose input and output pin with the logic level referenced to the VDD_IO and DGND pins.	
C11	MODE2/GPIO2	DI/O	A Multifunction Pin.	
			In PIN control mode, MODE2 is the PIN Control Operating Profile Selection Input 2.	
			In SPI control mode, GPIO2 is the general purpose input and output pin with its logic level referenced to the VDD_IO and DGND pins.	
C12	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C13	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
C14	VDD2_ADC	P	ADC Secondary Analog Supply Voltage. Referenced to AGND.	
D1	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.	
D2	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
D3	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
D4	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
D5	IN3+	Al	Signal Input, Noninverting, Gain of 0.143. Maximum differential input of 57 V p-p.	
D6	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
D7	AGND	Р	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC Supplies. Connect AGND to system ground for normal operation.	
D8	IN3-	Al	Signal Input, Inverting, Gain of 0.143. Maximum differential input of 57 V p-p.	
D9	DNC	N/A	Do Not Connect. Leave the node floating for normal operation.	

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## PIN CONFIGURATION AND FUNCTION DESCRIPTION

Table 7. Pin Function Descriptions (Continued)

Pin No.	Mnemonic	Type <sup>1</sup>	Description
D10	MODE3/GPIO3	DI/O	A Multifunction Pin.
			In PIN control mode, MODE3 is the PIN Control Operating Profile Selection Input 3.
			In SPI control mode, GPIO3 is the general purpose input and output pin with the logic level referenced to the VDD_IO and DGND pins. The pin can also be assigned a START function through the EN_GPIO_START bit.
D11	MODE0/GPI00	DI/O	A Multifunction Pin.
			In PIN control mode, MODE0 is the PIN Control Operating Profile Selection Input 0.
			In SPI control mode, GPIO0 is the general-purpose input and output pin with the logic level referenced to the VDD_IO and DGND pins.
D12	SYNC_IN	DI	SYNC_IN receives the synchronization signal from the SYNC_OUT pin or from the main controller. The synchronization signal must be synchronous to MCLK. SYNC_IN enables synchronization and simultaneous sampling of multiple ADAQ7767-1 devices.
D13	SYNC_OUT	DO	Synchronization Pulse Output Synchronous to MCLK. The SYNC_OUT pin allows one or multiple ADAQ7767-1 devices to be synchronized through the SPI. Send a SYNC command over the SPI to initiate a SYNC_OUT output. If used, route the SYNC_OUT signal back to the SYNC_IN pin of the same device and the SYNC_IN pins of other ADAQ7767-1 devices for simultaneous sampling.
D14	AREG_CAP	AO	Internal Analog LDO Regulator Output of the ADC. Decouple the AREG_CAP pin to AGND with a 1 µF capacitor. Do not use the voltage output from AREG_CAP in circuits external to the ADAQ7767-1.
E1	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
E2	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
E3	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
E4	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
E5	AGND	P	Ground Reference for VDD_FDA, IN_LDO, VDD_ADC, and VDD2_ADC supplies. Connect to system ground for normal operation.
E6	VDD_FDA	P	ADC Driver Amplifier Positive Supply. Referenced to AGND. Connect VDD_FDA to OUT_LDO if using the on-device LDO regulator, or connect VDD_FDA to a single power source that also supplies the VDD_ADC pin
E7	VDD_FDA	Р	ADC Driver Amplifier Positive Supply. Referenced to AGND. Connect VDD_FDA to OUT_LDO if using the on-device LDO regulator, or connect VDD_FDA to a single power source that also supplies the VDD_ADC pin
E8	VDD_FDA	Р	ADC Driver Amplifier Positive Supply. Referenced to AGND. Connect VDD_FDA to OUT_LDO if using the on-device LDO regulator, or connect VDD_FDA to a single power source that also supplies the VDD_ADC pin
E9	PIN/SPI	DI	Device Mode Selection Input.
			Set to 0 for PIN Mode Operation. Control and configure device operation through the configuration pin logic.
			Set to 1 for SPI Mode Operation. Control and configure device through the registers over the SPI.
E10	DOUT/RDY	DO	Serial Interface Data Output and Data Ready Signal Combined. Configure this output data pin as either a DOUT pin only, or through SPI control mode, include the ready signal (RDY). The ability to program the device
E44	00114	DI	to provide a combined DOUT/RDY signal can reduce the number of required interface input and output lines.
E11	SCLK	DI	Serial Interface Clock.
E12	SDI	DI	Serial Interface Data Input.
E13	CS	DI	Serial Interface Chip-Select Input. Active low.
E14	DRDY	DO	ADC Conversion Data Ready Output. Periodic signal output to signify conversion results are available.
F1	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
F2	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
F3	NC	N/A	Not (Internally) Connected. Leave floating or connect to ground reference.
F4	EN_LDO	DI	On-Device LDO Regulator Enable Input. Active high.
F5	CLK_SEL	DI	ADC Clock Source Selection Input.
			In PIN control mode, set to 0 for the CMOS Clock Option. Apply the external CMOS clock signal to the XTAL2_MCLK pin, and tie XTAL1 pin to DGND. Also in PIN mode, set to 1 for the Crystal Option. Connect the external crystal across the XTAL1 and XTAL2_MCLK pins.
			In SPI control mode, tie the CLK_SEL pin to DGND. Select the clock source through register access. The LVDS clock option is available only in SPI control mode.
F6	OUT_LDO	Р	On-Device LDO Regulator Output. Bypass OUT_LDO to AGND with a capacitor of at least 1 µF.
F7	OUT_LDO	P	On-Device LDO Regulator Output. Bypass OUT_LDO to AGND with a capacitor of at least 1 μF.

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## PIN CONFIGURATION AND FUNCTION DESCRIPTION

Table 7. Pin Function Descriptions (Continued)

Pin No.	Mnemonic	Type <sup>1</sup>	Description	
F8	OUT_LDO	Р	On-Device LDO Regulator Output. Bypass OUT_LDO to AGND with a capacitor of at least 1 µF.	
F9	VDD_IO	P	Digital Supply. The VDD_IO pin sets the logic levels for all interface pins. VDD_IO powers the digital processing through the internal digital LDO regulator. Referenced to DGND. Bypass VDD_IO to DGND with a capacitor of at least 1 $\mu$ F. For VDD_IO $\leq$ 1.8 V, connect VDD_IO to DREG_CAP, decouple it with a 10 $\mu$ F capacitor and enable LV_BOOST (Bit 7 of Register 0x14) from the interface format control register (see the Interface Format Control Register section).	
F10	DGND	P	Ground Reference for VDD_IO Supplies. Connect DGND to system ground for normal operation.	
F11	DGND	P	Ground Reference for VDD_IO Supplies. Connect DGND to system ground for normal operation.	
F12	DREG_CAP	AO	Internal Digital LDO Regulator Output for the ADC. Decouple DREG_CAP to DGND with a 1 $\mu$ F capacitor. For VDD_IO $\leq$ 1.8 V, connect VDD_IO to DREG_CAP, decouple it with a 10 $\mu$ F capacitor and enable LV_BOOST (Bit 7 of Register 0x14) from the interface format control register (see the Interface Format Control Register section). Do not use the voltage output from DREG_CAP in circuits external to the ADAQ7767-1.	
F13	XTAL1	DI	ADC Clock Input 1.	
			External crystal: connect XTAL1 to one node of the external crystal.	
			LVDS: connect XTAL1 to one node of the LVDS clock source.	
			CMOS clock: connect to DGND.	
F14	XTAL2_MCLK	DI	ADC Clock Input 2.	
			External crystal: connect to the second node of the external crystal.	
			LVDS: connect to the second node of the LVDS clock source.	
			CMOS clock: connect to the CMOS clock source. Logic level referenced to VDD_IO and DGND.	

<sup>&</sup>lt;sup>1</sup> Al is analog input, AO is analog output, DI is digital input, DO is digital output, DI/O is bidirectional digital, P is power or ground, and N/A is not applicable.

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### TYPICAL PERFORMANCE CHARACTERISTICS

AGND = DGND = 0 V, input common-mode voltage = 0 V, IN\_LDO = EN\_LDO = 5.1 V to 5.5 V, OUT\_LDO = VDD\_FDA = VDD\_ADC, VDD2\_ADC = 2 V to 5.5 V, VDD\_IO = 1.7 V to 3.6 V, REF+ = 4.096 V, REF- = 0 V, MCLK = SCLK = 16.384 MHz 50:50 duty cycle,  $f_{\text{MOD}}$  = MCLK/2, filter = wideband low ripple, decimation = 32, ODR = 256 kSPS, linearity boost buffer on, reference precharge buffers on, FDA = full power mode, and  $T_{\text{A}}$  =  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $T_{\text{A}}$  =  $25^{\circ}\text{C}$ .

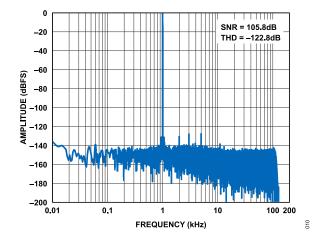


Figure 10. Wideband Low Ripple Filter, Differential Input, IN1, -0.5 dBFS  $(3.9 V_P)$ 

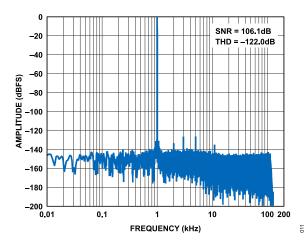


Figure 11. Wideband Low Ripple Filter, Differential Input, IN2, -0.5 dBFS (10.6 V<sub>P</sub>)

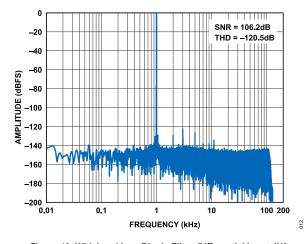


Figure 12. Wideband Low Ripple Filter, Differential Input, IN3, -0.5 dBFS (27.0 V<sub>P</sub>)

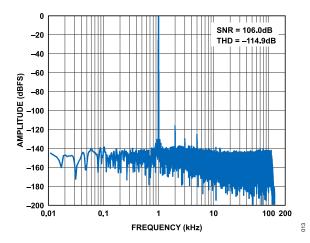


Figure 13. Wideband Low Ripple Filter, Single-Ended, IN1, -0.5 dBFS (3.9 V<sub>P</sub>)

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#### TYPICAL PERFORMANCE CHARACTERISTICS

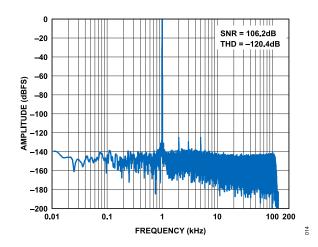


Figure 14. Wideband Low Ripple Filter, Single-Ended, IN2, -0.5 dBFS (10.6  $V_P$ )

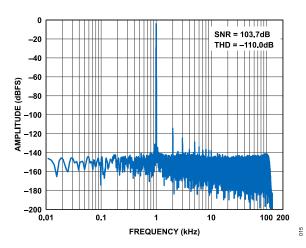


Figure 15. Wideband Low Ripple Filter, Single-Ended, IN3, -3.6 dBFS (18.9  $V_P$ )

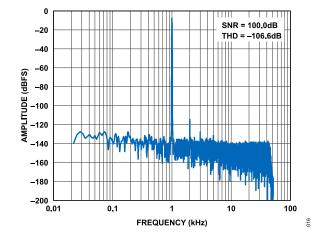


Figure 16. Wideband Low Ripple Filter, MCLK = 13.107 MHz, ODR = 102.4 kSPS, Single-Ended Input, IN3, -12 V DC + 10 V<sub>P</sub> (-2 V to -22 V)

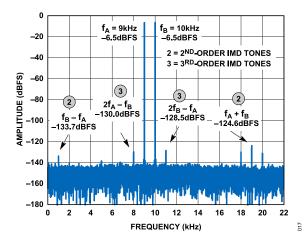


Figure 17. Two-Tone Input, IN1,  $f_A$  = 9 kHz and -6.5 dBFS, and  $f_B$  = 10 kHz and -6.5 dBFS Sine, Wideband Low Ripple Filter, ODR = 256 kSPS

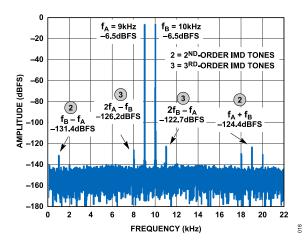


Figure 18. Two-Tone Input, IN2,  $f_A$  = 9 kHz and -6.5 dBFS, and  $f_B$  = 10 kHz and -6.5 dBFS Sine, Wideband Low Ripple Filter, ODR = 256 kSPS

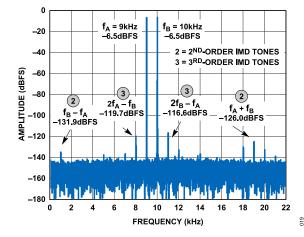


Figure 19. Two-Tone input, IN3,  $f_A$  = 9 kHz and -6.5 dBFS, and  $f_B$  = 10 kHz and -6.5 dBFS Sine, Wideband Low Ripple Filter, ODR = 256 kSPS

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#### TYPICAL PERFORMANCE CHARACTERISTICS

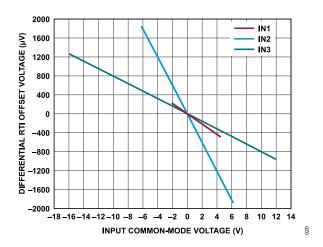


Figure 20. Differential RTI Offset Voltage vs. Input Common-Mode Voltage

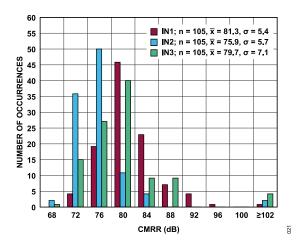


Figure 21. DC CMRR Distribution

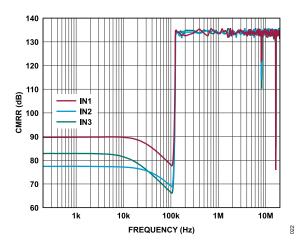


Figure 22. AC CMRR vs. Input Frequency

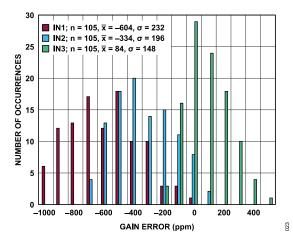


Figure 23. Gain Error Distribution

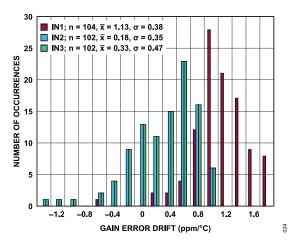


Figure 24. Gain Error Drift Distribution

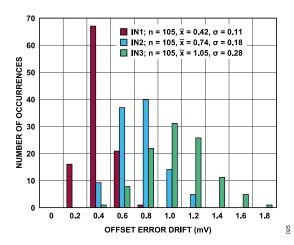


Figure 25. Offset Error Distribution

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#### TYPICAL PERFORMANCE CHARACTERISTICS

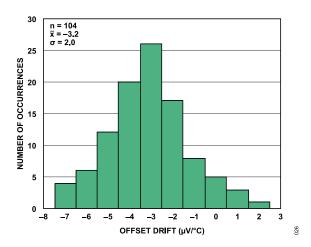


Figure 26. Offset Error Drift Distribution, IN1

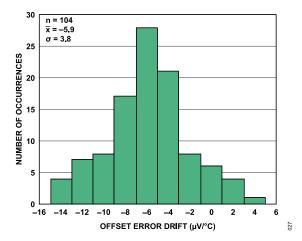


Figure 27. Offset Error Drift Distribution, IN2

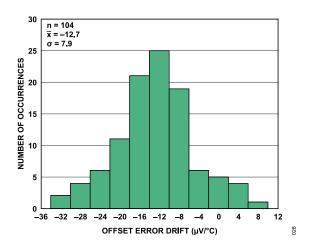


Figure 28. Offset Error Drift Distribution, IN3

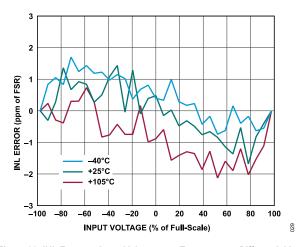


Figure 29. INL Error vs. Input Voltage over Temperature, Differential Input, IN1

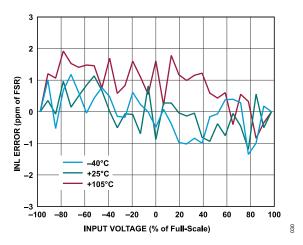


Figure 30. INL Error vs. Input Voltage over Temperature, Differential Input, IN2

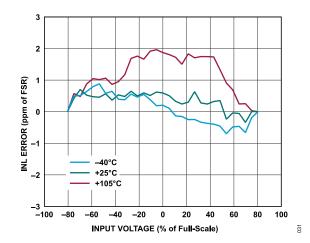


Figure 31. INL Error vs. Input Voltage over Temperature, Differential Input,

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#### TYPICAL PERFORMANCE CHARACTERISTICS

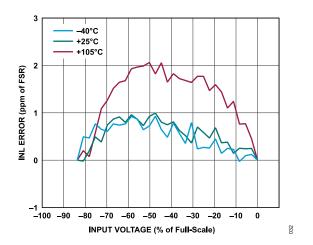


Figure 32. INL Error vs. Input Voltage over Temperature, IN3, Single-Ended Input, 0 V to -24 V (Unipolar) Input Sweep

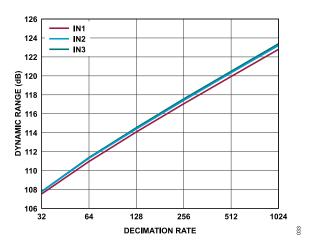


Figure 33. Dynamic Range vs. Decimation Rate, Wideband Low Ripple Filter, Shorted Inputs

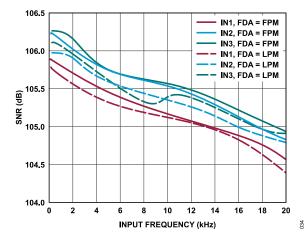


Figure 34. SNR vs. Input Frequency at 25°C, Differential Input, -0.5 dBFS Fully Differential Amplifier (FDA) at Full Power Mode (FPM) or Low Power Mode (LPM)

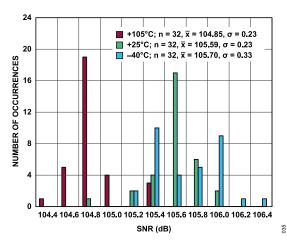


Figure 35. SNR Distribution Across Temperature, Differential Input, IN1, -0.5 dBFS, 1 kHz

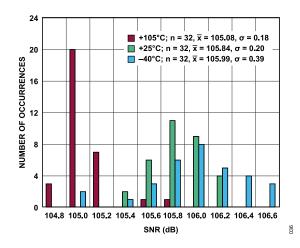


Figure 36. SNR Distribution Across Temperature, Differential Input, IN2, -0.5 dBFS, 1 kHz

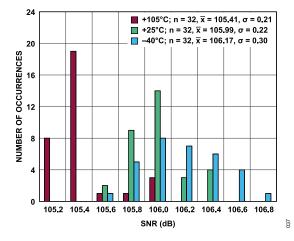


Figure 37. SNR Distribution Across Temperature, Differential Input, IN3, -0.5 dBFS, 1 kHz

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#### TYPICAL PERFORMANCE CHARACTERISTICS

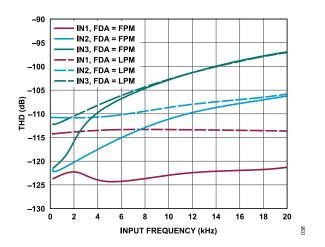


Figure 38. THD vs. Input Frequency at 25°C, Differential Input, -0.5 dBFS

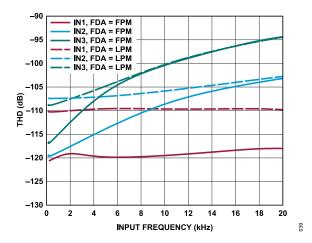


Figure 39. THD vs. Input Frequency at 105°C, Differential Input, -0.5 dBFS

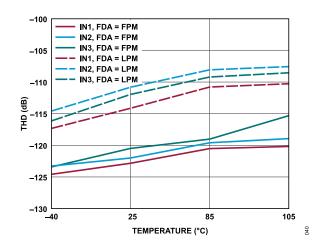


Figure 40. THD vs. Temperature, Differential Input, -0.5 dBFS, 1 kHz

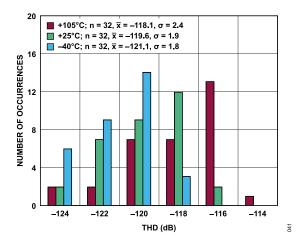


Figure 41. THD Distribution Across Temperature, Differential Input, IN1, -0.5 dBFS, 1 kHz

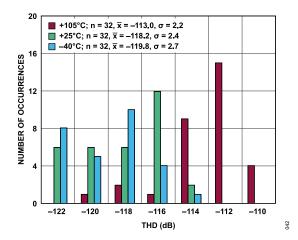


Figure 42. THD Distribution Across Temperature, Differential Input, IN2, -0.5 dBFS, 1 kHz

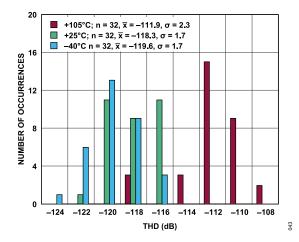


Figure 43. THD Distribution Across Temperature, Differential Input, IN3, -0.5 dBFS, 1 kHz

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#### TYPICAL PERFORMANCE CHARACTERISTICS

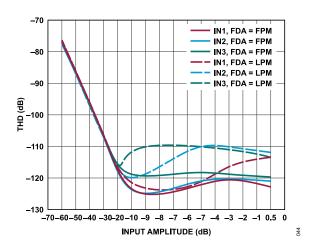


Figure 44. THD vs. Input Amplitude, Differential Input, 1 kHz

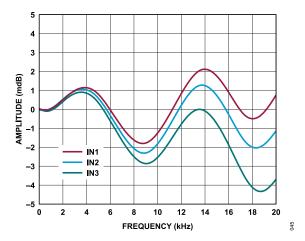


Figure 45. Wideband Low Ripple FIR Filter Pass-Band Ripple, ODR = 256 kSPS

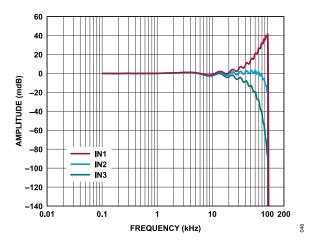


Figure 46. Wideband Low Ripple FIR Filter Magnitude Flatness, ODR = 256 kSPS

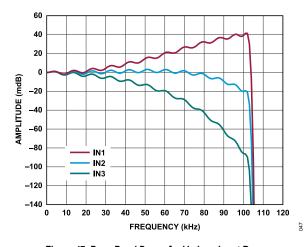


Figure 47. Pass-Band Droop for Various Input Ranges

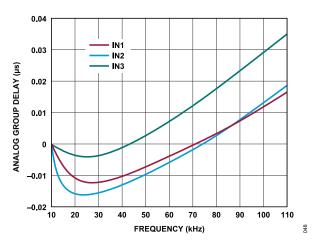


Figure 48. AFE Pass-Band Analog Group Delay Frequency Response at 25°C, Normalized to Delay at 10 kHz

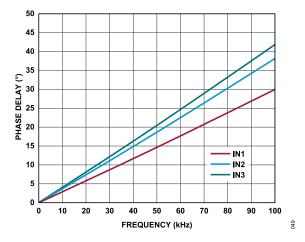


Figure 49. AFE Pass-Band Phase Response

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#### TYPICAL PERFORMANCE CHARACTERISTICS

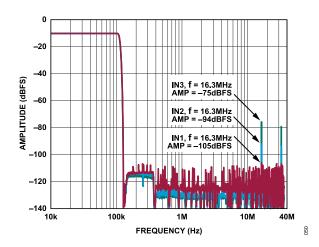


Figure 50. Anti-Aliasing Filter Rejection, INx = −10 dBFS (f Means Frequency)

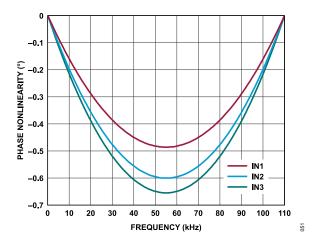


Figure 51. AFE Phase Nonlinearity, Endpoint Method (100 Hz to 110 kHz)

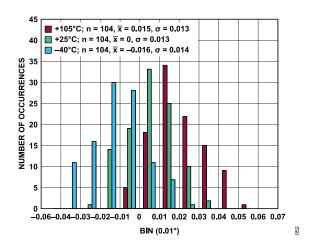


Figure 52. Device-to-Device Phase Angle Mismatch Histogram, 20 kHz, IN1, Normalized to the Mean Value at 25°C

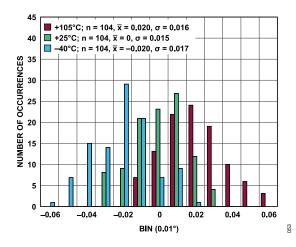


Figure 53. Device-to-Device Phase Angle Mismatch Histogram, 20 kHz, IN2, Normalized to the Mean Value at 25°C

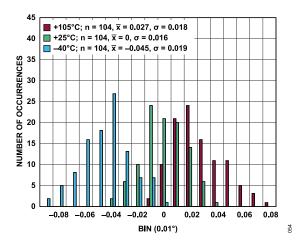


Figure 54. Device-to-Device Phase Angle Mismatch Histogram, 20 kHz, IN3, Normalized to the Mean Value at 25°C

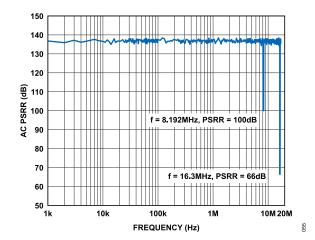


Figure 55. LDO AC PSRR, Connected to VDD\_FDA, VDD\_ADC, and VDD2 ADC with 1 µF External Supply Decoupling Capacitor at OUT LDO

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#### TYPICAL PERFORMANCE CHARACTERISTICS

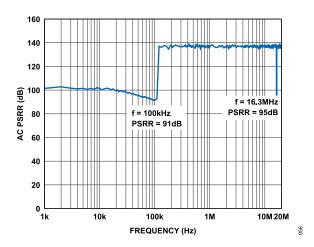


Figure 56. VDD\_IO AC PSRR Using Built-In Supply Decoupling

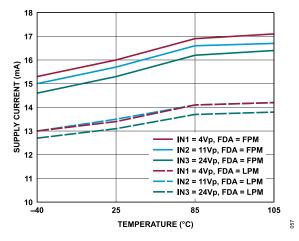


Figure 57. LDO Supply Current vs. Temperature using AC Input, OUT\_LDO Connected to VDD\_FDA, VDD\_ADC, and VDD2\_ADC

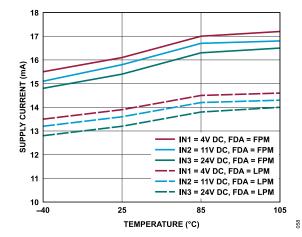


Figure 58. LDO Supply Current vs. Temperature using DC Input, OUT\_LDO Connected to VDD\_FDA, VDD\_ADC, and VDD2\_ADC

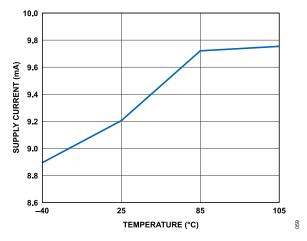


Figure 59. VDD\_IO Supply Current vs. Temperature

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#### **TERMINOLOGY**

### AC Common-Mode Rejection Ratio (CMRR)

The ratio of the sine-wave, common-mode voltage applied to INx+ and INx- at frequency, f, to the voltage at the ADC output at the same frequency, f.

CMRR 
$$(dB) = 20log\left(\frac{V_{INX\_f} \times AFE\_GAIN}{V_{ADC\_f}}\right)$$
 (1)

where:

 $V_{INx\_f}$  is the sine-wave, common-mode voltage applied to INx+ and INx- at frequency, f.

AFE\_GAIN is the analog front-end gain, corresponding to the selected differential input.

 $V_{ADC\ f}$  is the voltage at the ADC output at the same frequency, f.

### Least Significant Bit (LSB)

The smallest increment that can be represented by a converter. For a fully differential input ADC with N bits of resolution, the LSB expressed in volts is as follows:

LSB (V) = 
$$\frac{V_{REF} \times 2}{2^{N} \times AFE \ GAIN}$$
 (2)

#### **Gain Error**

The first transition (from 100 ... 000 to 100 ...001) occurs at a level ½ LSB more than nominal negative full scale (-4.0955999756 V for the ±4.096 V range). The last transition (from 011 ... 110 to 011 ... 111) occurs for an analog voltage 1½ LSB less than the nominal full scale (+4.095999268V for the ±4.096 V range). The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels.

#### **Gain Error Drift**

The ratio of the gain error change due to a temperature change of 1°C and the full-scale range (2<sup>N</sup>). It is expressed in parts per million per degree Celsius.

#### **Offset Error**

The difference between the ideal midscale input voltage (0 V) and actual voltage producing the midscale output code.

#### Offset Error Drift

The ratio of the offset error change due to a temperature change of 1°C and the full scale code range (2<sup>N</sup>).

#### Differential Nonlinearity (DNL) Error

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value, often specified in terms of resolution for which no missing codes are guaranteed.

### Integral Nonlinearity (INL) Error

The deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½ LSB before the first code transition. Positive full scale is defined as a level 1½ LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line.

### **Dynamic Range**

The ratio of the root mean-square (RMS) value of the full scale to the RMS noise measured when input pins are shorted together. The value is expressed in decibels.

### **Total System Dynamic Range**

The ratio of the RMS value of the full scale using IN3+ and IN3- to the input-referred RMS noise measured when the IN1+ and IN1- pins are shorted together. The value is expressed in decibels.

#### Peak-to-Peak Resolution

The number of bits unaffected by peak-to-peak noise or flicker. This resolution is also sometimes called flicker-free resolution or noise-free code resolution and follows this formula:

$$\log_2\left(\frac{\text{Full Scale Range}}{6.6 \times \text{RMS Noise}}\right) \tag{3}$$

#### Signal-to-Noise Ratio (SNR)

The ratio of the RMS value of the actual input signal to the RMS sum of all other spectral components less than the Nyquist frequency, excluding harmonics and DC. The value is expressed in decibels.

#### **Total Harmonic Distortion (THD)**

The ratio of the RMS sum of the harmonics to the fundamental. THD is expressed in decibels. For the ADAQ7767-1, THD is defined as:

THD 
$$(dB) = 20\log\left(\frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1}\right)$$
 (4)

where:

 $\text{V}_2,\,\text{V}_3,\,\text{V}_4,\,\text{V}_5,\,\text{V}_6$  are the RMS amplitudes of the second to sixth harmonics.

 $V_1$  is the RMS amplitude of the fundamental.

## Signal-to-Noise-and-Distortion (SINAD) Ratio

The ratio of the RMS value of the actual input signal to the RMS sum of all other spectral components less than the Nyquist frequency, including harmonics but excluding DC. The value is expressed in decibels.

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#### **TERMINOLOGY**

### Spurious-Free Dynamic Range (SFDR)

The difference, in decibels, between the RMS amplitude of the input signal and peak spurious signal (including harmonics).

#### Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb, any active device with nonlinearities creates distortion products at sum and difference frequencies of mfa and nfb, where m, n = 0, 1, 2, 3, and so on. Intermodulation distortion terms are those for which neither m nor n are equal to 0. For example, the second-order terms include (fa + fb) and (fa – fb), and the third-order terms include (2fa + fb), (2fa – fb), (fa + 2fb), and (fa – 2fb).

The calculation of the intermodulation distortion is per the THD specification, where it is the ratio of the RMS sum of the individual distortion products to the RMS amplitude of the sum of the fundamentals expressed in decibels.

#### **Phase Angle Drift**

The phase angle drift defines the rate of change of the phase delay over temperature of a single device at a given input signal frequency. The drift in degrees/°C is calculated using the endpoint method over the full operating temperature range. The typical specification is the average phase angle drift across a large number of devices, while the maximum (or minimum) specification is six standard deviations ( $\sigma$ ) away from the typical value.

#### **Device-to-Device Phase Angle Mismatch**

The device-to-device phase angle mismatch measures the deviation of the phase delay of a single ADAQ7767-1 device relative to the average phase delay of a group of ADAQ7767-1 devices at a given input signal frequency. This mismatch also shows how well the phase response of the data acquisition signal chain matches among channels. The typical specification is equal to  $\pm 1\sigma$  (standard deviation) of the distribution, while the maximum (or minimum) is six times this value.

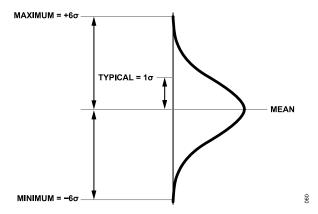


Figure 60. Device-to-Device Phase Angle Mismatch Calculation

### **Device-to-Device Phase Angle Mismatch Drift**

Device-to-device phase angle mismatch drift quantifies how much the device-to-device phase angle mismatch standard deviation ( $\sigma$ ) widens or tightens across temperature at a given input signal frequency. A positive sign indicates a wider phase mismatch distribution as temperature increases, while a negative sign indicates a tighter phase mismatch distribution as temperature increases. This drift is calculated using the endpoint method over the full operating temperature range. The typical specification is the change in  $|1\sigma|$  per °C, while the maximum is six times this value, as shown in Figure 61.

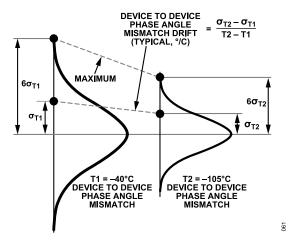


Figure 61. Device-to-Device Phase Angle Mismatch Drift Calculation

## Power Supply Rejection Ratio, PSRR

Variations in power supply affect the full-scale transition but not the linearity of the converter. PSRR is the maximum change in the full-scale transition point due to a change in power supply voltage from the nominal value.

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#### THEORY OF OPERATION

#### **ANALOG INPUT**

The wide common-mode input range and high CMRR of the ADAQ7767-1 allow each pair of its input pins to swing with an arbitrary relationship to each other, allowing the device to accept a wide variety of signal swings, including unipolar and bipolar single-

ended, pseudodifferential and fully differential signals, as shown in Figure 62. Emphasis is given on the positive single-ended range of IN3, where the single-ended signal is limited to 24 V (-1.55 dBFS) due to the common-mode limit of IN3.

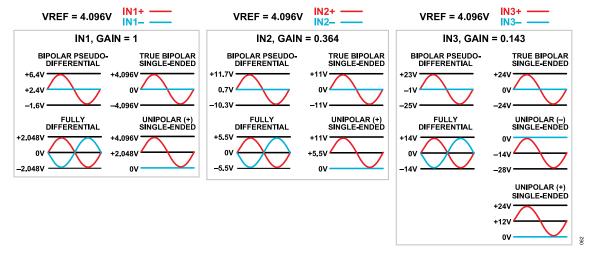


Figure 62. Examples of Different Input Signals

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#### THEORY OF OPERATION

### **Arbitrary Input**

The two-tone tests shown in Figure 17 to Figure 19 demonstrate the arbitrary input drive capability of the ADAQ7767-1. The test simultaneously drives INx+ with a -6.5 dBFS, 9 kHz, single-ended sine wave and INx- with a -6.5 dBFS, 10 kHz, single-ended sine wave. Together, these signals sweep the analog inputs across a wide range of common-mode and differential-mode voltage combinations. These signals also have a simple spectral representation. An ideal differential converter with no common-mode sensitivity digitizes thes signals as two -6.5 dBFS spectral tones, one at each sine-wave frequency. The fast Fourier transform (FFT) plots in Figure 17 to Figure 19 demonstrate the ADAQ7767-1 response across all input ranges.

### **Absolute Input Range**

The absolute voltage that the ADAQ7767-1 accepts varies between the input pairs. For IN1+ and IN1- and IN2+ and IN2-, the absolute maximum input is at  $\pm$ 15 V. For IN3+ and IN3-, the absolute maximum is at  $\pm$ 36 V.

#### **Differential Input Range**

The differential signal amplitude depends on the front-end signal gain and the reference voltage level. To calculate the maximum differential input voltage, use the following equation:

$$V_{INx+} - V_{INx-} = \pm V_{REF} / AFE\_GAIN$$
 (5)

where V<sub>INx+</sub> is the INx+ voltage, and V<sub>INx-</sub> is the INx- voltage.

### Input Common-Mode Voltage Range

The input common-mode voltage  $(V_{\text{ICM}})$  is the average of the absolute voltage across a particular pair of differential inputs, given by the formula:

$$V_{ICM} = \frac{V_{INx} + V_{INx} - V_{INx} - V_{ICM}}{2} \tag{6}$$

The V<sub>ICM</sub> range depends on the driver amplifier supply voltage (VDD\_FDA) and the selected pair of input pins. Figure 63 shows the operating region where a valid output is produced for each input pair of the ADAQ7767-1. To simplify selection of input pins, Table 8 lists the maximum differential input range and common-mode input range for each of the input pins.

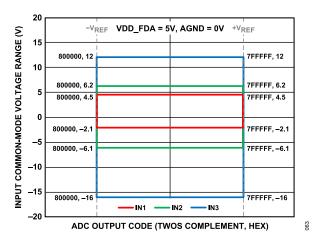


Figure 63. Input Common-Mode Voltage Range vs. ADC Output Code

Table 8. Input Selection Table

		Differential Input Range with V <sub>RFF</sub>	V <sub>ICM</sub> Range with Full-Scale Input Signal V <sub>REF</sub> = 4.096 \	
Input Pin	Gain (V/V)	= 4.096 V (V)	Minimum (V)	Maximum (V)
IN1+ and IN1-	1	±4.096	-2.1	+4.5
IN2+ and IN2-	0.364	±11.264	-6.1	+6.2
IN3+ and IN3-	0.143	±28.672	-16	+12

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#### THEORY OF OPERATION

### IN3+ and IN3- Single-Ended Input Range

For the IN3+ and IN3– pair, emphasis is given to its single-ended input configuration, where IN3+ =  $_{VIN}$  and IN3– = AGND because this pair is limited by the  $V_{ICM}$  range of IN3+ and IN3–, unlike IN1+ and IN1– and IN2+ and IN2–. In this configuration, the single-ended, signal positive amplitude is linear only up to 24 V, which corresponds to 83.7% of the full-scale input (or –1.55 dBFS). This range captures the intended application of the single-ended, integrated electronics piezoelectric (IEPE) sensors.

On the negative side, a single-ended signal at IN3+ and IN3- is not limited, and it can swing as low as -28.672 V.

Figure 64 show the relative scaling between the differential voltages applied to the input pins and the respective 24-bit, twos complement digital outputs, expressed as hexadecimal codes. The ADAQ7767-1 is typically characterized with differential inputs at -0.5 dBFS of each input pair. Figure 65 shows the special case of a single-ended input at IN3+ and IN3-.

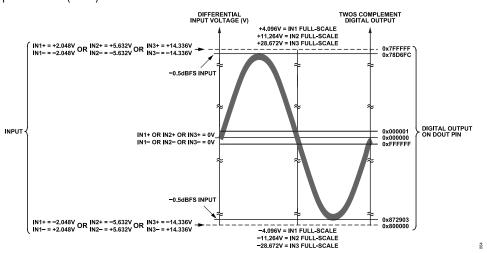


Figure 64. Differential Input Voltage vs. ADC Output Code

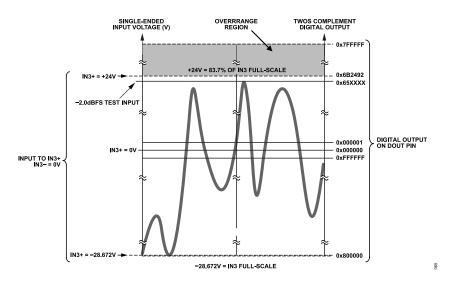


Figure 65. IN3+ and IN3- Single-Ended Input Voltage vs. ADC Output Code

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#### THEORY OF OPERATION

# **ANTI-ALIASING FILTER (AAF)**

The input signal bandwidth of the ADAQ7767-1 is dominated by its digital filter. The user can program the decimation ratio to adjust the digital filter bandwidth. The filter bandwidth can also be fine-tuned by changing the MCLK frequency. For example, with the wideband low ripple digital filter option and an ODR = 256 kSPS, the -3 dB bandwidth of the overall signal chain is equal to the digital filter bandwidth of  $f_{3\text{ dB}} = 0.433 \times \text{ODR} = 110.85 \text{ kHz}$ . The same filter has a stop band of  $0.499 \times \text{ODR}$  and a minimum stop band attenuation of -105 dB.

As with any discrete-time  $\Sigma$ - $\Delta$  ADC, the digital filter of the ADAQ7767-1 does not offer rejection to signals around the signal sampling frequency,  $f_S$ . The core ADC samples of the ADAQ7767-1

are at a frequency of 2 ×  $f_{MOD}$ . In normal operating mode with  $f_{MOD}$  = MCLK/2, the  $f_S$  of the ADC is equal to MCLK. The digital filter has no rejection to signals within the  $f_S \pm f_{3 \ dB}$  frequency range, allowing noise and interference in this frequency range to fold in the pass band. As shown in Figure 66, an additional analog anti-aliasing filter is required to reject signals around  $f_S$  to prevent out-of-band signals from folding back to the band of interest.

The ADAQ7767-1 features a fourth-order analog, anti-aliasing filter that is designed to achieve greater than 65 dB of rejection at 16.384 MHz for all input pairs. Combining its analog anti-aliasing filter with its wideband low ripple FIR Filter, the ADAQ7767-1 is able to reject all out-of-band signals by a minimum of 65 dB, as shown in Figure 67 and Figure 50.

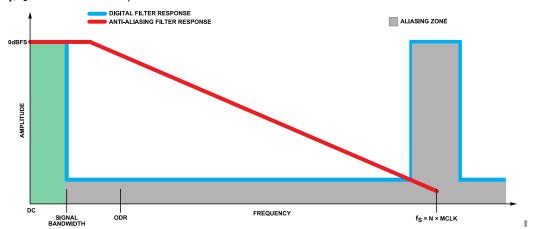


Figure 66. Simplified Illustration of AAF Requirement for Discrete-Time Oversampled Converters

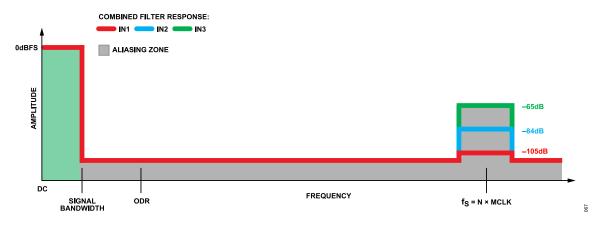


Figure 67. Simplified Illustration of the ADAQ7767-1 Combined AAF and Digital Filter Frequency Response

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# THEORY OF OPERATION

# **Magnitude and Phase Response**

The anti-aliasing filter is designed to achieve optimal aliasing rejection level with minimum magnitude and phase distortion to the in-band signal. As illustrated in Figure 51, the phase response of the filter in the pass band is highly linear. With the help of Analog Devices, Inc., iPASSIVES technology, the filter has a tightly controlled –3 dB corner, allowing for a minimal device-to-device phase angle mismatch, as shown in Figure 52 to Figure 54. This

performance is highly desirable in simultaneously sampling applications, such as using three accelerometers for the x, y, and z axes to locate faults in machine health monitoring applications. These applications can be challenging and expensive to achieve in signal chains using discrete resistors and capacitors, which vary with respect to their tolerance and temperature drift behavior, making this performance a key advantage of signal chain  $\mu$ Modules.

Table 9. Anti-Aliasing Filter Profile

Input Pin	Gain	Relative to DC Attenuation at MCLK = 16.384 MHz (dB)	DC to 100 kHz Pass- Band Droop (mdB)  Change in Group Delay from DC to 100 kHz (ns)		Device-to-Device Phase Angle Mismatch (Typical = $\pm 1 \sigma$ )
IN1+ and IN1-	1	105	+50	17	±0.013°
IN2+ and IN2-	0.36	84	-20	19	±0.015°
IN3+ and IN2-	0.14	65	-90	35	±0.016°

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# THEORY OF OPERATION

## **Calculations on AFE Phase Performance**

All mismatches on the phase angle across gain or temperature, or from device to device, are due to the AFE and its filters because the group delay of the digital filter is constant.

# Phase Angle over Frequency

The ADAQ7767-1 has a linear phase response. To interpolate the phase delay from one frequency to another, the ideal formula is:

$$\frac{\theta_1}{f_{IN\_1}} = \frac{\theta_2}{f_{IN\_2}} \tag{7}$$

where  $\theta_x$  is the phase delay of the AFE using an input frequency of  $f_{\text{IN}-x}.$ 

However, due to small nonlinearities, calibrate the formula in terms of its slope and intercept as follows:

$$\theta = m \times f_{IN} + b + Nonlinearity$$
 (8)

where:

*m* is the slope.

*b* is the y-intercept of the linear equation of the phase delay with respect to the input frequency over the span of the pass-band frequency using endpoint method, as shown in Figure 49.

Using the phase delay at 100 Hz to 110 kHz as endpoints, a typical device has a worst nonlinearity of approximately  $-0.4^{\circ}$  to  $-0.7^{\circ}$ , depending on the input range, as shown in Figure 51.

# **Phase Angle Drift**

Phase angle drift defines the rate of change of the phase delay over temperature of a single device at a given input signal frequency. The drift in degrees/°C is calculated using the endpoint method over the full operating temperature range of  $-40^{\circ}$ C to  $+105^{\circ}$ C. The typical specification is the average phase angle drift across a large number of devices, while the maximum (or minimum) specification is six standard deviations ( $\sigma$ ) away from the typical value.

For example, Typical Device A has a  $5.8^{\circ}$  phase delay from input to output at 20 kHz and a  $T_A$  =  $25^{\circ}$ C using IN1. At  $T_A$  =  $105^{\circ}$ C, the same Device A typically has the following:

 $5.8^{\circ}$  +  $0.00022^{\circ}$ /°C (*Typical Specification*) × ( $105^{\circ}$ C –  $25^{\circ}$ C) =  $5.8176^{\circ}$  *Phase Delay* 

If Device B is operating on the maximum phase angle drift specifications, the same Device B typically has the following:

 $5.8^{\circ}$  +  $0.00039^{\circ}$ /°C (Maximum Specification) × ( $105^{\circ}$ C –  $25^{\circ}$ C) =  $5.8312^{\circ}$  Phase Delay

# **Device-to-Device Phase Angle Mismatch**

Device-to-device phase angle mismatch measures the deviation of the phase delay of a single ADAQ7767-1 device relative to the average phase delay of a group of ADAQ7767-1 devices at a given input signal frequency (see Figure 60). This mismatch shows how well the phase response of the data acquisition signal chain matches between channels. The typical specification is equal to  $\pm 1$   $\sigma$  (standard deviation) of the distribution, while the maximum (or minimum) is six times this value.

For example, measuring the phase delay of a large number of devices with a 20 kHz input using IN1, Device C has a phase delay on the minimum side of the distribution, which is (-) 0.078° earlier than the average. Again, Device D has a phase delay on the maximum side of the distribution, which is (+) 0.078° later than the average. The phase angle mismatch between Device C and Device D is as follows:

 $+0.078^{\circ}$  (max) - (-)  $0.078^{\circ}$  (min)  $= 0.156^{\circ}$ 

This is the worst-case phase angle mismatch between any two ADAQ7767-1 devices (using IN1,  $T_A = 25^{\circ}$ C, and a 20 kHz input).

# **Device-to-Device Phase Angle Mismatch Drift**

Device-to-device phase angle mismatch drift quantifies how much the device-to-device phase angle mismatch standard deviation ( $\sigma$ ) widens or tightens across temperature at a given input signal frequency. A positive sign indicates a wider phase mismatch distribution as temperature increases, while a negative sign indicates a tighter phase mismatch distribution as temperature increases. This specification is calculated using the endpoint method over the full operating temperature range of  $-40^{\circ}$ C to  $+105^{\circ}$ C. The typical specification is the change in 1  $\sigma$  per °C, while the maximum is six times this value, as shown in Figure 61.

Measuring the device-to-device phase angle mismatch standard deviation ( $\sigma$ ) of a large number of devices at 25°C with a 20 kHz input using IN1, it is observed that the  $\sigma$  of the distribution is 0.013°. To interpolate the standard deviation at another temperature, use the following:

 $\sigma_{T2}$  =  $\sigma_{T1}$  + Device-to-Device Phase Angle Mismatch Drift × (T2 – T1)

For example,  $\sigma_{-40^{\circ}C} = 0.013^{\circ} + (-3.0 \mu^{\circ}/^{\circ}C) \times (-40^{\circ}C - +25^{\circ}C) = 0.013195^{\circ}$ .

# FULLY DIFFERENTIAL AMPLIFIER (FDA) POWER MODE

The FDA of the ADAQ7767-1 is a low noise, low distortion amplifier that can drive high resolution and high performance,  $\Sigma$ - $\Delta$  ADCs.

The FDA two selectable power modes are low power mode and full power mode. The FDA low power mode is ideal for DC input applications due to its low 1/f noise. The full power mode offers better linearity performance at a higher current consumption.

Figure 68 shows the connection between M0\_FDA, M1\_FDA, M0\_ADC, and M1\_ADC. The connection sets the FDA to full power mode. To set the FDA to low power mode, M0\_FDA must be pulled to ground, while keeping M1\_FDA and M1\_ADC connected as shown on Figure 69.

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To conserve power when the ADC is in power-down mode or in standby mode, the FDA should be put on standby by pulling both M0\_FDA and M1\_FDA to ground. This is automatically done when M0\_FDA and M1\_FDA is connected to M0\_ADC and M1\_ADC. See the Table 10

Table 10. FDA Mode Truth Table (N/A Means Not Applicable)

	Is M0/ M1_FDA				
ADC Mode	Connected to M0/M1_ADC?	M0_FDA Input Logic	M1_FDA Input Logic	FDA Mode	
N/A	N/A	Low	Low	Standby	
N/A	N/A	Low	High	Low power mode	
N/A	N/A	High	High	Full power mode	
Active <sup>1</sup>	Yes	M0_ADC = high	M1_ADC = high	Full power mode	
Standby	Yes	M0_ADC = low	M1_ADC = low	Standby	
Power-Down	Yes	M0_ADC = low	M1_ADC = low	Standby	

In continuous conversion and one-shot conversion modes, the ADC is always active. In single conversion and duty cycled conversion modes, the ADC alternates between active and standby states. See the Data Conversion Modes section for further information.

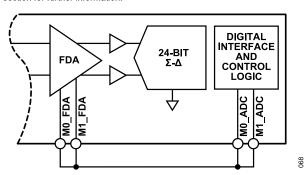


Figure 68. FDA Full Power Mode Connection

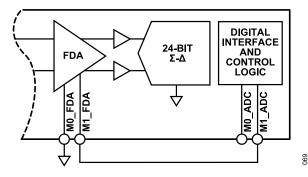


Figure 69. FDA Low Power Mode Connection

# LINEARITY BOOST BUFFER

The ADAQ7767-1 has a pair of linearity boost buffers placed between the driver amplifier and core ADC. There is the option to turn the buffers on to boost the linearity performance of the device. The linearity boost buffers add no noise to the signal chain performance and consume an additional 2 mA typical current (as a pair) on the VDD ADC supply.

The linearity boost buffers are enabled by default. Turn the buffers off in SPI control mode by setting the LINEARITY\_BOOST\_A\_OFF and LINEARITY\_BOOST\_B\_OFF bits in the Analog Buffer Control Register section (Register 0x16, Bit 1 and Bit 2, respectively) to 0. The linearity buffers are always enabled in  $\overline{PIN}$  control mode.

# REFERENCE INPUT AND BUFFERING

The ADAQ7767-1 has differential reference inputs, REF+ and REF-. The absolute input reference voltage range is from 1 V to VDD ADC - AGND.

The reference inputs can be configured for a fully buffered input on each of the REF+ and REF- pins, a precharge buffered input, or to bypass both buffers.

Use of either the full buffers or the precharge buffers reduces the burden on the external reference when driving large loads or multiple devices. The fully buffered input to the reference pins provides a high-impedance input node and enables the use of the ADAQ7767-1 in ratiometric applications, where the ultralow source impedance of a traditional external reference is not available.

In  $\overline{\text{PIN}}$  control mode, the reference precharge buffers are on by default. In SPI mode, there is a choice of either fully buffered or precharge buffers.

The reference input current scales linearly with the modulator clock rate.

For MCLK = 16.384 MHz in fast mode, the reference input current is ~80  $\mu$ A/V unbuffered and ~20  $\mu$ A with the precharge buffers enabled.

With the precharge buffers off, REF+ = 5 V and REF- = 0 V.

 $REF \pm = 5 \text{ V} \times 80 \text{ } \mu\text{A/V} = +400 \text{ } \mu\text{A}$ 

With the precharge buffers on, REF+ = 5 V and REF- = 0 V.

 $REF \pm = approximately 20 \mu A$ 

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#### THEORY OF OPERATION

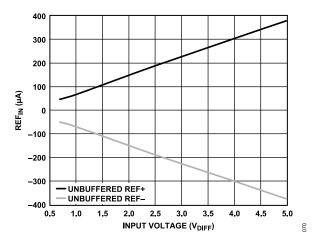


Figure 70. Reference Input Current (REF<sub>IN</sub>) vs. Input Voltage, Unbuffered REF+ and REF-

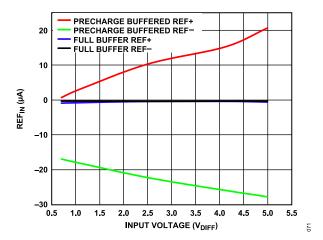


Figure 71. REF<sub>IN</sub> vs. Input Voltage, Precharge Buffered REF+ and REF- and Full Buffer REF+ and REF-

For the best performance and headroom, use a 4.096 V reference, such as the ADR444 or ADR4540, which can both be supplied by a 5 V rail and shared to the VDD ADC supply.

A reference detect function is available in SPI control mode. See the SPI Mode Diagnostic Features section for details.

# **CORE CONVERTER**

The ADAQ7767-1 can use up to a 5 V reference and convert the differential voltage between any input pair to a digital output. The 24-bit conversion result is in MSB first, twos complement format. Figure 72 shows the ideal transfer function, and Table 11 lists the ideal input voltages and their output codes.

Use the following equation to convert from codes to volts, assuming the codes are first converted from twos complement to straight binary:

Voltage = 
$$\frac{\text{(Code - Midscale Code)} \times 2 \times V_{REF}}{2^{24} \times AFE \text{ GAIN}}$$
(9)

where the midscale code is 0x800000 in straight binary and 0x7FFFFF in Table 11 is converted to 0xFFFFFF in straight binary. Use the previous equation to calculate a voltage in the  $V_{REF}/AFE$  GAIN range.

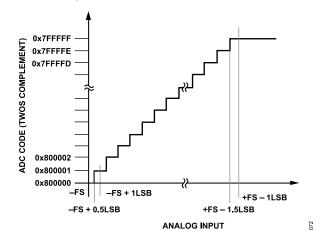


Figure 72. Ideal Transfer Function (FS is Full-Scale)

Table 11. Ideal Input Voltages and Output Codes

Description	Analog Input (V), IN1 AFE_GAIN = 1, IN2 AFE_GAIN = 4/11, and IN3 AFE_GAIN = 1/7	Digital Output Code, Twos Complement (Hexadecimal)
FS - 1 LSB	+V <sub>REF</sub> /AFE_GAIN × (1 - 1/2 <sup>23</sup> )	0x7FFFFF
Midscale + 1 LSB	+V <sub>REF</sub> /AFE_GAIN/2 <sup>23</sup>	0x000001
Midscale	0	0x000000
Midscale - 1 LSB	-V <sub>REF</sub> /AFE_GAIN/2 <sup>23</sup>	0xFFFFFF
-FS + 1 LSB	-V <sub>REF</sub> /AFE_GAIN × (1 - 1/2 <sup>23</sup> )	0x800001
-FS	-V <sub>REF</sub> /AFE_GAIN	0x800000

## **POWER SUPPLIES**

The ADAQ7767-1 has several power supply pins to power the ADC driver and ADC.

To simplify the connection, the internal LDO regulator can be used with an input ranging from 5.1 V to 5.5 V to regulate an output of 5 V for the use of the VDD\_FDA, VDD\_ADC, and VDD2\_ADC pins and an external reference like the ADR4540, as shown in Figure 73. For proper operation, it is recommended to use a 1  $\mu F$  capacitor at the input and output of the LDO regulator. Figure 74 illustrates the use of an external power supply for the VDD\_FDA, VDD\_ADC, and VDD2\_ADC pins and an external voltage reference if the internal LDO regulator is not preferred. In applications requiring less power consumption, VDD2\_ADC can be separately supplied with a well-regulated power supply from 2 V to 5.5 V (2.5 V typical). With a typical current consumption of 4.7 mA, using a 2.5 V external LDO regulator for VDD2\_ADC typically conserves 11.75 mW compared to using the 5 V from the internal LDO regulator or an external 5 V power supply.

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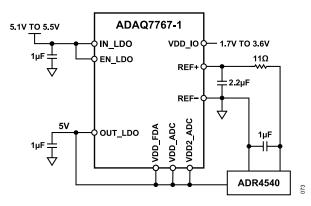


Figure 73. ADAQ7767-1 Power Supply Connection Using an Internal LDO Regulator

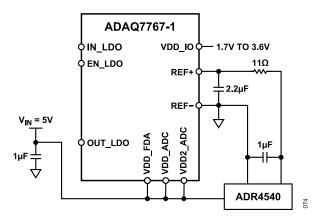


Figure 74. ADAQ7767-1 Power Supply Connection Using an External 5 V Supply

The VDD FDA supply powers the ADC driver.

The VDD\_ADC supply powers the linearity boost buffer, core ADC front-end, and reference input.

The VDD2\_ADC supply connects to an internal 1.8 V analog LDO regulator. This regulator powers the ADC core. VDD2\_ADC – AGND can range from 5.5 V (maximum) to 2.0 V (minimum).

VDD\_IO powers the internal 1.8 V digital LDO regulator. This regulator powers the digital logic of the ADC. VDD\_IO sets the voltage levels for the SPI of the ADC. VDD\_IO is referenced to DGND, and VDD\_IO – DGND can vary from 3.6 V (maximum) to 1.7 V (minimum).

# **POWER SUPPLY DECOUPLING**

The ADAQ7767-1 has built-in, 0.1  $\mu$ F supply decoupling capacitors on the VDD\_FDA, VDD\_ADC, VDD\_ADC2, and VDD\_IO supply pins. Externally, decouple the analog and digital LDO regulators of the ADC to ground with a 1  $\mu$ F capacitor through the AREG\_CAP and DREG\_CAP pins.

Figure 55 shows the AC PSRR of the internal 5 V LDO regulator while it is connected to the VDD\_FDA, VDD\_ADC, and VDD\_ADC2 pins, with their internal 0.1 µF supply decoupling capacitors,

and the recommended 1  $\mu$ F external decoupling capacitor at the OUT\_LDO pin, as shown in Figure 73. Figure 56 shows the AC PSRR of VDD\_IO using its internal 0.1  $\mu$ F supply decoupling capacitor.

#### **POWER STANDBY**

Each functional block of the ADAQ7767-1 can be put into standby mode or power-down mode. The ADAQ7767-1 can achieve 0.5 mW of total power consumption while all functional blocks are put into standby mode or power-down mode. See the Fully Differential Amplifier (FDA) Power Mode, ADC Power-Down Mode, and ADC Standby Mode sections for additional information.

#### **CLOCKING AND SAMPLING TREE**

The ADAQ7767-1 core ADC receives a controller clock signal (MCLK). The MCLK signal can be sourced from one of four options: a CMOS clock, a crystal connected between the XTAL1 and XTAL2 pins, an LVDS signal, and the internal clock. The MCLK signal received by the ADAQ7767-1 defines the core  $\Sigma\text{-}\Delta$  modulator clock rate (f\_MOD) of the ADC and, in turn, the sampling frequency of the modulator of 2 × f\_MOD.

$$f_{MOD} = \frac{MCLK}{MCLK\_DIV} \tag{10}$$

To determine f<sub>MOD</sub>, select and set one of four clock divider settings: MCLK/2, MCLK/4, MCLK/8, or MCLK/16 from the MCLK\_DIV bits (Register 0x15, Bits[5:4]) detailed in the Power and Clock Control Register section. For example, to maximize the ODR or input bandwidth, a MCLK rate of 16.384 MHz is required. Select an MCLK divider (MCLK\_DIV) equal to 2 for a modulator frequency of 8.192 MHz.

Control of the settings for the modulator frequency differ in  $\overline{\text{PIN}}$  control mode vs. SPI control mode.

In SPI control mode, the user can program the power mode and MCLK\_DIV independently. Independent selection of the power mode and MCLK\_DIV allows full freedom in the MCLK speed selection to achieve a target modulator frequency, which can also result in a small power saving. For example, if the power mode is low power, it is more power efficient to use MCLK = 2.048 MHz with MCLK\_DIV = 2 than MCLK = 16.384 MHz with MCLK\_DIV = 16. Both options are valid selections and result in an f<sub>MOD</sub> frequency of 1.024 MHz. Table 12 gives a recommendation on setting the ADC power mode with respect to the f<sub>MOD</sub> frequency.

Table 12. Recommended f<sub>MOD</sub> Range for Each ADC Power Mode

Power Mode	Recommended f <sub>MOD</sub> Range (MHz)
Low	0.038 to 1.024
Median	1.024 to 4.096
Fast	4.096 to 8.192

In PIN control mode, the MODEx pins determine the modulator frequency (see Table 22). The MODEx pins are also used to select the filter type and decimation rate.

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It is recommended to keep the  $f_{MOD}$  frequency high to maximize the out of band tone rejection from the front-end anti-aliasing filter. Increase the decimation rate if low input bandwidth is required.

# **Power vs. Noise Performance Optimization**

Depending on the bandwidth of interest for the measurement, the user can choose a strategy of either lowest current consumption or highest resolution. This choice is due to an overlap in the coverage of each power mode. There are different ways to achieve the same ODR. Using a lower MCLK frequency in tandem with a lower decimation rate allows the user to achieve the same data rate as using a higher MCLK frequency with a higher decimation. Lower power can be achieved by using lower modulator clock frequencies. Conversely, to achieve the highest resolution, use higher modulator clock frequencies and maximize the amount of oversampling.

# **CLOCKING AND CLOCK SELECTION**

In SPI control mode, the ADAQ7767-1 has an internal oscillator that is used for the initial power-up of the device. After the ADAQ7767-1 completes the start-up routine, a clock handover occurs to the external MCLK. The ADAQ7767-1 counts the falling edges of the external MCLK over a given number of internal clock cycles to determine if the clock is valid and of a frequency of at least 600 kHz. If there is a fault with the external MCLK, the handover does not occur, the ADAQ7767-1 clock error bit is set, and the ADAQ7767-1 continues to operate from the internal clock.

Four clock options are available in SPI mode: internal oscillator, external CMOS, crystal oscillator, or LVDS. Use the CLOCK\_SEL bits (Register 0x15, Bits[7:6]) detailed in the Power and Clock Control Register section to set the MCLK source. Regarding the MCLK pin polarity, the MCLK as illustrated in the timing diagrams shown in Figure 4 to Figure 8 is in-phase with the MCLK source applied to the XTAL2\_MCLK pin when using an external CMOS clock or crystal oscillator, while the MCLK is in-phase with the XTAL1 pin when using an LVDS clock.

In PIN control mode, the CLK\_SEL pin sets the external MCLK source. Two clock options are available in PIN control mode: an external CMOS, or a crystal oscillator. The CLK\_SEL pin is sampled on power-up.

For both  $\overline{\text{PIN}}$  and SPI mode, it is suggested to reset the device whenever the clock source is changed.

Set the EN\_ERR\_EXT\_CLK\_QUAL bit (Register 0x29, Bit 0 detailed in the ADC Diagnostic Feature Control Register section) to turn off the clock qualification. Turning off the clock qualification allows the use of slower external MCLK rates outside the recommended MCLK frequency.

# **CLK\_SEL Pin**

If  $CLK\_SEL = 0$  in  $\overline{PIN}$  control mode, the CMOS clock option is selected and must be applied to the XTAL2 MCLK pin. In this case,

tie the XTAL1 pin to DGND. This connection is illustrated in Figure 75

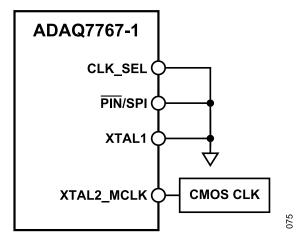


Figure 75. PIN Mode Using an External CMOS Clock as MCLK

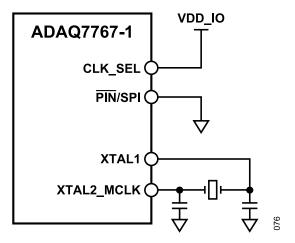


Figure 76. PIN Mode Using an External Crystal as MCLK

If CLK\_SEL = 1 in PIN control mode, the crystal option is selected and must be connected between the XTAL1 and XTAL2\_MCLK pins, as shown in Figure 76. CX1 and CX2 are capacitors connected from each terminal of the crystal to DGND for circuit tuning. The values for these capacitors depend on the length and capacitance of the trace connections between the crystal and the XTAL1 and XTAL2 MCLK pins.

In SPI control mode, the CLK\_SEL pin does not determine the MCLK source used, and CLK\_SEL must be tied to DGND.

# **Using the Internal Oscillator**

In some cases, conversion using an internal clock oscillator may be preferred, such as in isolated applications where DC input voltages must be measured. Converting AC signals with the internal clock is not recommended because using the internal clock can result in degradation of SNR due to jitter.

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## **DIGITAL FILTERING**

The ADAQ7767-1 offers three types of digital filters. The digital filters available on the ADAQ7767-1 are the following:

- ▶ Wideband low ripple FIR filter, -3 dB at 0.433 × ODR (6 rates in SPI control mode)
- Sinc5, low latency filter, −3 dB at 0.204 × ODR (8 rates in SPI control mode)
- Sinc3, low latency filter, −3 dB at 0.2617 × ODR, widely programmable data rate in SPI control mode

#### **Decimation Rate Control**

The ADAQ7767-1 has programmable decimation rates for the sinc and wideband low ripple FIR digital filters, as shown in Table 13. The decimation rates allow the user to band limit the measurement, which reduces the speed and input bandwidth, but increases the resolution because there is further averaging in the digital filter. Control of the decimation rate on the ADAQ7767-1 when using SPI control is set in the Digital Filter and Decimation Control Register for the sinc5 and wideband low ripple FIR filters.

The decimation rate of the sinc3 filter is controlled using the SINC3 Decimation Rate (LSB) Register and the SINC3 Decimation Rate (MSB) Register. These registers combine to provide 13 bits of programmability. The decimation rate is set by incrementing the value in these registers by one and multiplying the value by 32. For example, setting a value of 0x5 in the SINC3 Decimation Rate (LSB) Register results in a decimation rate of 192 for the sinc3 filter.

In  $\overline{\text{PIN}}$  control mode, the MODE0 pin controls the decimation ratio. Only decimation rates of ×32 and ×64 are available for use with the sinc5 and wideband filter options. See Table 22 for the full list of options available in  $\overline{\text{PIN}}$  control mode.

Table 13. Decimation Rate Options

	ation Rates	
Filter Option	SPI Control Mode	PIN Control Mode
Wideband Low Ripple FIR	×32, ×64, ×128, ×256, ×512, ×1024	×32, ×64
Sinc5	×8, ×16, ×32, ×64, ×128, ×256, ×512, ×1024	×8, ×32, ×64
Sinc3	Programmable decimation rate	50 Hz and 60 Hz output only, based on a 16.384 MHz MCLK

# Wideband Low Ripple FIR Filter

The FIR filter is a low ripple, input pass band up to  $0.433 \times ODR$ . The wideband low ripple FIR filter has almost full attenuation of 105 dB at  $0.5 \times ODR$  (Nyquist), maximizing anti-alias protection. The frequency response of the wideband low ripple FIR filter is shown in Figure 77. The wideband low ripple FIR filter has a pass-band ripple of  $\pm 0.005$  dB, shown in Figure 78, and a stop-band attenuation of 105 dB. The wideband low ripple FIR filter is a 64-order digital filter.

The group delay of the filter is 34/ODR. After a sync pulse, there is an additional delay from the SYNC\_IN rising edge to fully settled data. The time from a SYNC\_IN pulse to both the first DRDY and to fully settled data for various ODR values is shown in Table 14.

The wideband low ripple FIR filter can be selected in one of six different decimation rates, allowing the user to choose the optimal input bandwidth and speed of the conversion vs. the desired resolution.

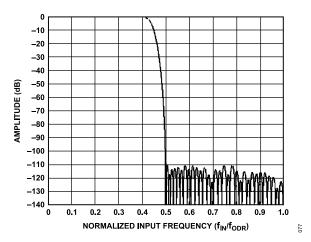


Figure 77. Wideband Low Ripple FIR Filter Frequency Response

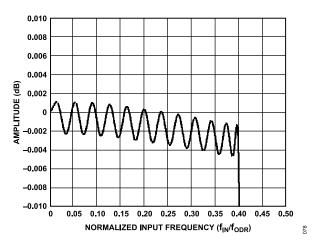


Figure 78. Wideband Low Ripple FIR Filter Pass-Band Ripple

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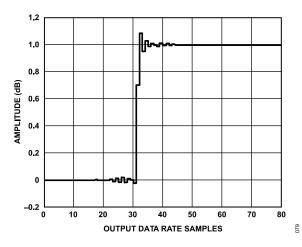


Figure 79. Wideband Low Ripple FIR Filter Step Response

Table 14. Wideband Low Ripple FIR Filter SYNC\_IN to Settled Data

		ODR (kSPS)		MCLK Periods		
MCLK Divide Setting	Decimation Rate	MCLK = 16.384 MHz	MCLK = 13.107 MHz	Delay from First MCLK Rise After SYNC_IN Rise to First DRDY Rise	Delay from First MCLK Rise After SYNC_IN Rise to Earliest Settled DRDY Rise	
MCLK/2	32	256	204.8	284	4,252	
	64	128	102.4	413	8,349	
	128	64	51.2	797	16,669	
	256	32	25.6	1,565	33,309	
	512	16	12.8	3,101	66,589	
	1024	8	6.4	6,157	133,133	
MCLK/4	32	128	102.4	428	8,364	
	64	64	51.2	812	16,684	
	128	32	25.6	1,580	33,324	
	256	16	12.8	3,116	66,604	
	512	8	6.4	6,188	133,164	
	1024	4	3.2	12,300	266,252	
MCLK/16	32	32	25.6	1,674	33,418	
	64	16	12.8	3,202	66,690	
	128	8	6.4	6,274	133,250	
	256	4	3.2	12,418	266,370	
	512	2	1.6	24,706	532,610	
	1024	1	0.8	49,154	1,064,962	

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#### Sinc5 Filter

The sinc5 filter offered in the ADAQ7767-1 enables a low latency signal path useful for DC inputs on control loops, or for where user-specific post processing is required. The sinc5 filter has a -3 dB bandwidth of 0.204 × ODR.

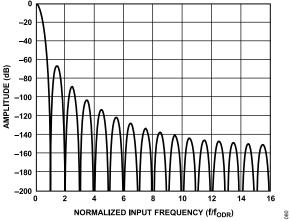


Figure 80. Sinc5 Filter Frequency Response

Table 15. Sinc5 Filter, SYNC IN to Settled Data

1024

1

ODR (kSPS)

The impulse response of the filter is five times 1/ODR. For 250 kSPS ODR, the time to settle data fully is 20 µs. For the 1.024 MSPS ODR, the time to settle data fully is 5 µs.

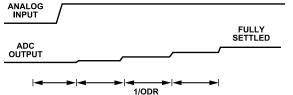


Figure 81. Sinc5 Filter Step Response

The time from a SYNC IN pulse to both the first DRDY and to fully settled data for various ODR values for the sinc5 filter is shown in Table 15.

**MCLK Periods** 

82,818

**Delay from First MCLK Rise After** MCLK = 16.384 MCLK = 13.107 SYNC IN Rise to Earliest Settled **Delay from First MCLK Rise After** SYNC\_IN Rise to First DRDY Rise DRDY Rise **MCLK Divide Setting Decimation Rate** MHz MHz MCLK/2 819.2 46 8 1024 110 16 512 409.6 62 190 32 256 204.8 94 350 102.4 64 128 162 674 128 64 51.2 295 1,319 32 25.6 256 561 2,609 512 16 12.8 1,093 5,189 1024 8 6.4 2,173 10,365 MCLK/4 512 409.6 79 207 8 204.8 16 256 111 367 32 128 102.4 175 687 51.2 64 64 310 1,334 128 32 25.6 576 2,624 256 16 12.8 1.108 5,204 512 8 6.4 2.172 10,364 1024 4 3.2 4.332 20.716 MCLK/16 8 128 102.4 278 790 16 64 51.2 406 1,430 32 32 25.6 662 2,710 64 16 12.8 1,194 5,290 128 8 6.4 2,258 10,450 3.2 4.386 20.770 256 4 512 2 1.6 8.642 41.410

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17,282

8.0

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# **Programming for 1.024 MSPS Output Data Rate**

A 1.024 MSPS, sinc5 filter path exists for users seeking an even higher ODR than is achievable using the wideband low ripple FIR filter. This path is quantization noise limited. Therefore, it is best suited for customers requiring minimum latency for control loops or implementing custom digital filtering on an external field programmable gate array (FPGA) or digital signal processor (DSP).

To configure the sinc5 FIR filter for a 1.024 MSPS output data rate, write 001 to the FILTER bits (Register 0x19, Bits[6:4]) of Digital Filter and Decimation Control Register. The ADAQ7767-1 automatically changes the decimation rate to 8 and the output data length is reduced to 16 bits from 24 bits due to the maximum speed limitation of the digital serial interface.

For example, to program the ADAQ7767-1 to an 1.024 MSPS output data rate from power up using a 16.384 MHz MCLK, while using the CMOS MCLK as the clock source, the subsequent SPI writes that follow can be used:

- ▶ Data 0x33 to Register 0x15
- ▶ Data 0x10 to Register 0x19

# Sinc3 Filter

The sinc3 filter in the ADAQ7767-1 enables a low latency signal path useful for DC inputs on control loops or eliminates unwanted known interferers at specific frequencies. The sinc3 filter path incorporates a programmable decimation rate to reject known interferers. Decimation rates from 32 to 185,280 are achievable using the sinc3 filter. The sinc3 filter has a −3 dB bandwidth of 0.2617 × ODR.

For example, to calculate the DEC\_RATE of the sinc3 filter with a 16.384 MHz MCLK and ODR of SPS with MCLK\_DIV = 2, use the following equation:

$$DEC\_RATE = \frac{MCLK}{MCLK\_DIV \times ODR}$$

$$DEC\_RATE = \frac{16.384 \text{ MHz}}{2 \times 50} = 163,840$$

To program the sinc3 decimation ratio, the user must first calculate the equivalent sinc3 decimation ratio to be written on the SINC3 Decimation Rate (MSB) Register (Register 0x1A) and SINC3 Decimation Rate (LSB) Register (Register 0x1B) using the following equation:

$$Value = \frac{DEC\_RATE}{32} - 1 = 5119$$

To set the decimation ratio to 163,840, write the equivalent binary value of 5119 to the SINC3 Decimation Rate (MSB) Register (Registers 0x1A) and SINC3 Decimation Rate (LSB) Register (Register 0x1B) because the value in these registers are incremented by 1 and then multiplied by 32 to give the actual decimation rate.

Table 16 and Table 17 list the values to be written to the sinc3 decimation registers to achieve an ODR of 50 SPS and 60 SPS, respectively, for various MCLK and MCLK DIV.

Table 16. Sinc3 Decimation Register Values for 50 SPS ODR Using Various MCLK and MCLK DIV

MCLK (MHz)	MCLK_DIV	Decimation Rate	Value in DEC_RATE Register
16.384	2	163840	5119
	4	81920	2559
	8	40960	1279
	16	20480	639
13.1072	2	131072	4095
	4	65536	2047
	8	32768	1023
	16	16384	511

Table 17. Sinc3 Decimation Register Values for 60 SPS ODR Using Various MCLK and MCLK DIV

MCLK (MHz)	MCLK_DIV	Decimation Rate	Value in DEC_RATE Register
16.384	2	136533	4266
	4	68267	2132
	8	34133	1066
	16	17067	532
13.1072	2	109227	3412
	4	54613	1706
	8	27307	852
	16	13653	426

# Programming for 50 Hz, 60 Hz, and 50 Hz and 60 Hz Rejection

To reject 50 Hz tones, program the ODR of the sinc3 filter to 50 Hz (see Figure 82). It is also possible to achieve simultaneous rejection of both 50 Hz and 60 Hz by setting the EN\_60HZ\_REJ bit (Register 0x19, Bit 7) in the Digital Filter and Decimation Control Register. Rejection of both the 50 Hz and 60 Hz line frequencies is possible in this configuration. Table 18 and Table 19 list the minimum rejection measured at the frequencies of interest with a 50 SPS ODR.

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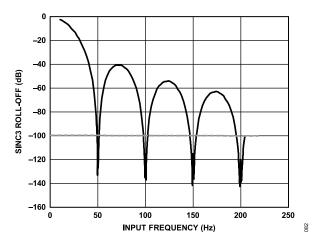


Figure 82. Sinc3 Filter Frequency Response Showing 50 Hz Rejection, 50 Hz ODR, ×163,840 Decimation

Table 18. Sinc3 Filter 50 Hz Rejection, 50 SPS ODR and Decimate by 163,840

Frequency Band (Hz)	Minimum Measured Rejection (dB)
50 ± 1	101
100 ± 2	102
150 ± 3	102
200 ± 4	102

Table 19. Sinc3 Filter 50 Hz and 60 Hz Rejection, 50 SPS ODR and Decimate by 163,840

Frequency Band (Hz)	Minimum Measured Rejection (dB)
50 ± 1	81
60 ± 1	67
100 ± 2	83
120 ± 2	72
150 ± 3	86
180 ± 3	78
200 ± 4	90
240 ± 4	87

The impulse response of the filter is three times 1/ODR. For a 250 kSPS ODR, the time to settle data fully is 12  $\mu$ s.

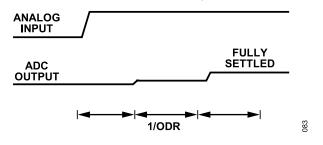


Figure 83. Sinc3 Filter Step Response

Table 20. Sinc3 Filter, SYNC\_IN to Settled Data

			ODR	(kSPS)	MCLK	Periods
MCLK Divide Setting	Decimation Rate	Value in DEC_RATE register	MCLK = 16.384 MHz	MCLK = 13.107 MHz	Delay from First MCLK Rise After SYNC_IN Rise to First DRDY Rise	Delay from First MCLK Rise After SYNC_IN Rise to Earliest Settled DRDY Rise
MCLK/2	32	0	256	204.8	127	255
	64	1	128	102.4	191	447
	128	3	64	51.2	319	831
	256	7	32	25.6	575	1,599
	512	15	16	12.8	1,087	3,135
	1024	31	8	6.4	2,111	6,207
	163,840	5119	0.05	0.04	327,743	983,103
MCLK/4	32	0	128	102.4	241	497
	64	1	64	51.2	369	881
	128	3	32	25.6	625	1,649
	256	7	16	12.8	1,137	3,185
	512	15	8	6.4	2,161	6,257
	1024	31	4	3.2	4,209	12,401
	81,920	2559	0.05	0.04	327,793	983,153
MCLK/16	32	0	32	25.6	926	1,950
	64	1	16	12.8	1,438	3,486
	128	3	8	6.4	2,462	6,558
	256	7	4	3.2	4,510	12,702
	512	15	2	1.6	8,606	24,990
	1024	31	1	0.8	16,798	49,566
	20,480	639	0.05	0.04	328,094	983,454

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## **TOTAL GROUP DELAY**

Both the AFE and the digital filter have a linear phase response and a constant group delay across the pass band. As a complete signal chain, the total group delay from the INx input to the ADC output is as follows:

where:

Analog Group Delay is the delay from the AFE listed in the specifications.

Digital Filter Group Delay is the delay from the selected digital filter and ODR, listed in the specifications.

#### ADC SPEED AND PERFORMANCE

The ADAQ7767-1 offers a wide selection of ODR depending on the digital filter used. The ADAQ7767-1 can have an ODR as low as 1 kSPS using the wideband low ripple filter and sinc5 filter, and as low as 0.0125 kSPS using the sinc3 filter, which can be achieved using a high decimation ratio and operating the modulator at the lowest possible sampling rate. For example, with the wideband low ripple filter option, 1 kSPS ODR can be achieved using MCLK = 16.384 MHz, decimation rate = 1024, and  $f_{MOD}$  = MCLK / 16.

Note that the ADAQ7767-1 modulator samples on the rising and falling edge of the  $f_{MOD}$  and outputs data to the digital filter at a rate of  $f_{MOD}$ . There is a zero in the frequency response profile of the modulator centered at the odd multiples of  $f_{MOD}$ , which means there is no foldback from frequencies at the  $f_{MOD}$  rate and at odd multiple rates. However, the modulator is open to noise for even multiples of  $f_{MOD}$ . There is no attenuation at these zones.

For optimum performance, it is recommended to use MCLK = 16.384 MHz and MCLK\_DIV = 2, which sets the  $f_{MOD}$  = 8.192 MHz, and by keeping the  $f_{MOD}$  frequency high, it maximizes the out-of-band tone rejection from the front-end, anti-aliasing filter.

The default controller clock divider setting for the ADAQ7767-1 is MCLK\_DIV = 16. To configure the MCLK divider to MCLK\_DIV = 2, write 11 to the MCLK\_DIV bits (Register 0x15, Bits[5:4]) of the Power and Clock Control Register after power up.

Figure 84 shows the AAF rejection relative to  $f_S$ . Using a higher MCLK divider results in lower  $f_S$  with reduced rejection from the anti-alias filter.

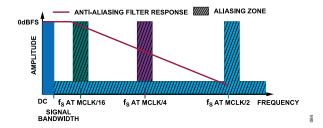


Figure 84. Anti-Alias Filter Response vs. MCLK Divider

#### **DEVICE CONFIGURATION METHOD**

The ADAQ7767-1 has two options for controlling device functionality. On power-up, the mode is determined by the state of the PIN/SPI pin. The two modes of configuration are as follows:

- ▶ SPI: over a 3- or 4-wire SPI (complete configurability)
- ▶ PIN: pin-strapped digital logic inputs (a subset of complete configurability)

On power-up, apply a soft or <u>hard reset</u> to the ADAQ7767-1 when using either control mode. A <u>SYNC\_IN</u> pulse is also recommended after the reset or after any change to the device configuration. Choose between controlling and configuring over the SPI or via pin connections only.

The first design decision is setting the ADC in either the SPI or PIN mode of configuration. In either mode, the digital host reads the ADC data over the SPI port lines.

#### **PIN** Control Mode

An overview of the PIN control mode features follows:

- ▶ No SPI write access to the device.
- ▶ Pins control all functions.
- ▶ ADC results read back over the SPI pins.
- ADC result includes an 8-bit status header output after each conversion result.
- ► The SDI pin can be used to create a daisy chain of multiple devices operating in PIN mode.

#### **SPI Control Mode**

An overview of the SPI control mode features follows:

- ▶ The Standard SPI Mode 3 interface for register access, where the ADC always behaves as an SPI target.
- ▶ Indication of a new conversion via the DRDY pin output. A second method allows the user to merge the ready (RDY) signal within the DOUT output stream, which allows a reduction in the number of lines across an isolation barrier.
- Reading back conversions can be performed by writing 8 bits to address the ADC register and reading back the result from the register.
- ▶ Continuous readback mode, which is enabled via an SPI write. There is no need to supply the 8 bits to address the Conversion Result Register (ADC\_DATA, Register 0x2C). Data readback occurs on the application of SCLK. The DRDY pin indicates that a conversion result is complete and can be used to trigger a readback of the conversion result.
- ▶ In continuous read back mode, there is the option to append either the 8-bit status header or an 8-bit cyclic redundancy check (CRC) check, or both.

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## PIN CONTROL MODE OVERVIEW

PIN control mode eliminates the need for SPI communication to set the required mode of operation. It is best used for situations where the user requires a single, known configuration, to reduce routing signals to the digital host. PIN control mode is useful in digitally isolated applications where minimal configuration is needed. PIN control mode offers a subset of the core functionality and ensures a known state of operation after power-up, reset, or a fault condition on the power supply. In PIN control mode, the linearity boost buffers and the reference input precharge buffers are enabled by default for best performance.

An automatic sync pulse drives out on the SYNC\_OUT pin in PIN control mode when the device is either initially powered up or after a reset. A SYNC\_OUT pulse also occurs when a GPIOx pin toggles, meaning after a change to the PIN control mode settings of the device, the synchronization is automatically performed. For this synchronization to work, tie SYNC\_OUT to SYNC\_IN, eliminating the need to provide a synchronous SYNC\_IN pulse. The SYNC\_OUT of one device can also be tied to the SYNC\_IN of many devices when the synchronization of multiple devices is required. If synchronization of multiple devices is required, all devices must share a common MCLK.

# **Data Output Format**

PIN control mode has a set output format for conversion data. The rising DRDY edge indicates that a new conversion is ready. The next 24 serial clock falling edges clock out the 24-bit ADC result. The following eight serial clocks output the status bits of the ADAQ7767-1. The ADC data is output MSB first in twos complement format. If further SCLK falling edges are applied to the ADC after clocking out the status bits, the logic level applied to SDI is clocked out, similar to a daisy-chain scenario. In Figure 85, an extra serial clock edge (33<sup>rd</sup> falling edge) is shown. If an extra serial clock edge occurs, the logic level of the SDI pin clocks out.

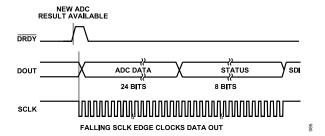


Figure 85. PIN Mode Data Output Format (This Figure Does Not Show the CS Signal)

Table 21. Differences in Control and Interface Pin Functions in PIN Control Mode and SPI Control Mode

		Pin Function
Mnemonic	PIN Control Mode	SPI Control Mode
MODE0/GPIO0	MODE0 configuration pin	GPIO0 pin
MODE1/GPIO1	MODE1 configuration pin	GPIO1 pin
MODE2/GPIO2	MODE2 configuration pin	GPIO2 pin
MODE3/GPIO3	MODE3 configuration pin	GPIO3 pin
CS	SPI pin for readback of ADC conversion results	SPI for full configuration of the ADAQ7767-1 via a register read/write and readback of the ADC conversion results
SCLK	SPI pin for readback of ADC conversion results	SPI for full configuration of the ADAQ7767-1 via a register read/write and readback of the ADC conversion results
SDI	SPI pin for readback of ADC conversion results	SPI for full configuration of the ADAQ7767-1 via a register read/write and readback of the ADC conversion results
DOUT/RDY	SPI pin for readback of ADC conversion results	SPI for full configuration of the ADAQ7767-1 via a register read/write and readback of the ADC conversion results

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# **Diagnostics and Status Bits**

PIN control mode offers a subset of diagnostics features. Internal errors are reported in the status header output with the data conversion results for each channel.

The status header reports the internal CRC errors, memory map flipped bits, and the undetected external clock, indicating a reset is required. The status header also reports filter settled and filter saturated signals. Users can determine when to ignore data by monitoring these error flags.

If a significant error shows in the status bits, a reset of the ADC using the  $\overline{\text{RESET}}$  pin is recommended because, in  $\overline{\text{PIN}}$  mode, there is no way to interrogate further for specific errors.

# Daisy-Chaining—PIN Control Mode Only

Daisy-chaining devices allows multiple devices to use the same data interface lines by cascading the outputs of multiple ADCs from separate ADAQ7767-1 devices. Daisy-chaining devices is only possible in PIN control mode.

When configured for daisy-chaining, only one ADAQ7767-1 device has its data interface in direct connection with the digital host. For

the ADAQ7767-1 cascading the DOUT/RDY pin of the upstream ADAQ7767-1 device to the SDI pin of the next downstream ADAQ7767-1 device in the chain implements this daisy-chaining. The ability to daisy-chain devices and the limit on the number of devices that can be handled by the chain is dependent on the serial clock frequency used and the time available to clock through multiple 32-bit conversion outputs (24-bit conversion + 8-bit status) before the next conversion is complete.

The daisy-chaining feature is useful to reduce component count and to wire connections to the controller.

Figure 86 shows an example of daisy-chaining multiple ADAQ7767-1 devices.

The daisy-chain scheme depends on all devices receiving the same MCLK and SCLK, being synchronized, and being configured with the same decimation rate. The chip select signal (CS) gates each conversion chain of data, its rising edge resetting the SPI to a known state after each conversion ripples through. The ADAQ7767-1 device that is furthest from the controller must have its SDI pin tied to VDD IO, logic high.

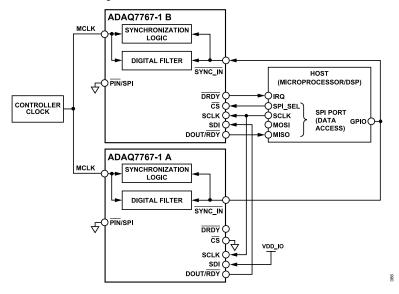


Figure 86. Daisy-Chaining Multiple ADAQ7767-1 Devices

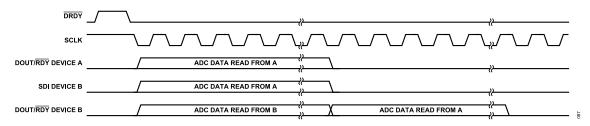


Figure 87. Data Output Format When Devices Daisy-Chained (PIN Control Mode Only)

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Table 22. PIN Control Settings for MODEx Pins

		MODEx Pin Se	ttings			ADC Configuration		
MODEx (Hex)	MODE3/ GPIO3	MODE2/ GPIO2	MODE1/ GPIO1	MODE0/ GPIO0	f <sub>MOD</sub> Frequency	Filter	Decimation	MCLK = 16.384 MHz
0	0	0	0	0	MCLK/2	Wideband low ripple FIR	×32	256 kSPS
1	0	0	0	1	MCLK/2	Wideband low ripple FIR	×64	128 kSPS
2	0	0	1	0	MCLK/2	Sinc5	×32	256 kSPS
3	0	0	1	1	MCLK/2	Sinc5	×64	128 kSPS
4	0	1	0	0	MCLK/4	Wideband low ripple FIR	×32	128 kSPS
5	0	1	0	1	MCLK/4	Wideband low ripple FIR	×64	64 kSPS
6	0	1	1	0	MCLK/4	Sinc5	×32	128 kSPS
7	0	1	1	1	MCLK/4	Sinc5	×64	64 kSPS
8	1	0	0	0	MCLK/16	Wideband low ripple FIR	×32	32 kSPS
9	1	0	0	1	MCLK/16	Wideband low ripple FIR	×64	16 kSPS
A	1	0	1	0	MCLK/16	Sinc5	×32	32 kSPS
В	1	0	1	1	MCLK/16	Sinc5	×64	16 kSPS
С	1	1	0	0	MCLK/2	Sinc5	×8	833 kSPS <sup>1</sup>
D	1	1	0	1	MCLK/2	Sinc3 50 Hz and 60 Hz rejection <sup>2</sup>	×163,840	50 SPS
E	1	1	1	0	MCLK/16	Sinc3 50 Hz and 60 Hz rejection <sup>2</sup>	×20,480	50 SPS
F	1	1	1	1		ADC	Standby	·

<sup>1</sup> In PIN mode, only the sinc5, MCLK/2, decimate by 8 configuration cannot be used with a 16.384 MHz MCLK due to the lack of SCLK pulses to drive out the 24-bit output (16-bit ADC data + 8-bit status) given that the maximum SCLK is 20 MHz. The maximum data rate possible when used with a 13.33 MHz MCLK is 833 kSPS.

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<sup>&</sup>lt;sup>2</sup> Sinc3 filter, rejection of 50 Hz and 60 Hz. Rejection of 50 Hz and 60 Hz is possible only if the MCLK applied in control mode is equal to 16.384 MHz. The decimation rate is tuned internally for these PIN mode settings so that the sinc filter notches fall at 50 Hz and 60 Hz.

# **THEORY OF OPERATION**

# **SPI CONTROL OVERVIEW**

SPI control offers a superset of flexibility and diagnostics to the user, and the categories described in Table 23 define the major controls, conversion modes, and diagnostic monitoring abilities enabled in SPI control mode.

Table 23. SPI Control Capabilities

SPI Control	Capabilities	Meaning for the User		
MCLK Division	MCLK/2 to MCLK/16	The ability to customize clock frequency relating to the bandwidth of interest.		
MCLK Source	CMOS, crystal, LVDS, and internal clock	Allows the user a distributed or local clock capability.		
Digital Filter Style	Wideband low ripple FIR, sinc5, sinc3 (programmable)	The ability to customize the latency and frequency response to the measurement target of the user and its bandwidth.		
Interface Format	Bit length	The ability to change between a 24-bit and a 16-bit conversion length in continuous read mode.		
	Status bits	The ability to view output device status bits with the ADC conversion results.		
	CRC	The ability to implement error checking when transmitting data.		
	Data streaming	The ability to stream conversion data, eliminating interface write overhead.		
Analog Buffers	Linearity boost buffer	Boost the linearity performance.		
	Reference input precharge	Reduce reference input current, making it easier to filter the reference.		
	Reference input full buffer	This full, high impedance buffer enables filtering of the reference source and enables high impedance sources, that is, reference resistors.		
Conversion Modes	Single conversion	The ability to return to standby after one conversion.		
	One shot	The ability to perform a conversion similar to a timed successive approximation register (SAR) conversion, in which the ADAQ7767-1 converts on a timed pulse.		
	Continuous conversion	Normal operation keeps the modulator continually converting, offering the fastest response to a change on the input.		
	Duty-cycled conversion	The ability to save more power for point conversions. Times the rate of conversion and sets the time for the ADC to remain in standby after the conversion completes.		
Conversion Targets	ADC inputs	The ability to measure the input signal applied at the ADC input.		
	Temperature sensor	The ability to measure local temperatures with an on-chip temperature sensor. Used for relative temperature measurement.		
	Diagnostic sources	The ability to measure reference inputs and internal voltages for periodic functional safety checking.		
GPIO Control	Up to four GPIOx pins	The ability to control other local hardware (such as gain stages), to power down other blocks in the signal chain, or to read local status signals over the SPI of the ADAQ7767-1.		
System Offset and Gain Correction	System calibration routines	The ability to correct offset and/or gain by writing to registers when the environment changes (that is, th temperature increases). Requires characterization of system errors to feed these registers.		
Diagnostics	Internal checks and flags	Users can have the highest confidence in the conversion results.		

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## **SPI CONTROL MODE**

## **MCLK Source and MCLK Division**

MCLK division (MCLK\_DIV) bits (Register 0x15, Bits[5;4]) control the divided ratio between the MCLK applied at the input to the ADAQ7767-1 and the clock used by the ADC modulator. Select the division ratio best for configuration of the clocks.

The following options are available as the MCLK input source in SPI mode:

- ▶ LVDS
- External crystal
- ▶ CMOS input MCLK

From the Power and Clock Control Register, set the CLOCK\_SEL bits (Register 0x15, Bits[7:6]) to 00 to configure the ADAQ7767-1 for a CMOS clock, and set these bits to 01 to enable the use of an external crystal. Setting these bits to 10 enables the application of the LVDS clock to the XTAL2\_MCLK pin. LVDS clocking is exclusive to SPI mode and requires register selection for operation.

## **ADC Power-Down Mode**

All blocks on the core ADC are turned off. A specific code is required to wake the ADC up. All register contents are lost when entering power-down mode. Ensure the FDA is powered down or is in standby mode before entering the ADC into power-down mode. Connecting the M0\_ADC and M1\_ADC to M0\_FDA and M1\_FDA, respectively, automatically powers down the FDA when the ADC is in power-down mode. The ADC power-down mode can be set from the Power and Clock Control Register.

# **ADC Standby Mode**

The analog clocking and power functions of the core ADC are powered down. The digital LDO regulator and register settings are retained when in standby mode. This mode is best used in scenarios where the ADC is not in use, briefly, and the user wants to save power. See the Data Conversion Modes section for more details on how to set the ADC to standby mode.

# SPI Synchronization

The ADAQ7767-1 can be synchronized over the SPI. The final SCLK rising edge of the command is the instance of synchronization. This command initiates the \$\overline{SYNC\_OUT}\$ pin to pulse active low and then back active high again. \$\overline{SYNC\_OUT}\$ is a signal synchronized internally to the MCLK of the ADC. Connecting the output of \$\overline{SYNC\_OUT}\$ to the \$\overline{SYNC\_IN}\$ input synchronizes that individual ADC. Routing \$\overline{SYNC\_OUT}\$ to other ADAQ7767-1 devices also ensures the devices are synchronized, as long as the devices share a common MCLK source, as shown in Figure 88.

It is recommended to perform synchronization functions directly after the  $\overline{DRDY}$  pulse. If the ADAQ7767-1  $\overline{SYNC\_IN}$  pulse occurs too close to the upcoming  $\overline{DRDY}$  pulse edge, the upcoming  $\overline{DRDY}$  pulse may still be output because the  $\overline{SYNC\_IN}$  pulse has not yet propagated through the device.

When using the <u>SYNC\_OUT</u> function with an <u>VDD\_IO</u> voltage of 1.8 V, it is recommended to set the <u>SYNC\_OUT\_POS\_EDGE</u> bit to 1 (Register 0x1D, Bit 6) in the <u>Synchronization Modes and Reset Triggering Register.</u>

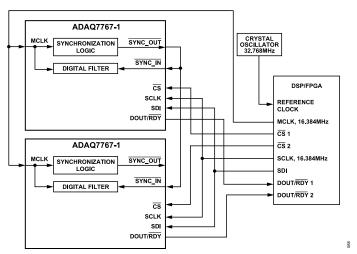


Figure 88. Basic SPI Synchronization Diagram

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## Offset Calibration

In SPI control mode, the ADAQ7767-1 has the ability to calibrate the offset and gain. There are options to alter the gain and offset of the ADAQ7767-1 and its subsystem. These options are available in SPI control mode only.

The offset correction registers provide 24-bit, signed, twos complement registers for channel offset adjustment. If the channel gain setting is at the ideal nominal value of 0x555555, an LSB of the offset register adjustment changes the digital output by -4/3 LSBs. For example, changing the offset register from 0 to 100 changes the digital output by -133 LSBs. Because offset calibration occurs before gain calibration, the LSB ratio of -4/3 changes linearly with gain adjustment through the gain correction registers.

The Offset Calibration MSB Register, Offset Calibration MID Register, and Offset Calibration LSB Register sections provide further register information and calibration instructions.

## **Gain Calibration**

In SPI control mode, alter the gain and offset of the ADAQ7767-1 and its subsystem. These options are available in SPI control mode only.

The ADC has an associated gain coefficient stored for each ADC after factory programming. Nominally, this gain is approximately 0x555555 (for an ADC channel). Overwrite the gain register setting. However, after a reset or power cycle, the gain register values revert to the hard-coded, programmed factory setting.

$$\begin{array}{l} ADC\_DATA = \\ \left(\frac{3 \times V_{IN} \times AFE\_GAIN}{V_{REF}} \times 2^{21} - \left(OffsetCaI\right)\right) \times \\ \frac{GainCal}{4} \times \frac{4,194,300}{2^{42}} \end{array} \tag{12}$$

where:

ADC\_DATA (Register 0x2C, see the Conversion Result Register section) is in the twos complement format.

OffsetCal is the decimal value from the offset calibration registers (Register 0x21, Register 0x22, and Register 0x23, see the Offset Calibration MSB Register, Offset Calibration MID Register, and Offset Calibration LSB Register).

GainCal is the decimal value from the gain calibration registers (Register 0x24, Register 0x25, and Register 0x26). The gain calibration register sections provides further register information and calibration instructions (see the Gain Calibration MSB Register, Gain Calibration MID Register, and Gain Calibration LSB Register.

# Reset over SPI Control Interface

Issue a reset command to the ADAQ7767-1 by writing to the SPI\_RESET bits (Register 0x16, Bits[1:0]) in the Synchronization Modes and Reset Triggering Register. Two successive writes to these bits are required to initiate the device reset.

## **Resume from Shutdown**

Shutdown mode features the lowest possible current consumption with all blocks on the device turned off, including the standard SPI. Therefore, to wake the ADC up from this mode, either a hardware reset on the  $\overline{\text{RESET}}$  pin or a specific code on the SPI SDI input is required. The specific sequence required on SDI consists of a 1 followed by 63 zeros, clocked in by SCLK while  $\overline{\text{CS}}$  is low, which allows the system to wake up the ADAQ7767-1 from shutdown without using the  $\overline{\text{RESET}}$  pin. This reset function is useful in isolated applications where the number of pins brought across the isolation barrier must be minimized.

# **GPIO and START Functions**

When operating in SPI mode, the ADAQ7767-1 has additional GPIO functionality. This fully configurable mode allows the device to operate four GPIOs. These pins can be configured as read or write in any order.

GPIO read is a useful feature because it allows a peripheral device to send information to the input GPIO. Then, this information can be read from the SPI of the ADAQ7767-1.

The GPIOx pins can be set as inputs or outputs on a per pin basis, and there is an option to configure outputs as open-drain.

In SPI control mode, one of the GPIOx pins can be assigned the function of the START input. The START function allows a signal asynchronous to MCLK to be used to generate the SYNC OUT signal to reset the digital filter path of the ADAQ7767-1. The START pin function can be enabled on GPIO3.

# **SPI Mode Diagnostic Features**

The ADAQ7767-1 includes diagnostic coverage across the internal blocks within the core ADC. The diagnostics in the following list allow the user to monitor the ADC and to increase confidence in the fidelity of the data acquired:

- ▶ Reference detection
- Clock qualification
- ▶ CRC on SPI transaction
- ▶ Flags for detection of an illegal register write
- ▶ CRC checks
- Power-on reset (POR) monitor
- MCLK counter

In addition, these diagnostics are useful in situations where instruments require remote checking of power supplies and references during initialization stages.

The diagnostics are selectable by the user via the SPI Diagnostic Control Register, ADC Diagnostic Feature Control Register, and Digital Diagnostic Feature Control Register. The flags for POR and the clock qualification are on by default. The flags are readable via

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registers but also ripple through to the top-level status bits that can be output with each ADC conversion, if desired.

#### **Reference Detection**

Write 1 to the EN\_ERR\_REF\_DET bit (Register 0x29, Bit 3) of the ADC Diagnostic Feature Control Register to enable the reference detection block in SPI control mode. When enabled, the error flags in the ADC Diagnostics Output Register (Register 0x2F). Any error flags then propagate through to the Device Error Flags Main Register (Register 0x2D). The reference error flags when the reference applied on the REF+ pin is less than 1/3 of (VDD\_ADC - AGND).

#### **Clock Qualification**

The clock qualification check attempts to detect when a valid MCLK is detected. When the MCLK applied is greater than 600 kHz, the clock qualification passes. The error flags in both the ADC Diagnostics Output Register (Register 0x2F) and the Device Error Flags Main Register (Register 0x2D). If the clock detected is less than the 600 kHz frequency threshold, or if an external MCLK is not detected, the clock qualification error bit is set to 1. To disable the clock qualification check, write 0 to the EN\_ERR\_EXT\_CLK\_QUAL bit (Register 0x29, Bit 0) of the ADC Diagnostic Feature Control Register.

#### **CRC on SPI Transaction**

See the CRC Check on Serial Interface section for more details.

# Flags for Detection of Illegal Register Write

See the SPI Control Interface Error Handling section for more details.

#### **CRC Checks**

Enable CRC checks in the Digital Diagnostic Feature Control Register (Register 0x2A) to check the state of the memory map of the

ADAQ7767-1 and the internal random-access memory (RAM) and fuse settings. If any of these errors flag on the device, perform a reset to return the device to a valid state.

## **POR Monitor**

The POR monitor flag appears in both the register and the status bits when output. The POR flag indicates that a reset or a temporary supply brown out occurred.

## **MCLK Counter**

The MCLK Diagnostic Output Register (Register 0x31) updates every 64 MCLKs. The MCLK counter register verifies that the ADAQ7767-1 is still receiving a valid MCLK. Read the MCLK counter register according to the specific MCLK to SCLK ratio to ensure that a valid read occurs. The SCLK applied to read the MCLK\_COUNTER register must be less than 2.1 × MCLK or greater than 4.6 × MCLK. For example, if MCLK = 2 MHz, the SCLK applied cannot be in the 4.2 MHz to 9.2 MHz range. If the MCLK to SCLK ratio is not adhered to, the read may corrupt because the MCLK may update during the read of the register, causing an error.

# **Product Identification (ID) Number**

The ADAQ7767-1 contains ID registers that allow software interrogation of the silicon. The class of the product (precision ADC), product ID, device revision, and grade of device can all be read from the registry over the SPI. The vendor ID for Analog Devices, Inc., is also included in the registry for readback. These registers, in addition to a scratch pad that allows free reads from and writes to a specific register address, are methods of verifying the correct operation of the serial control interface.

Table 24. Product Identification Registers

Register Address (Hex)	Name		Bit Fields	
0x03	Chip type	Reserved	Class	
0x04	Product ID [7:0]	PF	RODUCT_ID[7:0]	
0x05	Product ID [15:8]	PR	PRODUCT_ID[15:8]	
0x06	Grade and revision	Grade	DEVICE_REVISION	
0x0A	Scratch pad		Value	
0x0C	Vendor ID		VID[7:0]	
0x0D			VID[15:8]	

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#### **QUICK START-UP GUIDE**

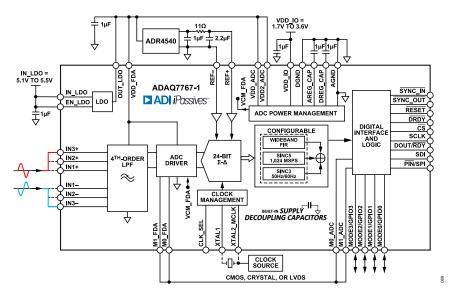


Figure 89. Typical Connection Diagram of ADAQ7767-1

#### POWER SUPPLY CONNECTION

The ADAQ7767-1 has several power supplies to power each block of the signal chain. To reduce the number of power supplies needed to power up the device, the ADAQ7767-1 has a built-in LDO regulator to supply power to VDD\_FDA, VDD\_ADC, and VDD2\_ADC. The LDO regulator can also supply the power required by the recommended voltage reference, ADR4540. The LDO regulator can handle an input voltage range of 5.1 V to 5.5 V. For proper operation, it is recommended to use a 1  $\mu\text{F}$  capacitor at the input and output of the LDO regulator. If the LDO regulator is not used during normal operation, it is recommended to keep all the LDO regulator pins floating.

VDD\_IO powers the internal regulator needed by the digital logic of the ADC, and VDD\_IO is referenced to DGND and can vary from 1.7 V to 3.6 V.

The ADAQ7767-1 has a built-in,  $0.1~\mu F$  internal decoupling capacitor on each power supply. For detailed information regarding power supply connection and decoupling, see the Power Supplies section and Power Supply Decoupling section.

Table 25. Power Supply Voltage Requirements

		Supply Voltage (V)				
Supplies	Minimum	Typical	Maximum			
IN_LDO	5.1	5.3	5.5			
VDD_FDA	4.75	OUT_LDO (5)	5.5			
VDD_ADC	4.75	OUT_LDO (5)	5.5			
VDD2_ADC	2	OUT_LDO (5) or 2.5	5.5			
VDD_IO	1.7	1.8	3.6			

#### **DEVICE CONTROL MODE**

The ADAQ7767-1 has two options to control device functionality. On power-up, the mode is determined by the state of the  $\overline{PIN}/SPI$  pin. The two modes of configuration are as follows:

- ▶ PIN/SPI = VDD\_IO = SPI control mode: over a 3- or 4-wire SPI (complete configurability), suggested control mode.
- ▶ PIN/SPI = DGND = PIN control mode: pin-strapped digital logic inputs (a subset of complete configurability, daisy-chain is available only at this mode)

The first design decision is setting the ADC in either the SPI or  $\overline{\text{PIN}}$  mode of configuration.

On power-up, apply a soft or hard reset to the device when using either control mode. A SYNC\_IN pulse is also recommended after the reset or after any change to the device configuration. Choose between controlling and configuring over the SPI or through pin connections only.

The Device Configuration Method section provides a detailed discussion on the capability and limitations of the two control mode options.

# INPUT RANGE SELECTION

The ADAQ7767-1 input is a low noise, low distortion, high bandwidth ADC driver with a fourth-order anti-aliasing filter. It has three differential input pairs: IN1+ and IN1-, IN2+ and IN2-, and IN3+ and IN3-, from which the user selects from. Each input pair has a fixed gain, leading to full-scale ranges of  $\pm 4.096$  V,  $\pm 11.264$  V, and  $\pm 28.672$  V differential, respectively. Noise performance across various input ranges and ADC configurations are detailed in the Noise Performance section.

# **GPIO Pins**

A common use of the GPIO pins is to digitally control the gain settings of a programmable gain amplifier (PGA) used as a high impedance amplifier at the input of the ADAQ7767-1. The PGA gain pins can be connected to the GPIO pins of the ADAQ7767-1 to enable the user to control the PGA gain over SPI. When the GPIO

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pins are used to control the gain, the user must configure the GPIO Port Control Register (Register 0x1E) to enable the GPIO and set the necessary GPIO ports as outputs. To set the logic output level for the GPIO pins, configure the GPIO Output Control Register (Register 0x1F).

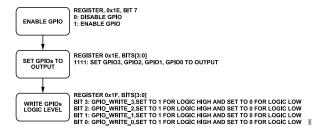


Figure 90. GPIO Gain Control Flowchart

For example, if a connected PGA has GAIN0, GAIN1, and GAIN2 as gain control pins, these pins can be connected to the GPIO0, GPIO1, and GPIO2 pins, respectively, of the ADAQ7767-1. In SPI control mode, the user can enable the GPIO control port and set the necessary GPIO pins as outputs by writing 0x87 to the GPIO Port Control Register (Register 0x1E). By default, the GPIO Output Control Register (Register 0x1F) has an output logic low to GPIO0, GPIO1, and GPIO2.

# SELECTING THE MCLK DIVIDER AND SOURCE

### **MCLK Source Selection**

Program the MCLK source using the two control mode options, PIN and SPI control modes.

In  $\overline{\text{PIN}}$  control mode, the CLK\_SEL pin sets the external MCLK source. Three clock options are available in  $\overline{\text{PIN}}$  control mode: an internal oscillator, an external CMOS, or a crystal oscillator.

- Set CLK\_SEL = 0 in PIN control mode to select the CMOS clock option and apply the external CMOS clock signal to the XTAL2 MCLK pin. In this case, tie the XTAL1 pin to DGND.
- Set CLK\_SEL = 1 in PIN control mode to select the crystal option and connect the external crystal across the XTAL1 and XTAL2 MCLK pins.

In SPI control mode, the ADAQ7767-1 has an internal oscillator used for initial power-up of the device. After the ADAQ7767-1 completes the start-up routine, there is a clock handover to the external MCLK. The following options are available for the MCLK input source and can be set from the CLOCK\_SEL bits (Register 0x15, Bits[7:6]) in the Power and Clock Control Register:

- ▶ CLOCK SEL bits = 00: CMOS clock on the XTAL2 MCLK
- ► CLOCK SEL bits = 01: external crystal oscillator
- CLOCK\_SEL bits = 10: LVDS input enable (exclusive to SPI control mode)
- ► CLOCK SEL bits = 11: internal coarse RC clock (diagnostics)

When switching from one clock source to another, apply a soft reset to the device.

For optimum AC performance, it is not recommended to use in the internal clock as the MCLK source.

#### **MCLK Divider**

The MCLK signal received by the ADAQ7767-1 defines the  $\Sigma\text{-}\Delta$  modulator clock rate of the ADC core ( $f_{MOD}$ ) and, in turn, the sampling frequency of the modulator of 2 ×  $f_{MOD}$ . For optimum performance, it is recommended to use MCLK = 16.384 MHz and MCLK\_DIV = 2, which sets  $f_{MOD}$  = 8.192 MHz, keeping the  $f_{MOD}$  frequency high and maximizing the out-of-band tone rejection from the front-end anti-aliasing filter.

$$f_{MOD} = \frac{MCLK}{MCLK\_DIV} \tag{13}$$

The default controller clock divider setting for the ADAQ7767-1 is MCLK divider = 16. To configure the MCLK divider to MCLK = 2, write 11 to the MCLK\_DIV bits (Register 0x15, Bits[5:4]) in the Power and Clock Control Register after power up.

Control of the settings for the modulator frequency differs in  $\overline{\text{PIN}}$  control mode vs. SPI control mode. Refer to Table 22 for  $\overline{\text{PIN}}$  control mode and refer to the Power and Clock Control Register for SPI control mode.

# MCLK and SCLK Alignment

The ADAQ7767-1 interface is flexible to allow the multiple modes of operation and various data output formats to work across different DSPs and microcontroller units (MCUs). To achieve maximum performance, it is recommended to have a synchronous SCLK and MCLK from the same clock source. It is also possible to set SCLK to be a divided down version of MCLK. The Recommended Interface section provides a detailed discussion about digital interface.

## DIGITAL FILTER SETTING

The ADAQ7767-1 offers three types of digital filters. The digital filters available on the ADAQ7767-1 are as follows:

- ▶ Wideband low ripple FIR filter, −3 dB at 0.433 × ODR (6 rates)
- ► Sinc5, low latency filter, -3 dB at 0.204 × ODR (8 rates)
- Sinc3, low latency filter, −3 dB at 0.2617 × ODR, widely programmable data rate

Details on the digital filter setting can be found in the Digital Filtering section.

# **Decimation Rate and Output Data Rate**

The ADAQ7767-1 has programmable decimation rates for the wideband low ripple FIR, sinc5, and sinc3 digital filters. The decimation rates allow to band limit the measurement, which reduces the speed and input bandwidth but increases the resolution because there is further averaging in the digital filter. Filter selection and

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# **QUICK START-UP GUIDE**

decimation rate setting when using  $\overline{\text{PIN}}$  control mode are listed in Table 22, while the SPI control mode requires a register write to the Digital Filter and Decimation Control Register (Register 0x19). The SINC3 Decimation Rate (MSB) Register and SINC3 Decimation Rate (LSB) Register) are needed when setting the decimation rate for sinc3 using the SPI.

Use the following equation to calculate the ODR of the ADAQ7767-1:

$$ODR = \frac{f_{MOD}}{DEC\_RATE} \tag{14}$$

## **ADC POWER MODE**

Th ADC core power mode must match the MCLK\_DIV setting. The default power setting of the ADAQ7767-1 is set to low power mode. For optimum performance, change the ADC\_MODE to fast power mode by writing 11 to the ADC\_MODE bits (Register 0x15, Bits[1:0]) in the Power and Clock Control Register with MCLK\_DIV = 2.

### **BASIC REGISTER SETUP**

Figure 91 shows the basic flow of register writes for ADAQ7767-1 upon power up.

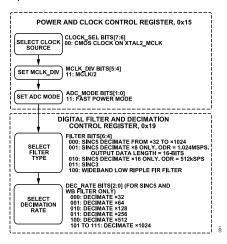


Figure 91. Basic Register Setup for ADAQ7767-1

## **QUICK START EXAMPLES**

# Wideband Low Ripple FIR Filter

For example, to operate the ADAQ7767-1 under the following conditions:

- MCLK sourced from CMOS clock
- ▶ The MCLK divider is set to 2 (recommended)
- ▶ The ADC power mode is set to fast power mode (recommended)
- Wideband low ripple FIR filter used
- ▶ Decimation rate is set to 32

The equivalent consecutive SPI writes are as follows:

- ▶ Data 0x33 to Power and Clock Control Register (Register 0x15)
- ▶ Data 0x40 to Digital Filter and Decimation Control Register (Register 0x19)

#### **ODR = 1.024 MSPS**

If the application has an ODR = 1.024 MSPS, it requires the following:

- ► A 16.384 MHz MCLK
- ▶ The MCLK divider set to 2
- ▶ The ADC power mode set to fast mode
- A sinc5 filter
- ▶ Decimation rate set to 8 (16-bit output data length)

Note that the ADAQ7767-1 automatically changes the output data length to 16 bit instead of 24 bit when using a sinc5 filter specifically with the decimation rate of 8 because this particular use case is quantization noise limited. Assuming a CMOS MCLK source, equivalent consecutive SPI writes are as follows:

- ▶ Data 0x33 to Power and Clock Control Register (Register 0x15)
- ▶ Data 0x10 to Digital Filter and Decimation Control Register (Register 0x19)

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### **NOISE PERFORMANCE**

The noise performance of the signal chain is highly dependent on the input range of the application and the desired ODR of the ADAQ7767-1. While the input range is varied by simply selecting from the pairs of input pins, the ODR of the device is dependent on the MCLK and the configured decimation rate. Use the following equations to calculate the ODR, for any digital filter:

$$f_{MOD} = \frac{MCLK}{MCLK\ DIV} \tag{15}$$

$$ODR = \frac{f_{MOD}}{DEC\ RATE} \tag{16}$$

where:

f<sub>MOD</sub> is the ADC modulator frequency.
MCLK is the controller clock frequency.
MCLK\_DIV is the ratio between the MCLK applied at the input to the ADAQ7767-1 and the clock used by the ADC modulator.
DEC RATE is the decimation rate.

Noise performance also depends on the type of digital filter used; each having different –3 dB bandwidths. The digital filters available on the ADAQ7767-1 are the following:

- ▶ Wideband low ripple FIR filter, -3 dB at 0.433 × ODR
- ▶ Sinc5, low latency filter, -3 dB at 0.204 × ODR
- ▶ Sinc3, low latency filter, -3 dB at 0.2617 × ODR

The DEC\_RATE, MCLK, MCLK\_DIV, and type of digital filter can be varied by the user, and the manner of configuration varies between the PIN control and SPI control modes (see the Device Configuration Method section).

Table 26 through Table 34 list the noise performance for the different digital filters of the ADAQ7767-1 for various ODR values. The specified noise values and dynamic ranges are typical with an external 4.096 V reference (V<sub>REF</sub>). The RMS noise is measured with shorted analog inputs to ground reference.

Table 26. IN1 (AFE\_GAIN = 1 V/V), Wideband Low Ripple FIR Filter Noise Performance vs. ODR (V<sub>REF</sub> = 4.096 V, f<sub>MOD</sub> = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	110.8	12.1
16.384	64	128	55.4	8.20
6.384	128	64	27.7	5.73
6.384	256	32	13.9	4.07
6.384	512	16	6.9	2.92
6.384	1024	8	3.5	2.10
3.107	32	204.8	88.7	11.8
3.107	64	102.4	44.3	8.00
3.107	128	51.2	22.2	5.60
3.107	256	25.6	11.1	3.99

Table 27. IN1 (AFE\_GAIN = 1 V/V), Sinc5 Filter Noise Performance vs. ODR (V<sub>REF</sub> = 4.096 V, f<sub>MOD</sub> = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	8	1024(16-bit)	208.9	61.0
16.384	16	512	104.4	13.7
16.384	32	256	52.2	8.29
16.384	64	128	26.1	5.73
16.384	128	64	13.1	4.05
16.384	256	32	6.5	2.88
13.107	32	204.8	41.8	8.09
13.107	64	102.4	20.9	5.63
13.107	128	51.2	10.4	3.96
13.107	256	25.6	5.2	2.83

Table 28. IN1 (AFE GAIN = 1 V/V), Sinc3 Filter Noise Performance vs. ODR ( $V_{REF}$  = 4.096 V,  $f_{MOD}$  = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	67.0	19.7
16.384	128	64	16.7	4.59
16.384	512	16	4.2	2.35
16.384	2048	4	1.0	1.26
16.384	8192	1	0.262	0.78
16.384	163840	0.05	0.013	0.46

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# **NOISE PERFORMANCE**

Table 29. IN2 (AFE\_GAIN = 0.364 V/V), Wideband Low Ripple FIR Filter Noise Performance vs. ODR ( $V_{REF}$  = 4.096 V,  $f_{MOD}$  = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	110.8	32.5
16.384	64	128	55.4	21.7
16.384	128	64	27.7	15.2
16.384	256	32	13.9	10.7
16.384	512	16	6.9	7.67
16.384	1024	8	3.5	5.51
13.107	32	204.8	88.7	31.9
13.107	64	102.4	44.3	21.5
13.107	128	51.2	22.2	14.9
13.107	256	25.6	11.1	10.6

Table 30. IN2 (AFE GAIN = 0.364 V/V), Sinc5 Filter Noise Performance vs. ODR (V<sub>REF</sub> = 4.096 V, f<sub>MOD</sub> = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	8	1024(16-bit)	208.9	168.4
16.384	16	512	104.4	36.8
16.384	32	256	52.2	22.2
16.384	64	128	26.1	15.2
16.384	128	64	13.1	10.7
16.384	256	32	6.5	7.66
13.107	32	204.8	41.8	21.6
13.107	64	102.4	20.9	15.0
13.107	128	51.2	10.4	10.6
13.107	256	25.6	5.2	7.50

Table 31. IN2 (AFE\_GAIN = 0.364 V/V), Sinc3 Filter Noise Performance vs. ODR ( $V_{REF}$  = 4.096 V,  $f_{MOD}$  = MCLK/2)

	,,	( /\=/	· mes ,	
MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	67.0	53.9
16.384	128	64	16.7	12.1
16.384	512	16	4.2	6.17
16.384	2048	4	1.0	3.31
16.384	8192	1	0.262	2.06
16.384	163840	0.05	0.013	1.19

Table 32. IN3 (AFE GAIN = 0.143 V/V), Wideband Low Ripple FIR Filter Noise Performance vs. ODR (V<sub>REF</sub> = 4.096 V, f<sub>MOD</sub> = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	110.8	82.6
16.384	64	128	55.4	54.7
16.384	128	64	27.7	38.1
16.384	256	32	13.9	26.8
16.384	512	16	6.9	19.2
16.384	1024	8	3.5	13.8
13.107	32	204.8	88.7	80.6
13.107	64	102.4	44.3	53.9
13.107	128	51.2	22.2	37.5
13.107	256	25.6	11.1	22.4

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# **NOISE PERFORMANCE**

Table 33. IN3 (AFE\_GAIN = 0.143 V/V), Sinc5 Filter Noise Performance vs. ODR ( $V_{REF}$  = 4.096 V,  $f_{MOD}$  = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	8	1024	208.9	436.4
16.384	16	512	104.4	93.5
16.384	32	256	52.2	55.4
16.384	64	128	26.1	38.2
16.384	128	64	13.1	26.8
16.384	256	32	6.5	19.1
13.107	32	204.8	41.8	54.8
13.107	64	102.4	20.9	37.7
13.107	128	51.2	10.4	26.6
13.107	256	25.6	5.2	18.9

Table 34. IN3 (AFE\_GAIN = 0.143 V/V), Sinc3 Filter Noise Performance vs. ODR (V<sub>REF</sub> = 4.096 V, f<sub>MOD</sub> = MCLK/2)

MCLK (MHz)	DEC_RATE	ODR (kSPS)	−3 dB Bandwidth (kHz)	RTI RMS Noise (µV RMS)
16.384	32	256	67.0	136.3
16.384	128	64	16.7	30.4
16.384	512	16	4.2	15.4
16.384	2048	4	1.0	8.17
16.384	8192	1	0.262	5.01
16.384	163840	0.05	0.013	3.22

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#### **DIGITAL INTERFACE**

The ADAQ7767-1 has a 4-wire SPI. The interface operates in SPI Mode 3. In SPI Mode 3, SCLK idles high, the first data is clocked out on the first falling or drive edge of the SCLK, and data is clocked in on the rising or the sample edge. Figure 92 and Figure 93 show SPI Mode 3 operation where the falling edge of SCLK is driving out the data and the rising edge of SCLK is when the data is sampled.

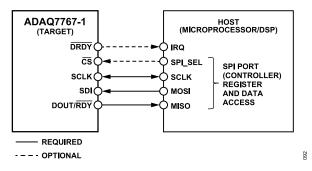
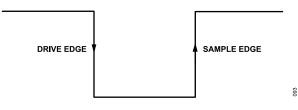


Figure 92. Basic Serial Port Connection Diagram



# SPI READING AND WRITING

To use SPI control mode, set the  $\overline{\text{PIN}}/\text{SPI}$  pin high. The SPI control operates as a 4-wire interface allowing read and write access. In systems where  $\overline{\text{CS}}$  can be tied low, such as those requiring isolation, the ADAQ7767-1 can operate in a 3-wire configuration. Figure 92 shows a typical connection between the ADAQ7767-1 and the digital host. The corresponding 3-wire interface involves tying the  $\overline{\text{CS}}$  pin low and using SCLK, SDI, and DOUT/ $\overline{\text{RDY}}$ .

The format of the SPI read or write is shown in Figure 94. The MSB is the first bit in both read and write operations. An active low frame start signal ( $\overline{FS}$ ) begins the transaction, followed by the R/W bit that determines if the transaction being carried out is to a read (1) or a write (0). The next six bits are used for the address, and the eight bits of data to be written follow. All registers in the ADAQ7767-1 are 8 bits in width, except for the ADC\_DATA register (Register 0x2C), which is 24 bits in width. In the case where  $\overline{CS}$  is tied low, the last SCLK rising edge completes the SPI transaction and resets the interface. When reading back data with  $\overline{CS}$  held low, it is recommended that SDI idle high to prevent an accidental reset of the device where SCLK is free running (see the Reset section).

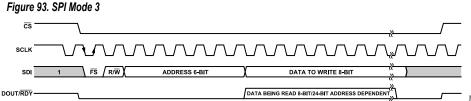


Figure 94. SPI Basic Read and Write Frame

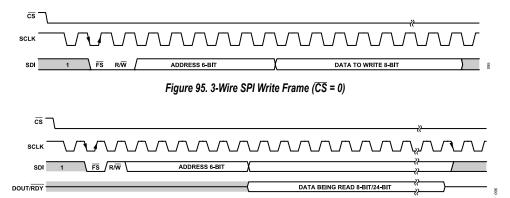


Figure 96. 3-Wire SPI Read Frame (CS = 0)

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# **DIGITAL INTERFACE**

## SPI CONTROL INTERFACE ERROR HANDLING

The ADAQ7767-1 SPI control interface detects if an illegal command is received. An illegal command is a write to a read only register, a write to a register address that does not exist, or a read from a register address that does not exist. If any of these illegal commands are received by the ADAQ7767-1, error bits are set in the SPI\_DIAG\_STATUS register (Register 0x2E), see the SPI Error Register section.

Five sources of SPI error can be detected. These detectable error sources must be enabled in the SPI\_DIAG\_ENABLE register (Register 0x28), see the SPI Diagnostic Control Register section. Only the EN\_ERR\_SPI\_IGNORE bit (Register 0x28, Bit 4) error is enabled on startup.

The five detectable sources of SPI error are as follows:

- ▶ SPI CRC error. This error occurs when the received CRC/XOR does not match the calculated CRC/exclusive OR (XOR).
- SPI read error. This error occurs when an incorrect read address is detected (for example, when the user attempts to access a register that does not exist).
- ▶ SPI write error. This error occurs when a write to an incorrect address is detected (for example, when the user attempts to write to a register that does not exist).
- ▶ SPI clock count error. When the SPI transaction is controlled by CS, this error flags when the SPI clock count during the frame is not equal to 8, 16, 24, 32, or 40. This error can be detected in both continuous read mode and normal SPI mode.
- ▶ SPI ignore error. This error flags when an SPI transaction is attempted before initial power-up completes.

All SPI errors are sticky, meaning they can only be cleared if the user writes a 1 to the corresponding error location.

## **CRC CHECK ON SERIAL INTERFACE**

The ADAQ7767-1 can deliver up to 40 bits with each conversion result, consisting of 24 bits of data and eight status bits, with the

option to add eight further CRC/XOR check bits in the SPI mode only.

The status bits default per the description in the Status Header section. The CRC functionality is available only when operating in SPI control mode. When the CRC functionality is in use, the CRC message is calculated internally by the ADAQ7767-1. The CRC is then appended to the conversion data and optional status bits.

The ADAQ7767-1 uses a CRC polynomial to calculate the CRC message. The 8-bit CRC polynomial used is  $x^8 + x^2 + x + 1$ .

To generate the checksum, shift the data by eight bits to create a number ending in eight Logic 0s.

The polynomial is aligned such that the MSB is adjacent to the left-most Logic 1 of the command bits and register data. For example, when reading the ADC\_DATA register containing 0xABCDEF, the following:

Initial Value = Frame Start Bit + R/W Bit + ADDR[5:0] + ADC\_DA-TA[23:0]

Initial Value = 0x6CABCDEF

Apply an XOR function to the data to produce a new, shorter number. The polynomial is again aligned such that the MSB is adjacent to the leftmost Logic 1 of the new result, and the procedure is repeated. This process repeats until the original data is reduced to a value less than the polynomial, which is the 8-bit checksum. In the previous example, the CRC checksum = 0x9E.

If enabled, the SPI writes always use CRC, regardless of whether the XOR option is selected in the INTERFACE\_FORMAT register (Register 0x14), see the Interface Format Control Register section. The initial CRC checksum for SPI transactions is 0x00, unless reading back data in continuous read mode, in which case, the initial CRC is 0x03.

If using the XOR option in continuous read mode, the initial value is set to 0x6C. The XOR option is only available for SPI reads.

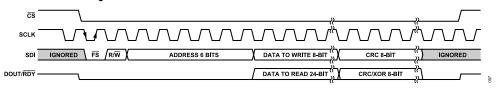


Figure 97. Data Output Format When Using CRC

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# **DIGITAL INTERFACE**

# Example of a Polynomial CRC Calculation (24-Bit Word: 0x654321, Eight Command Bits and 16-Bit Data)

An example to generate the 8-bit checksum using the polynomial-based checksum is as follows:

```
011001010100001100100001
                                 = Initial Value
01100101010000110010000100000000 left shifted eight bits
                                 = x^8 + x^2 + x + 1 polynomial value
100000111
 10010010000011001000010000000 XOR result
                                 polynomial value
 100000111
    10001100011001000010000000 XOR result
    100000111
                                 polynomial value
        11111110010000100000000 XOR result
        100000111
                                 polynomial value
         1111101110000100000000 XOR result
         100000111
                                polynomial value
          111100000000100000000 XOR result
          100000111
                                 polynomial value
           11100111000100000000 XOR result
                                polynomial value
           100000111
            1100100100100000000 XOR result
            100000111
                               polynomial value
             100101010100000000 XOR result
             100000111 polynomial value
101101100000000 XOR result
                100000111 polynomial value
                  1101011000000 XOR result
                                polynomial value
                  100000111
                   101010110000 XOR result
                   100000111 polynomial value
                     1010001000 XOR result
                     100000111 polynomial value
                       10000110 XOR result; checksum = 0x86
```

# Example of an XOR Calculation (24-Bit Word: 0x654321, Eight Command Bits and 16-Bit Data)

Using the previous example, divide into three bytes (0x65, 0x43, and 0x21) as follows:

```
01100101 0x65
01000011 0x43
00100110 XOR result
00100001 0x21
00000111 XOR result; checksum = 0x07
```

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# **DIGITAL INTERFACE**

## **CONVERSION READ MODES**

The digital interface of the ADAQ7767-1 is a 4-wire SPI implementation operating in Mode 3 SPI. An 8-bit write instruction is needed to access the memory map address space. All registers are eight bits wide, with the exception of the ADC data register. The ADAQ7767-1 operates in a continuously converting mode by default. The user must decide whether to read the data. Two read modes are available to access the ADC conversion results: single-conversion read mode and continuous read mode.

Single-conversion read mode is a basic SPI read cycle where the user must write an 8-bit instruction to read the ADC data register. The status register must be read separately, if needed.

Write a 1 to the LSB of the Interface Format Control Register (Register 0x14) to enter continuous read mode. Subsequent data reads do not require an initial 8-bit write to query the ADC\_DATA register. Simply provide the required number of SCLKs for continuous readback of the data. Figure 98 shows an SPI read in continuous read mode.

Key considerations for users on the interface are as follows:

- Conversion data is available for readback after the rising edge of DRDY. In continuous read mode, the RDY function can be enabled, and the DRDY function can be ignored. Data is available for readback on the falling edge of RDY.
- ► The ADC conversion data register is updated internally 1 MCLK period prior to the rising DRDY edge.
- ▶ MCLK has a maximum frequency of 16.384 MHz.
- ▶ SCLK has a maximum frequency of 20 MHz.
- ► The DRDY high time is 1 × t<sub>MCLK</sub>
- In fast power mode, decimate by 32, the DRDY period is ~4 μs, and the fastest conversion can have a DRDY period of 1 μs.
- ▶ The  $\overline{CS}$  rising edge resets the serial data interface. If  $\overline{CS}$  is tied low, the final rising SCLK edge of the SPI transaction resets the serial interface. The point at which the interface is reset corresponds to 16 × SCLKs for a normal read operation and up to 40 SCLKs when reading back ADC conversion data, plus the status and CRC headers.

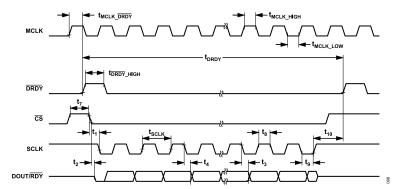


Figure 98. Serial Interface Timing Diagram, Example Reflects Reading an ADC Conversion in Continuous Read Mode

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# **DIGITAL INTERFACE**

# Single-Conversion Read Mode

When using single-conversion read mode, the ADC\_DATA register can be accessed in the same way as a normal SPI read transaction. The ADC\_DATA register (Register 0x2C), is 24 bits wide, see the Conversion Result Register section. Therefore, 32 SCLKs are required to read a conversion result.

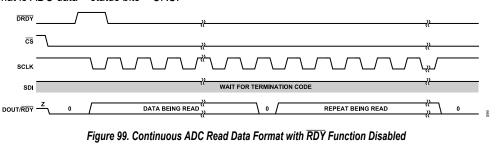
#### **Continuous Read Mode**

To eliminate the overhead of needing to write a command to read the ADC data register each time, the user can place the ADC in continuous read mode so that the ADC register can be read directly after the data ready signal is pulsed (see Figure 98). In continuous read mode, data is output on the falling edge of the first SCLK received. Therefore, only 24 SCLKs are required to read a conversion. In this continuous read mode, it is also possible to append one or both of the status or CRC headers (eight bits each) to the conversion result. If both the status and CRC headers are enabled, the data format is ADC data + status bits + CRC.

When the RDY function is not used, the ADC conversion result can be read multiple times in the DRDY period, as is shown in Figure 99. When the RDY function is enabled, the DOUT/RDY pin goes high after reading the ADAQ7767-1 conversion result and, therefore, the data cannot be read more than once (see Figure 100). The RDY function can be enabled by setting a logic low to the EN\_RDY\_DOUT bit (Register 0x14, Bit 2) of the Interface Format Control Register.

Continuous readback is the readback mode used in  $\overline{\text{PIN}}$  control mode. However, in this mode, the data output format is fixed, and there is no option for  $\overline{\text{RDY}}$  on the DOUT pin. See the Pin Control Mode Overview section for more details.

When using continuous read mode with the LV\_BOOST bit enabled (Bit 7 in the Interface Format Control Register, Register 0x14), it is necessary to re-enable LV\_BOOST each time continuous read mode is exited.



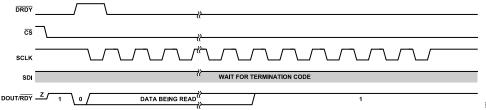


Figure 100. Continuous ADC Read Data Format with RDY Function Enabled on the DOUT/RDY Pin

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# **DIGITAL INTERFACE**

# **Exiting Continuous Read Mode**

To exit continuous read mode, write a key of 0x6C on the SDI that allows access to the register map one more time and that allows further configuration of the device. To comply with a normal SPI write, use the  $\overline{CS}$  signal to reset the SPI after this key is entered. If  $\overline{CS}$  cannot be controlled and is permanently held low, 16 SCLKs are required to complete the transaction so that the SPI

remains synchronized. For example, when  $\overline{CS}$  is permanently tied low, write 0x006C to exit continuous read mode when using the 3-wire version of the interface. The exit command must be written between  $\overline{DRDY}$  pulses to ensure that the device exits correctly.

A software reset can also be written in this mode in the same way as the exit command; however, by writing 0xAD, instead of 0x6C.

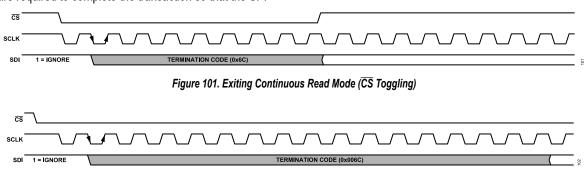


Figure 102. Exiting Continuous Read Mode (CS = 0)

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# **DATA CONVERSION MODES**

The four data conversion modes available in SPI control mode are as follows:

- ▶ Continuous conversion
- One shot conversion
- ▶ Single conversion
- Duty cycled conversion

The default conversion mode is continuous conversion. Write to the CONV\_MODE bits (Register 0x18, Bits[2:0]) of the Conversion Source Select and Mode Control Register to change the conversion mode. A SYNC\_IN pulse must be provided to the ADAQ7767-1 after any change to the configuration of the device, including changing filter settings and data conversion modes.

## **CONTINUOUS CONVERSION MODE**

In continuous conversion mode, the ADC continuously converts and a new ADC result is ready at an interval determined by the ODR, which is the default conversion operation in SPI control mode, and the only data conversion mode in which the wideband low ripple FIR filter is available. Two methods of data readback are available to the user in SPI control mode and are described in the Conversion Read Modes section.

## ONE SHOT CONVERSION MODE

Figure 103 shows the device operating in one shot conversion mode. In this mode, conversions occur on request by the controller device, for example, the DSP or FPGA. The SYNC\_IN pin receives the command initiating the data output.

In one shot conversion mode, the ADC runs continuously. However, the SYNC\_IN pin rising controls the point in time from which data is output.

To receive data, the controller device must pulse the SYNC\_IN pin, which resets the filter and forces DRDY low. DRDY subsequently

goes high to indicate to the controller device that the device has valid settled data available.

When the controller asserts SYNC\_IN and the ADAQ7767-1 receives the rising edge of this signal, the digital filter is reset, the full settling time of the filter elapses before the data is settled, and the output is available. The duration of the settling time depends on the filter path and decimation rate. One shot conversion mode is only available for use with the sinc5 or sinc3 filters because these filters feature a minimal settling time. One shot conversion mode is not available as an option for use with the wideband low ripple FIR filter.

When settled data is available, the  $\overline{DRDY}$  signal pulses. The time from the  $\overline{SYNC\_IN}$  signal until the ADC path settles data ( $t_{SETTLED}$ ) is shown in Figure 103. After settled data is available,  $\overline{DRDY}$  is asserted high, and the user can read the conversion result. The device then waits for another  $\overline{SYNC\_IN}$  signal before outputting more data.

The settling time is calculated relative to the settling time of the filter used, with some added latency for starting the one shot conversion. This settling time limits the overall throughput achievable in one shot conversion mode.

Because the ADC is sampling continuously, one shot conversion mode affects the sampling theory of the ADAQ7767-1. Periodically sending a SYNC\_IN pulse to the device is a form of subsampling of the ADC output. The bandwidth around this subsampling rate can now alias down to the baseband. Consider keeping the SYNC\_IN pulse synchronous with the controller clock to ensure coherent sampling and to reduce the effects of jitter on the frequency response, which otherwise heavily distort the output.

Any SPI configuration of the ADAQ7767-1 required is performed in continuous conversion mode before switching back to one shot conversion mode.

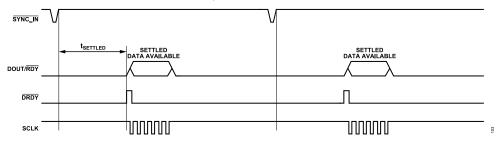


Figure 103. One Shot Conversion Mode, SYNC\_IN Pin Driven with an External Source

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# **DATA CONVERSION MODES**

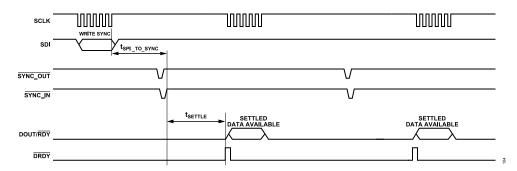


Figure 104. One Shot Conversion Mode, SYNC\_IN Pulse Initiated by a Register Write

## SINGLE-CONVERSION MODE

In single-conversion mode, the ADC wakes up from standby, performs a conversion, and then returns to standby. Only use single-conversion mode when operating in low power and median power modes. The user must send a command to initiate the read and subsequently read back the ADC conversion result. Use a toggle of the SYNC\_IN pin to exit the device from standby and to start a new conversion.

If M0\_ADC and M1\_ADC is connected to M0\_FDA and M1\_FDA, the FDA is automatically put in standby when the ADC is in standby (see the Fully Differential Amplifier (FDA) Power Mode section).

Any SPI configuration of the ADAQ7767-1 required must be performed in continuous conversion mode before then switching back to single-conversion mode.

# **DUTY CYCLED CONVERSION MODE**

In duty cycled conversion mode, the ADC wakes up from standby, performs a conversion, and then returns to standby. The user can set the period between each conversion, and the ADC automatically performs the single conversion before returning to standby, repeating the single conversion performed by the ADC at a period specified by the user. Only use duty cycled conversion mode when operating in low power and median power modes. Duty cycled conversion mode allows a method to reduce the power consumption for DC point conversions, and to eliminate any overhead in timing and initiating the conversion.

Use a toggle of the SYNC\_IN pin to begin the duty cycled conversion mode sequence. DRDY toggles once when a settled result is reached. Then, the device enters standby one more time. The Periodic Conversion Rate Control Register (Register 0x1C) controls the determined idle time.

If M0\_ADC and M1\_ADC is connected to M0\_FDA and M1\_FDA, the FDA is automatically put in standby when the ADC is in standby (see the Fully Differential Amplifier (FDA) Power Mode section).

Any SPI configuration of the ADAQ7767-1 required must be performed in continuous conversion mode before switching back to duty cycled conversion mode.

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# SYNCHRONIZATION OF MULTIPLE ADAQ7767-1 DEVICES

Synchronization is an important consideration when using multiple ADAQ7767-1 devices in a system. The basic provision for synchronizing multiple devices is that each device is clocked with the same base MCLK signal. Provide a SYNC\_IN pulse to the ADAQ7767-1 both after power-up and after any change to the configuration of the device. This pulse flushes out the digital filters and ensures that the device is in a known configuration, as well as synchronizing multiple devices in a system.

The ADAQ7767-1 has three options to ease system synchronization. Choosing among the options depends on the system. However, the most basic consideration is whether the user can supply a synchronization pulse that is truly synchronous with the base MCLK signal.

If a signal that is synchronous to the base MCLK signal cannot be provided, use one of the following methods:

- ▶ Configure the GPIOx pin of one of the ADAQ7767-1 devices in the system to be a START input. Apply a START pulse to the configured GPIOx pin. Route the SYNC\_OUT pin output to the SYNC\_IN input of that same device and all other devices to be synchronized. The ADAQ7767-1 samples the asynchronous START pulse and generates a SYNC\_OUT pulse related to the base MCLK signal for local distribution.
- ▶ Use synchronization over the SPI (only available in SPI control mode, see Figure 88). Write a synchronization command to one predetermined ADC device. Connect the SYNC\_OUT pin of this device to its own SYNC\_IN pin and to the SYNC\_IN pin of

any other device locally. Similar to the  $\overline{START}$  pin method, the SPI synchronization is received by one device and, subsequently, the  $\overline{SYNC\_OUT}$  signal is routed to local devices to allow synchronization.

If a <u>SYNC\_IN</u> signal synchronous to the base MCLK can be provided, apply the <u>SYNC\_IN</u> synchronous signal to the <u>SYNC\_IN</u> pin from a star point and connect directly to the pin of each ADAQ7767-1 device. The <u>SYNC\_IN</u> signal is sampled on the rising MCLK edge and, therefore, setup and hold times are associated with the <u>SYNC\_IN</u> input relative to the ADAQ7767-1 MCLK rising edge (see Figure 7).

In this case, <u>SYNC\_OUT</u> is redundant and can remain open-circuit or tied to <u>VDD\_IO</u>. GPIOx can be used for a different purpose because it is not required for the <u>START</u> function. <u>Figure 105</u> shows synchronization in channel-to-channel isolated systems.

It is recommended to perform synchronization functions directly after the  $\overline{DRDY}$  pulse. If the ADAQ7767-1  $\overline{SYNC\_IN}$  pulse occurs too close to the upcoming  $\overline{DRDY}$  pulse edge, the upcoming  $\overline{DRDY}$  pulse may still be output because the  $\overline{SYNC\_IN}$  pulse has not yet propagated through the device.

When using the <u>SYNC\_OUT</u> function with a <u>VDD\_IO</u> voltage of 1.8 V, it is recommended to set the <u>SYNC\_OUT\_POS\_EDGE</u> bit (Register 0x1D, Bit 6) shown in the <u>Synchronization Modes and Reset Triggering Register</u> to 1.

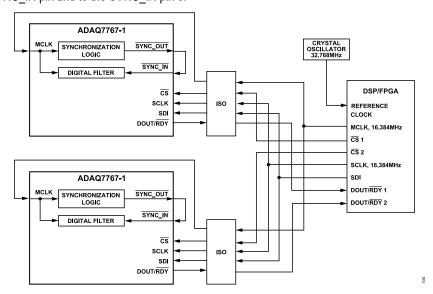


Figure 105. Synchronization in Channel-to-Channel Isolated Systems

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# **ADDITIONAL FUNCTIONALITY OF THE ADAQ7767-1**

#### RESET

After powering up the device, it is recommended to perform a full reset. There are multiple options available on the ADAQ7767-1 to perform a reset, including

- ▶ Using the dedicated RESET pin. See the Pin Configuration and Function Description section.
- When in continuous read mode, the ADAQ7767-1 monitors for the exit command or a reset command of 0xAD. See the Exiting Continuous Read Mode section for more details.
- A software reset can be performed by two consecutive writes to the Synchronization Modes and Reset Triggering Register (Register 0x1D).
- When CS is held low, it is possible to provide a reset by clocking in a 1 followed by 63 zeros on SDI, which is the SPI resume command reset function used to exit power-down mode.

The time taken from  $\overline{RESET}$  to an SPI write must be at least 200  $\mu$ s.

## STATUS HEADER

In SPI control mode, the status header can be output after the conversion result when operating the ADAQ7767-1 in continuous read back mode. The status header mirrors the MASTER\_STATUS register (Register 0x2D) detailed in the Device Error Flags Main Register section.

In PIN control mode, the status header is output by default after the conversion result. The status header contains the following bits and functions:

- ▶ The MASTER\_ERROR bit is an OR of all other errors present and can be monitored to provide a quick indication of a problem having occurred.
- ► The ADC\_ERROR bit sets to 1 if any error is present in the ADC Diagnostics Output Register (Register 0x2F). It is an OR of the error bits in the ADC Diagnostics Output Register register.
- ► The DIG\_ERROR bit sets to 1 if any error is present in the Digital Diagnostics Output Register (Register 0x30). It is an OR of the error bits in the Digital Diagnostics Output Register register.
- ► The ERR\_EXT\_CLK\_QUAL bit (Register 0x2D, Bit 4 and Register 0x2F, Bit 0) sets if a valid clock is not detected (see the Clock Qualification section).
- ► The FILT\_SATURATED bit (Register 0x2D, Bit 3 and Register 0x2F, Bit 2) sets to 1 if the digital filter is clipped on either positive or negative full scale. The clipping can be caused by the analog input exceeding the analog input range, or by a large step input to the device that causes a large overshoot in the digital filter. In addition, the filter may saturate if the ADC gain registers are incorrectly set. The combination of a full-scale signal and a large gain saturates the digital filter.
- ▶ The FILT\_NOT\_SETTLED bit (Register 0x2D, Bit2 and Register 0x2F, Bit 1) is set to 1 if the output of the digital filter is not settled. The digital filters are cleared following a RESET pulse,

or after a SYNC\_IN command is received. Table 14, Table 15, and Table 20 list the time for SYNC\_IN to settled data for each filter type. When using the wideband low ripple FIR filter, the FILT\_NOT\_SETTLED bit takes longer to update and propagate through the device than to read the status header. The FILT\_NOT\_SETTLED bit appears set when in fact the data output is settled. The worst-case update delay is 128 MCLK cycles for the wideband low ripple FIR filter, decimate by 1024 setting. In this case, if the readback is delayed by 128 MCLK cycles, the filter not settled bit has time to update, and the time to settled data is equal to the data shown in Table 14, Table 15, and Table 20.

- ► The SPI\_ERROR bit (Register 0x2D, Bit 1) sets to 1 if any error is present in the SPI Error Register (Register 0x2E). The bit is an OR of the error bits in the SPI Error Register.
- ► The POR\_FLAG bit (Register 0x2D, Bit 0) detects if a reset or a temporary supply brown out occurred. In PIN control mode, instead of being the POR flag, this bit is always set to 1 and then detects if the interface is operating correctly.

## **DIAGNOSTICS**

Internal diagnostics are available on the ADAQ7767-1 that allow the user to check both the functionality of the ADC and the environment in which the ADC is operating. The internal diagnostics are enabled in the conversion register detailed in the Conversion Source Select and Mode Control Register (Register 0x18). To use the diagnostics, the device must be configured to eco mode, MCLK\_DIV = MCLK/16, and the linearity boost buffers must be enabled. The diagnostics available are as follows:

- ▶ The temperature sensor is an on-chip temperature sensor that determines the approximate temperature. Temperature changes measured give approximately a 0.6 mV/°C, referred to output (RTO), change in the DC converted voltage. For example, at ambient temperature, the conversion result is approximately 180 mV (RTO, ADC\_DATA approximately = 0x059FFF). A 50°C increase in temperature reads back as approximately 210 mV (RTO, ADC\_DATA approximately = 0x068FFF), signaling, for example, a potential fault or the need to calibrate the system.
- The ADC input short disconnects the input pins of the core ADC from the FDA and creates an internal short across the core ADC input.
- ▶ The voltage converted is V<sub>REF+</sub> for positive full scale, if selected.
- ▶ The voltage converted is V<sub>RFF</sub> for negative full scale, if selected.

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# **APPLICATIONS INFORMATION**

# CONDITION-BASED MONITORING (CBM) APPLICATION

A common application of the ADAQ7767-1 is CbM using piezoelectric sensors. In the application shown in Figure 106, an integrated electronics piezoelectric (IEPE) sensor can be interfaced with the ADAQ7767-1 with the use of ADG5421F as a fault protection switch, LT3092 as a current source to bias the sensor, and ADA4610-1 as a high impedance buffer. Three-wire negative voltage accelerometers have a slightly different interface, as illustrated in Figure 107. Whenever a voltage source is used to test the signal

chain, disconnect the current source or bias through the switch. These application solutions are designed to convert vibration signals from either +2.5 V to +21.5 V or -21.5 V to +2.5 V by using the IN3+ and IN3- inputs of the ADAQ7767-1. The ±2.5 V headroom of the ADA4610-1 from both power rails causes the input range to be narrower, but nevertheless, captures the operational range of piezoelectric sensors in the market. The excellent DC performance of the ADAQ7767-1 allows the sensors to be DC-coupled to the system and convert the signals with precision in the sub-Hz frequencies.

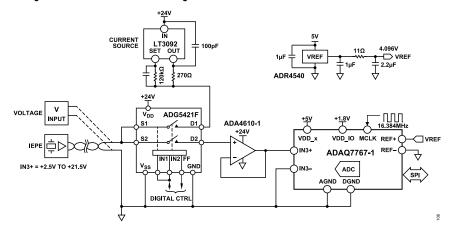


Figure 106. DC-Coupled IEPE Sensor Application, IN3+ = 2.5 V to 21.5 V

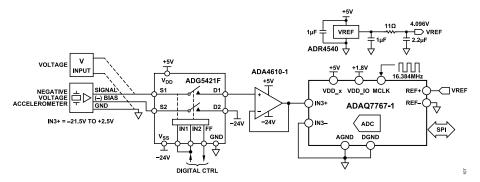


Figure 107. DC-Coupled, 3-Wire Negative Voltage Accelerometer Application, IN3+ = -21.5 V to +2.5 V

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### **APPLICATIONS INFORMATION**

### **ANALOG INPUTS**

### **Differential Inputs**

Figure 108, Figure 109, and Figure 110 show the typical application examples of differential signals with varying common-mode voltages applied to IN1+ and IN1-, IN2+ and IN2-, or IN3+ and IN3- of the ADAQ7767-1 for gains of 1, 0.36, and 0.14, respectively, assuming  $V_{REF} = 4.096 \text{ V}$ .

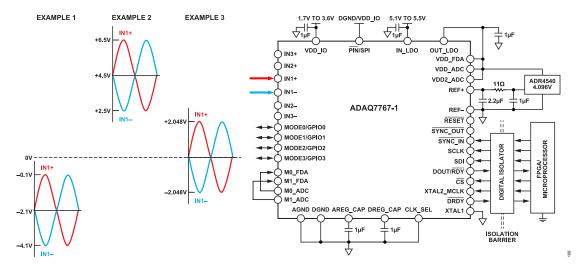


Figure 108. ADAQ7767-1 Differential Input Configuration to IN1+ and IN1- (AFE\_GAIN = 1 V/V)

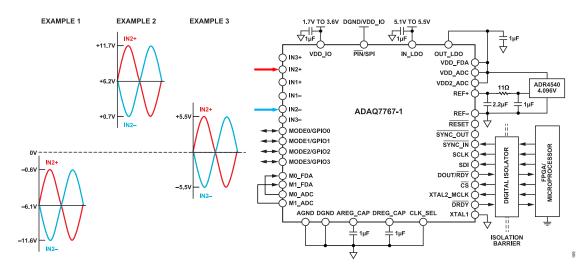


Figure 109. ADAQ7767-1 Differential Input Configuration to IN2+ and IN2- (AFE\_GAIN = 0.36 V/V)

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# **APPLICATIONS INFORMATION**

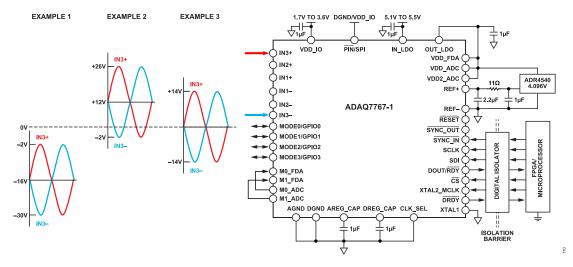


Figure 110. ADAQ7767-1 Differential Input Configuration to IN3+ and IN3- (AFE\_GAIN = 0.14 V/V)

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### **APPLICATIONS INFORMATION**

# Single-Ended Inputs

Figure 111, Figure 112, and Figure 113 show the typical application examples of single-ended signals applied to IN1+ and IN1-, IN2+ and IN2-, or IN3+ and IN3- of the ADAQ7767-1 for gains of 1, 0.36, and 0.14, respectively, assuming V<sub>RFF</sub> = 4.096 V.

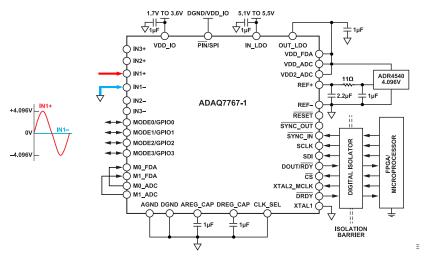


Figure 111. ADAQ7767-1 Single-Ended Input Configuration to IN1+ and IN1- (AFE\_GAIN = 1 V/V)

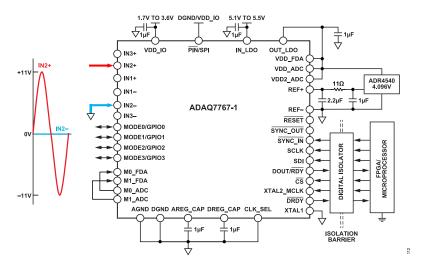


Figure 112. ADAQ7767-1 Single-Ended Input Configuration to IN2+ and IN2- (AFE GAIN = 0.36 V/V)

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# **APPLICATIONS INFORMATION**

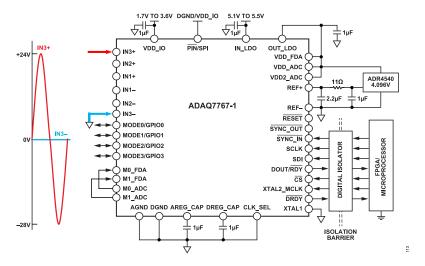


Figure 113. ADAQ7767-1 Single-Ended Input Configuration to IN3+ and IN3- (AFE\_GAIN = 0.14 V/V)

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### **APPLICATIONS INFORMATION**

### SENSOR INTERFACING

The applications diagram in Figure 114 illustrates how the ADAQ7767-1 is typically used with a single sensor. In the application, an external fixed gain signal conditioning circuit designed by the user buffers between the sensor and ADAQ7767-1.

Figure 115 illustrates how the user can also use the ADAQ7767-1 using multiple sensors. In this case, an external PGIA designed

by the user multiplexes and buffers multiple sensor inputs. The ADAQ7767-1 features GPIO pins that can be configured to set the gain for each channel of the user-designed PGIA.

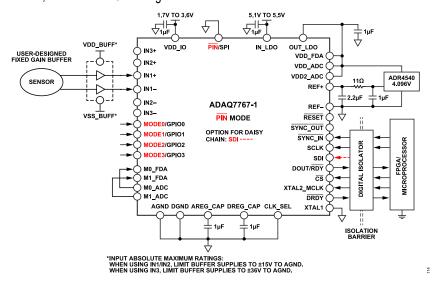


Figure 114. Typical Applications Diagram of DAQ System Involving One Sensor Input and PIN Mode

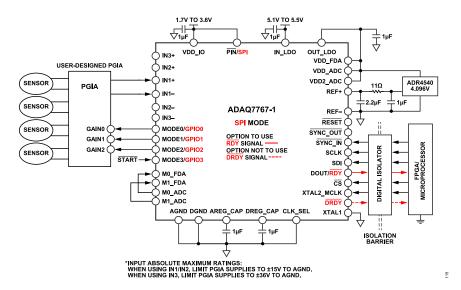


Figure 115. Typical Applications Diagram of DAQ System Involving Multiple Sensor Inputs and SPI Mode

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### **APPLICATIONS INFORMATION**

### **PIN AND SPI CONTROL MODES**

### **PIN** Control Mode

The ADAQ7767-1 can be configured in either  $\overline{\text{PIN}}/\text{SPI}$  mode, whose distinct advantages are presented in the Device Configuration Method section. One of the advantages of  $\overline{\text{PIN}}$  mode is illustrated in Figure 114, wherein the MODEx pins are used to set the ADC configurations such as the f<sub>MOD</sub> frequency, type of digital filter, and decimation rate from a list of predetermined modes as shown in Table 22. This ability allows the user to make an easier choice of ADC configuration and eliminates the need to write to the ADC registers that control these configurations. Because a write is not allowed, the SDI pin can be used for daisy-chaining, which is only available in  $\overline{\text{PIN}}$  control mode. To use  $\overline{\text{PIN}}$  control mode, ground the  $\overline{\text{PIN}}/\text{SPI}$  pin on startup.

### **SPI Control Mode**

Figure 115 illustrates an application in SPI control mode, wherein the user utilizes the GPIOs, in this case, to control the gain of a PGIA. This control can be done by configuring the GPIO Port Control Register (Register 0x1E) and GPIO Output Control Register (Register 0x1F). The SPI mode also allows the complete flexibility in ADC configurations, conversion read modes, and data conversion modes. The SPI control mode in continuous read mode can use the RDY signal, which can be enabled through the Interface Format Control Register (Register 0x14), to merge the indication of new ADC data with the DOUT output stream, eliminating the need for a digital line for DRDY. To use SPI control mode, connect the PIN/SPI pin to high (or VDD IO) on startup.

# **POWER SUPPLIES**

The power supplies illustrated in Figure 114 and Figure 115 are recommended in using the ADAQ7767-1 for its typical applications. Instead of using an external LDO regulator to supply 5 V to VDD\_FDA, VDD\_ADC, VDD2\_ADC, and the external 4.096 V reference, an internal LDO regulator that accepts a voltage of 5.1 V to 5.5 V is included in the ADAQ7767-1 to conveniently output a well-regulated 5 V supply. VDD\_IO is supplied with a 1.7 V minimum to power the digital logic of the ADC driver and the GPIO and SPI of the ADC.

The ADAQ7767-1 has built-in, 0.1  $\mu$ F supply decoupling capacitors on the VDD\_FDA, VDD\_ADC, VDD\_ADC2, and VDD\_IO supply pins. When the LDO regulator is in use, decouple it with a 1  $\mu$ F capacitor at IN\_LDO and OUT\_LDO. Additionally, decouple the analog and digital LDO regulators of the ADC to ground with a 1  $\mu$ F capacitor through the AREG\_CAP and DREG\_CAP pins.

When powering up the device, no particular power supply sequencing is required because the AGND pins of the ADAQ7767-1 are connected to a single ground plane.

# REFERENCE, REFERENCE BUFFER, AND LINEARITY BOOST BUFFER

While the ADC reference can range from VDD\_ADC down to 1 V, the typical application and specification of the ADAQ7767-1 is set with an input reference at 4.096 V, which can be implemented by connecting the output of the integrated 5 V LDO regulator to the ADR4540 voltage reference to output a voltage reference of 4.096 V

It is recommended to use the integrated reference precharge buffers of the ADC to lessen the burden on the external reference, as discussed in the Reference Input and Buffering section.

It is also recommended to enable the linearity boost buffers, which ease the driving between the fully differential amplifier and core ADC input (see the Linearity Boost Buffers section).

In the  $\overline{\text{PIN}}$  mode, the reference precharge buffers and linearity boost buffers are enabled by default for enhanced performance, while the SPI mode requires a register write to the Analog Buffer Control Register to enable them.

### RECOMMENDED INTERFACE

The ADAQ7767-1 interface is flexible to allow the many modes of operation and for data output formats to work across different DSPs and MCUs. To achieve maximum performance, the recommended interface configuration for reading conversion results is shown in Figure 116. This recommended implementation uses a synchronous SCLK to MCLK relationship.

Configure the interface as follows to achieve the recommended operation:

- 1. Tie the  $\overline{\text{CS}}$  signal low during the conversion readback.
- Enter continuous readback mode to avoid requiring to provide the address bits for the ADC\_DATA register. Continuous readback mode is the default readback mode in PIN mode.
- 3. Clocking out 32 bits of data, consisting of the 24-bit conversion result plus eight bits that can be either status or CRC bits. In PIN mode, these bits are always the conversion result plus the eight status bits.
- 4. Provide an SCLK that is phase coherent to MCLK. SCLK can be identical to MCLK (SCLK = MCLK) or a divided down version of MCLK (SCLK = MCLK/N). For example, SCLK = MCLK/2 when decimate by 32 is selected.
- 5. Clocking 32 bits ensures that the data readback operation fills the entire DRDY period when SCLK = MCLK/2. SCLK runs continuously. The readback spans the full DRDY period, thus spreading the noise coupling due to the current on VDD\_IO across the full ODR period.
- **6.** The  $\overline{DRDY}$  signal can synchronize the data read into the host controller.

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# **APPLICATIONS INFORMATION**

Figure 116 shows how the recommended interface operates. The data read back spans the entire length of the  $\overline{DRDY}$  period, and the LSB remains until  $\overline{DRDY}$  goes high for the next conversion.

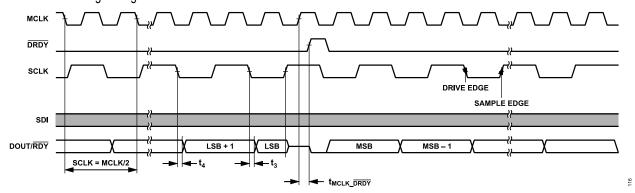


Figure 116. Recommended Interface for Reading Conversions, SPI Control, Continuous Readback Mode

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### **APPLICATIONS INFORMATION**

## Initializing the Recommended Interface

To configure the recommended interface, take the following steps:

- Configure the device settings, such as power mode, decimation ratio, filter type, and so on.
- 2. Enter continuous readback mode.
- Issue a synchronization pulse to apply the changes to the digital domain and to reset the digital filter. Issue the pulse immediately after DRDY goes high.

# **Recommended Interface for Reading Data**

The recommended interface for reading data is as follows:

- Synchronize the host controller with the DRDY or RDY pulse. See Figure 6 for details on the RDY behavior before data is clocked out.
- 2. Generate SCLK based on the DRDY or RDY timing. SCLK is high when the DRDY signal goes high and transitions on the MCLK falling edges (see Figure 116) to ensure that the LSB can be read correctly as the DOUT/RDY output is reset on the DRDY rising edge. However, SCLK rising occurs before this transition.
- 3. The MSB is clocked out on the next falling edge of SCLK.
- **4.** In PIN control mode, the LSB of the conversion output is the last bit of the status output. In PIN control mode, this bit is always 1 and, therefore, does not need to be read.

# Resynchronization of the Recommended Interface

Because the full ODR period is for clocking data, the  $\overline{RDY}$  signal no longer flags after each LSB outputs. This signal only flags if the ADAQ7767-1 is in continuous readback mode, or if the ADAQ7767-1 does not count 32 SCLKs within 1 ×  $t_{MCLK}$  before  $\overline{DRDY}$ , as is shown in Figure 116.

The  $\overline{RDY}$  function is only available in continuous readback mode. In normal readback, where the ADC\_DATA register must be addressed each time, the DOUT line is reset 1 ×  $t_{MCLK}$  before  $\overline{DRDY}$ ,

as per  $t_{10}$  in the Timing Specifications section. If  $\overline{DRDY}$  is used, the device operates as normal, and conversion readback is timed from the  $\overline{DRDY}$  pulse. In the case where  $\overline{RDY}$  detects the beginning of each sample, and where the data readback loses synchronization, the SCLK timing can be recovered by one of the following two methods:

- Using CS to reset the interface and to observe the RDY transition
- ▶ Stopping SCLK toggling until the RDY transition is detected one more time.

### PROGRAMMABLE DIGITAL FILTER

If there are additional filter requirements outside of the digital filters offered by default on the ADAQ7767-1, there is the added option of designing and uploading a custom digital filter to memory. This upload overwrites the default low ripple FIR filter coefficients to be replaced by a set of user defined coefficients.

The ADAQ7767-1 filter path has three separate stages:

- Initial sinc filter
- ▶ Sinc compensation filter
- ▶ Low ripple FIR filter

The user cannot change the first two stages. The only programmable stage is the third stage, where the default low ripple FIR filter coefficients can be replaced by a set of user-defined coefficients.

The data rate into the third stage is double the final ODR due to a fixed decimation by two that occurs after the final stage of filtering. Therefore, the programmable FIR stage receives data at a rate that is decimated from f<sub>MOD</sub> by rates of 16, 32, 64, 128, 256, and 512.

After the final decimation by 2, the overall decimation values are given and are in the range of decimate by 32 to decimate by 1024. The data rates into the final FIR stage are listed in Table 35. Table 35 describes the data rate into the final filter stage for each power mode, assuming the correct MCLK\_DIV setting is selected for the corresponding power mode. For example, when median power mode is selected, MCLK\_DIV must be MCLK/4.

Table 35. Data Rates into the Final FIR Input Stage

		Input to Third Stage, Programmable FIR (MCLK = 16.384 MHz)							
Power Mode	512 kSPS	256 kSPS	128 kSPS	64 kSPS	32 kSPS	16 kSPS	8 kSPS	4 kSPS	2 kSPS
Fast	Yes	Yes	Yes	Yes	Yes	Yes		Not applicable	Not applicable
Median	Not applicable	Yes	Yes	Yes	Yes	Yes	Yes	Not applicable	Not applicable
Low Power	Not applicable	Not applicable	Not applicable	Yes	Yes	Yes	Yes	Yes	Yes

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### **APPLICATIONS INFORMATION**

#### **Filter Coefficients**

The ADAQ7767-1 low ripple FIR filter uses a set of 112 coefficients. By writing the appropriate key to the ADAQ7767-1, these coefficients can be overwritten. Then, the customized filter coefficients can upload and lock into memory. If the ADAQ7767-1 is reset, these coefficients must be rewritten.

The coefficients uploaded are subject to the following required conditions:

- ▶ The number of coefficients in a full set is 112, which is made up of 56 coefficients that are mirrored to make the total coefficients sum 112. Therefore, only 56 coefficients are written to during any one filter upload.
- Coefficients written must be in integer form. The format used is twos complement.
- ▶ The Coefficient Data Register to be written is 24 bits wide, which is the only 24-bit register write used on the ADAQ7767-1. Only 23 bits are used for the coefficients. The remaining MSB is a control bit, detailed in the Register 0x33.
- ▶ Filter coefficients are scaled such that the 56 coefficients must sum to 2<sup>22</sup>. The total (112) coefficients, therefore, sum to 2<sup>23</sup>.

For example, if the filter coefficient to be written to is -0.0123, this value is scaled to  $-0.0123 \times 2^{22} = -51,590$ . In twos complement format, this value is represented by 0x7F367A.

Each filter coefficient is written by first selecting the coefficient address. Then, a separate write of the data occurs, which is repeated for all 56 coefficients from Address 0 to Address 55.

Because the FIR size cannot be changed, the filter group delay remains fixed at 34/ODR when using the programmable filter option. If a shorter number of coefficients are required, padding zeros before the coefficients can achieve this requirement. The group delay of the uploaded filter must always be equal to the group delay of the default ADAQ7767-1 FIR filter that equals approximately 34/ODR.

Each time either the Coefficient Control Register or the Coefficient Data Register (COEFF\_CONTROL or COEFF\_DATA) are accessed, the user must wait a period before performing another read or write. The following equation determines the wait time:

 $t_{WAIT} = 512/MCLK$ 

This wait time allows time for the register contents to update. Then, the coefficients are written to memory.

## **Upload Sequence**

To program a user-defined set of filter coefficients, perform the following sequence:

- 1. Write 0x4 to the filter bits in the Digital Filter and Decimation Control Register (Register 0x19, Bits[6:4]).
- The following key must be written to access the filter upload.
   First, write 0xAC to the Access Key Register (Register 0x34).
   Second, write 0x45 to the Access Key Register. Bit 0 (the key bit) of the Access Key Register can be read back to check if the key is entered correctly.
- **3.** Write 0xC0 to the Coefficient Control Register (Register 0x32). Wait for t<sub>WAIT</sub> sec to perform the following actions:
  - a. Set the coefficient address to Address 0.
  - **b.** Enable the access to memory (COEFF ACCESS EN = 1).
  - Allow a write to the coefficient memory (CO-EFF\_WRITE\_EN = 1).
- 4. The address of the first coefficient is selected. Write the required coefficient to the Coefficient Data Register (Register 0x33), and then wait for t<sub>WAIT</sub> sec. Always wait t<sub>WAIT</sub> sec between writes to Register 0x32 and Register 0x33.
- 5. Repeat Step 3 and Step 4 for each of the 56 coefficients. For example, write 0xC1 to the Coefficient Control Register to select coefficient Address 1. After waiting t<sub>WAIT</sub> sec, enter the coefficient data. Increment the data until Coefficient 55 is reached. (Coefficient 55 is a write of 0xF7 to Coefficient Control Register.)
- Disable writing to the coefficients by first writing 0x80 to the Coefficient Control Register. Then, wait t<sub>WAIT</sub> sec. Then, write 0x00 to the Coefficient Control Register to disable coefficient access.
- Set USER\_COEFF\_EN = 1 by writing 0x800 to the Coefficient Data Register to allow the user to toggle the synchronization pulse and to begin reading data.
- **8.** Exit the filter upload by writing 0x55 to the Access Key Register (Register 0x34).
- **9.** Send a synchronization pulse to the ADAQ7767-1. One way of sending this pulse is by writing to the Synchronization Modes and Reset Triggering Register (Register 0x1D). The filter upload is now complete.

The RAM CRC error check fails when the digital filter uploads. To disable this check, use the Digital Diagnostic Feature Control Register (Register 0x2A).

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### **APPLICATIONS INFORMATION**

## **Example Filter Upload**

The following sequence programs a sinc1 filter. The coefficients in Address 0 to Address 23 = 0. The coefficients from Address 24 to Address 55 = 131,072 ( $2^{22}/32$ ). When MCLK = 16.384 MHz and ODR = 256 kSPS, the filter notch appears at 8 kHz and multiplies of 8 kHz. This filter provides low noise and is recognizable by the distinctive filter profile shown in Figure 117.

To program the filter, take the following steps:

- 1. Write 0x4 to the filter bits in the Digital Filter and Decimation Control Register (Register 0x19, Bits[6:4]).
- **2.** Enter the key by writing to the Access Key Register (Register 0x34).
- Write 0xC0 to the Coefficient Control Register, Register 0x32, (COEFF\_ADDR = 0, COEFF\_ACCESS\_EN = 1, and CO-EFF WRITE EN = 1). Wait t<sub>WAIT</sub> sec.
- Write 0x000000 to the Coefficient Data Register (Register 0x33). Wait t<sub>WAIT</sub> sec.
- Write 0xC1 to the Coefficient Control Register (COEFF\_ADDR = 1). Wait t<sub>WAIT</sub> sec. In this case, the coefficient in Address 0 is equal to Address 1 and, therefore, the value in the Coefficient Data Register does not change.
- Write 0xC2 to the Coefficient Control Register (COEFF\_ADDR = 2). Wait t<sub>WAIT</sub> sec.
- Increment the address of the Coefficient Control Register (CO-EFF\_ADDR = 23) until the write of 0xD7. Continue to wait t<sub>WAIT</sub> sec.
- 8. Write 0xD8 to the Coefficient Control Register (COEFF\_ADDR = 24).
- **9.** Write 0x010000 to the Coefficient Data Register. Wait t<sub>WAIT</sub> sec.
- **10.** Write 0xD9 to the Coefficient Control Register (COEFF\_ADDR = 25). Wait t<sub>WAIT</sub> sec.
- **11.** Write 0xDA to the Coefficient Control Register (COEFF\_ADDR = 26) Wait t<sub>WAIT</sub> sec.
- **12.** Increment the address of the Coefficient Control Register (COEFF ADDR = 55) until the write 0xF7. Wait t<sub>WAIT</sub> sec.
- Disable write and access by first writing 0x80 to the Coefficient Control Register. Wait t<sub>WAIT</sub> sec. Then, write 0x00 to the Coefficient Control Register.
- **14.** Set USER\_COEFF\_EN = 1 to allow the user to toggle synchronization without reloading the default coefficients. (Write 0x800000 to the Coefficient Data Register.)
- **15.** Exit the write by writing 0x55 to the Access Key Register.
- **16.** Toggle synchronization.
- **17.** Gather data. The resulting filter profile is shown in Figure 117.

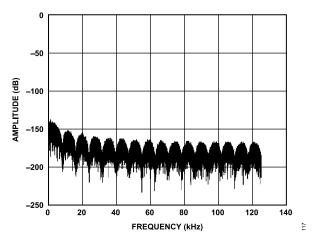


Figure 117. Example Filter Profile Upload

# Filter Upload Verification

To check that the filter coefficients are uploaded correctly, it is possible to read back the values written to the Coefficient Data Register. This read can be performed after an upload by taking the following steps:

- Enter the key by writing to the Access Key Register (Register 0x34). First, write 0xAC to the Access Key Register, and then write 0x45 to the Access Key Register.
- Write 0x80 to the Coefficient Control Register, Register 0x32 (COEFF\_ADDR = 0, COEFF\_ACCESS\_EN = 1, CO-EFF\_WRITE\_EN = 0). Wait t<sub>WAIT</sub> sec.
- Read back the contents of the 24-bit Coefficient Data Register (Register 0x33). Check that the coefficient matches the uploaded value.
- Write 0x81 to the Coefficient Control Register (COEFF\_ADDR = 1). Wait t<sub>WAIT</sub> sec.
- Read the 24-bit Coefficient Data Register for Address 1. Increment and continue to read back the data. Continue to wait t<sub>WAIT</sub> sec between updates to the Coefficient Control Register.
- **6.** Disable the coefficient access by writing 0x00 to the Coefficient Control Register.
- Exit the readback process by writing 0x55 to the Access Key Register.

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### **APPLICATIONS INFORMATION**

#### LAYOUT GUIDELINES

Design the PCB that houses the ADAQ7767-1 so that the analog and digital sections are separated and confined to different areas of the board. The ADAQ7767-1 pins are laid out with analog and digital pin partitioning. It is suggested to route to the analog pins on the top layer and to use symmetrical traces for the differential inputs (INx+ and INx-). Do not connect unused differential inputs (such as, to a multiplexer); otherwise, they may degrade performance. Follow the analog layer by a ground plane, while the lower layers are used for the digital lines.

For optimum noise performance and common-mode rejection, ensure that the selected differential input (INx+ and INx-) have symmetry and equal lengths.

For the stack-up, use at least one ground plane that can be common or split between the digital and analog sections. In the case of the split plane, join the digital and analog ground planes in one place only, preferably as close as possible to the ADAQ7767-1.

If the ADAQ7767-1 is in a system where multiple devices require analog-to-digital ground connections, still make the connection at only one point: a star ground point that must be established as close as possible to the ADAQ7767-1. Ensure good connections are made to the ground plane. Avoid sharing one connection for multiple ground pins. Use individual vias or multiple vias to the ground plane for each ground pin.

Avoid running digital lines under the devices because it couples noise onto the die. Allow the analog ground plane to run under the ADAQ7767-1 to avoid noise coupling. Shield fast switching signals, like MCLK, with digital grounds to avoid radiating noise to other sections of the board and never run these fast switching signals near analog signal paths. Avoid crossover of digital and analog signals. Run traces on layers in close proximity on the PCB at right angles to each other to reduce the effect of feedthrough through the PCB.

Use as large traces as possible on the power supply lines to the IN\_LDO and VDD\_IO pins on the ADAQ7767-1 to provide low impedance paths and reduce the effect of glitches on the power supply lines. When possible, use of supply planes to make good connections between the ADAQ7767-1 supply pins and the power supplies on the PCB. Use a single via or multiple vias for each supply pin.

Decouple the REF+, REF-, AREG\_CAP, and DREG\_CAP pins to AGND or DGND with minimal parasitic inductances by placing ceramic decoupling capacitors close to (ideally right up against) these pins and connect these pins with wide, low impedance traces.

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# **REGISTER SUMMARY**

Table 36. ADAQ7767-1 Register Summary

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	R/W
0x03	CHIP_TYPE	[7:0]		RES	ERVED			CLAS	S		0x07	R
0x04	PRODUCT_ ID_L	[7:0]				PR	ODUCT_ID[7:0]				0x01	R
0x05	PRODUCT_ ID_H	[7:0]				PRO	DDUCT_ID[15:8]				0x00	R
0x06	CHIP_ GRADE	[7:0]		GF	RADE			DEVICE_RE	EVISION		0x00	R
Ox0A	SCRATCH_ PAD	[7:0]					VALUE		0x00	R/W		
0x0C	VENDOR_L	[7:0]		VID[7:0] 0x							0x56	R
0x0D	VENDOR_H	[7:0]		• •						0x04	R	
0x14	INTERFACE _FORMAT	[7:0]	LV_BOOST	EN_ SPI_ CRC	CRC_ TYPE	STATUS_ EN	CONVLEN	EN_RDY_ DOUT	RESERVED	EN_ CONT_ READ	0x00	R/W
0x15	POWER_ CLOCK	[7:0]	CLOCK				0x00	R/W				
0x16	ANALOG	[7:0]	REF_BUI	POS	REF_I	BUF_NEG	RESER	VED	LINEAR- ITY_ BOOST_ A_OFF	LINEAR- ITY_ BOOST B OFF	0x00	R/W
0x18	CONVERSIO N	[7:0]					CONV_DIAG_ SELECT		CONV_MODE		0x00	R/W
0x19	DIGITAL_ FILTER	[7:0]	EN_60HZ_ REJ				RESERVED		DEC_RATE		0x00	R/W
0x1A	SINC3_ DEC_ RATE_MSB	[7:0]	F	RESERVED			SINC3_DEC[12:8]				0x00	R/W
0x1B	SINC3_ DEC_ RATE_LSB	[7:0]				SI	NC3_DEC[7:0]				0x00	R/W
0x1C	DUTY_ CYCLE_ RATIO	[7:0]					IDLE_TIME				0x00	R/W
0x1D	SYNC_ RESET	[7:0]	SPI_START	SYNC_ OUT_ POS_ EDGE	RES	SERVED	EN_GPIO_ START	RE- SERVED	SPI_RE	SET	0x80	R/W
0x1E	GPIO_ CONTROL	[7:0]	UGPIO_EN	GPIO2_ OPEN_ DRAIN_ EN	GPIO1_ OPEN_ DRAIN_ EN	GPIO0_ OPEN_ DRAIN_ EN	GPIO3_ OP_EN	GPIO2_ OP_EN	GPIO1_ OP_EN	GPIO0_ OP_EN	0x00	R/W
0x1F	GPIO_ WRITE	[7:0]		RES	ERVED		GPIO_ WRITE_3	GPIO_ WRITE_2	GPIO_ WRITE_1	GPIO_ WRITE_ 0	0x00	R/W
0x20	GPIO_READ	[7:0]		RES	ERVED		GPIO_ READ_3	GPIO_ READ_2	GPIO_ READ_1	GPIO_ READ_0	0x00	R
0x21	OFFSET_HI	[7:0]				0	FSET[23:16]				0x00	R/W
0x22	OFFSET_ MID	[7:0]					FFSET[15:8]				0x00	R/W
0x23	OFFSET_LO	[7:0]				(	OFFSET[7:0]				0x00	R/W

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# **REGISTER SUMMARY**

Table 36. ADAQ7767-1 Register Summary (Continued)

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	R/W
0x24	GAIN_HI	[7:0]				G	AIN[23:16]				0x00	R/W
0x25	GAIN_MID	[7:0]				(	GAIN[15:8]				0x00	R/W
0x26	GAIN_LO	[7:0]					GAIN[7:0]				0x00	R/W
0x28	SPI_DIAG_ ENABLE	[7:0]		SF IG		EN_ERR_ SPI_ IGNORE	EN_ERR_SPI_ CLK_CNT	EN_ERR_ SPI_RD	EN_ERR_ SPI_WR	RE- SERVE D	0x10	R/W
0x29	ADC_DIAG_ ENABLE	[7:0]	RESEI	RVED	EN_ERR_ DLDO_ PSM	EN_ERR_ ALDO_ PSM	EN_ERR_ REF_DET	EN_ERR_ FILTER_ SATUR- ATED	EN_ERR_ FILTER_ NOT_ SETTLED	EN_ ERR_ EXT_ CLK_ QUAL0	0x07	R/W
0x2A	DIG_DIAG_ ENABLE	[7:0]		N		EN_ERR_ MEMMAP_ CRC	EN_ERR_ RAM_CRC	EN_ERR_ FUSE_CRC	RESERVED	EN_ FREQ_ COUNT	0x0D	R/W
0x2C	ADC_DATA	[23:16]				ADC_RE	AD_DATA[23:16]				0x00000	R
		[15:8]				ADC_R	EAD_DATA[15:8]				0	
		[7:0]				ADC_F	READ_DATA[7:0]					
0x2D	MASTER_ STATUS	[7:0]	MASTER_ ERROR	ADC_ ERROR	DIG_ ERROR	ERR_EXT_ CLK_QUAL	FILT_ SATURATED	FILT_NOT_ SETTLED	SPI_ERROR	POR_ FLAG	0x00	R
0x2E	SPI_DIAG_ STATUS	[7:0]	RESERVED ERR_SPI_ ERR_SPI_ ERR_SPI_ ERR_SPI_ ERR_SPI_ ERR_SPI_ CLK_CNT RD WR SPI_ CRC		0x00	R/W						
0x2F	ADC_DIAG_ STATUS	[7:0]	RESE	RVED	ERR_ DLDO_ PSM	ERR_ ALDO_ PSM	ERR_REF_DET	FILT_ SATURATE D	FILT_NOT_ SETTLED	ERR_ EXT_ CLK_ QUAL	0x00	R
0x30	DIG_DIAG_ STATUS	[7:0]		RESERVED	)	ERR_ MEMMAP_ CRC	ERR_ RAM_CRC	ERR_ FUSE_ CRC	RESER	VED	0x00	R
0x31	MCLK_ COUNTER	[7:0]				MCL	K_COUNTER				0x00	R
0x32	COEFF_ CONTROL	[7:0]	COEFF_ ACCESS_ EN	COEFF_ WRITE_ EN		COEFF_ADDR				0x00	R/W	
0x33	COEFF_ DATA	[23:16]	USER_ COEFF_ EN				COEFF_DATA[22	:16]			0x00000 0	R/W
		[15:8]		'		COE	F_DATA[15:8]					
		[7:0]				COE	FF_DATA[7:0]					1
0x34	ACCESS_ KEY	[7:0]				RESEF	RVED			KEY	0x00	R/W

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### **REGISTER DETAILS**

# **COMPONENT TYPE REGISTER**

Register: 0x03, Reset: 0x07, Name: CHIP\_TYPE

Table 37. Bit Descriptions for CHIP\_TYPE

Bits	Bit Name	Description	Reset	Access
[7:4]	RESERVED	Reserved.	0x0	R
[3:0]	CLASS	Chip Type	0x7	R
		111: Analog to digital converter.		

### **UNIQUE PRODUCT ID REGISTER**

Register: 0x04, Reset: 0x01, Name: PRODUCT\_ID\_L

Table 38. Bit Descriptions for PRODUCT\_ID\_L

Bits	Bit Name	Description	Reset	Access
[7:0]	PRODUCT_ID[7:0]	Product ID	0x1	R

Register: 0x05, Reset: 0x00, Name: PRODUCT\_ID\_H

Table 39. Bit Descriptions for PRODUCT\_ID\_H

Bits	Bit Name	Description	Reset	Access
[7:0]	PRODUCT_ID[15:8]	Product ID	0x0	R

## **DEVICE GRADE AND REVISION REGISTER**

Register: 0x06, Reset: 0x00, Name: CHIP\_GRADE

Table 40. Bit Descriptions for CHIP GRADE

Bits	Bit Name	Description	Reset	Access
[7:4]	GRADE	Device Grade	0x0	R
[3:0]	DEVICE_REVISION	Device Revision ID	0x0	R

### **USER SCRATCH PAD REGISTER**

Register: 0x0A, Reset: 0x00, Name: SCRATCH\_PAD

Table 41. Bit Descriptions for SCRATCH\_PAD

Bits	Bit Name	Description	Reset	Access
[7:0]	VALUE	Scratch Pad. Read and write area communication and POR check.	0x0	R/W

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### **REGISTER DETAILS**

# **DEVICE VENDOR ID REGISTER**

Register: 0x0C, Reset: 0x56, Name: VENDOR\_L

Table 42. Bit Descriptions for VENDOR\_L

Bits	Bit Name	Description	Reset	Access
[7:0]	VID[7:0]	Vendor ID	0x56	R

Register: 0x0D, Reset: 0x04, Name: VENDOR\_H

Table 43. Bit Descriptions for VENDOR\_H

Bits	Bit Name	Description	Reset	Access
[7:0]	VID[15:8]	Vendor ID	0x4	R

# **INTERFACE FORMAT CONTROL REGISTER**

Register: 0x14, Reset: 0x00, Name: INTERFACE\_FORMAT

Table 44. Bit Descriptions for INTERFACE\_FORMAT

Bits	Bit Name	Description	Reset	Access
7	LV_BOOST	Boosts drive strength of SPI output for use with IOVDD levels of 1.8 V, or when a high capacitive load is present on the DOUT/RDY pin. The default state is LV_BOOST enabled when in PIN control mode.	0x0	R/W
		0: disables LV_BOOST.		
		1: enables LV_BOOST. Re-enable this bit following an exit from the continuous read mode, if applicable.		
	EN_SPI_CRC	Activates CRC on all SPI transactions.	0x0	R/W
		0: disable CRC function on all SPI transfers.		
		1: enable CRC function on all SPI transfers.		
	CRC_TYPE	Selects CRC method as XOR or 8-bit polynomial.	0x0	R/W
		1: XOR instead of CRC (applied to read transactions only).		
		0: CRC bits are based on CRC-8 polynomial.		
4	STATUS_EN	Enables output of the status bits. In SPI control mode, the status bits can be output after the ADC conversion result by setting the bits in this bit field. In PIN control mode, the status bits are output after the ADC conversion result.	0x0	R/W
		0: disable outputting status bits after ADC result in the continuous read mode.		
		1: output status bits after ADC result in the continuous read mode.		
	CONVLEN	Conversion Result Output Length.	0x0	R/W
		0: outputs full 24 bits.		
		1: outputs only 16 MSB of the ADC result.		
2	EN_RDY_DOUT	Enables RDY signal on DOUT/RDY pin. Enables RDY indicator on DOUT/RDY pin in continuous read mode. By default, the DOUT/RDY pin does not signal when new ADC conversion data is ready. Setting this bit causes DOUT/RDY to signal the availability of ADC conversion data.	0x0	R/W
		0: disables $\overline{RDY}$ function on DOUT/ $\overline{RDY}$ pin in the continuous read mode after result is clocked out.		
		1: enables RDY function on DOUT/RDY pin in continuous read mode after result is clocked out.		
1	RESERVED	Reserved.	0x0	R
	EN_CONT_READ	Continuous Read Enable Bit.	0x0	R/W
		0: disables continuous read mode.		
		1: enables continuous read mode.		

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# **REGISTER DETAILS**

# POWER AND CLOCK CONTROL REGISTER

Register: 0x15, Reset: 0x00, Name: POWER\_CLOCK

Table 45. Bit Descriptions for POWER\_CLOCK

Bits	Bit Name	Description	Reset	Access
[7:6]	CLOCK_SEL	Options for setting the clock used by the device.	0x0	R/W
		00: CMOS clock on XTAL2_MCLK.		
		01: external crystal oscillator.		
		10: LVDS input enable (exclusive to SPI control mode).		
		11: Internal coarse RC clock (diagnostics).		
[5:4]	MCLK_DIV	Sets the division of the MCLK to create the ADC modulator frequency f <sub>MOD</sub> .	0x0	R/W
		00: modulator CLK is equal to controller clock divided by 16.		
		01: modulator CLK is equal to controller clock divided by 8.		
		10: modulator CLK is equal to controller clock divided by 4.		
		11: modulator CLK is equal to controller clock divided by 2.		
3	ADC_POWER_ DOWN	Places ADC into a power-down state. All blocks including the SPI are powered down. The standard SPI is not active in this state. Power-down is the lowest power consumption mode. To enter power-down mode, write 0x08 to this register. If the user attempts to set Bit 3 while also setting other bits in this register, the SPI write command is ignored, the device does not enter power-down, and the other bits are not set. Power-down mode can be exited in three ways: by a reset using the RESET pin, by issuing the SPI resume command over SDI and SCLK, or by using the power cycle of the device.	0x0	R/W
2	RESERVED	Reserved.	0x0	R/W
[1:0]	ADC_MODE	Sets the operation mode of the ADC core. This setting in conjunction with MCLK_DIV creates the conditions for power scaling the ADC vs. input bandwidth and throughput.	0x0	R/W
		00: low power mode.		
		01: median power mode.		
		11: fast power mode.		

# **ANALOG BUFFER CONTROL REGISTER**

Register: 0x16, Reset: 0x00, Name: ANALOG

Table 46. Bit Descriptions for ANALOG

Bits	Bit Name	Description	Reset	Access
[7:6]	REF_BUF_POS	Buffering Options for the Reference Positive Input.	0x0	R/W
		00: precharge reference buffer on.		
		01: unbuffered reference input.		
		10: full reference buffer on.		
[5:4]	REF_BUF_NEG	Buffering Options for the Reference Negative Input.	0x0	R/W
		00: precharge reference buffer on.		
		01: unbuffered input.		
		10: full reference buffer on.		
[3:2]	RESERVED	Reserved.	0x0	R
1	LINEARITY_BOOST_A_OFF	Linearity Boost Buffer A Disable Control. Setting this bit disables Linearity Boost Buffer A. Use in conjunction with LINEARITY_BOOST_B_OFF.	0x0	R/W
		0: Linearity Boost Buffer A enabled.		
		1: Linearity Boost Buffer A disabled.		
0	LINEARITY_BOOST_B_OFF	Linearity Boost Buffer B Disable Control. Setting this bit disables Linearity Boost Buffer B. Use in conjunction with LINEARITY_BOOST_A_OFF.	0x0	R/W
		0: Linearity Boost Buffer B enabled.		
		1: Linearity Boost Buffer B disabled.		

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### **REGISTER DETAILS**

# **CONVERSION SOURCE SELECT AND MODE CONTROL REGISTER**

Register: 0x18, Reset: 0x00, Name: CONVERSION

Table 47. Bit Descriptions for CONVERSION

Bits	Bit Name	Description	Reset	Access
7:4]	DIAG_MUX_SELECT	Selects which signal to route through diagnostic mux. Perform diagnostic checks in low-power mode only.	0x0	R/W
		0000: temperature sensor.		
		1000: ADC input short (zero check).		
		1001: positive full scale.		
		1010: negative full scale.		
3	CONV_DIAG_SELECT	Selects the input of ADC for conversion as normal or diagnostic mux.	0x0	R/W
		0: converting signal through the normal signal chain.		
		1: ADC converting (and turning on) diagnostic subblocks.		
[2:0]	CONV MODE	Sets the conversion mode of the ADC.	0x0	R/W
-	_	000: continuous conversion mode. The modulator is converting continuously. A continuous $\overline{DRDY}$ pulse for every filter conversion.		
		001: continuous one-shot mode. One shot mode is the method of using the SYNC_IN time to start a conversion. It is similar to a conversion start signal when using the one-shot mode. The ADC modulator is continuously running while waiting on a SYNC_IN rising edge. On release of a pulse (low to high transition) to the SYNC_IN pin, a new conversion begins, converting and integrating over the settling time of the filter selected. DRDY toggles when the conversion completes, indicating it is available for readback over the SPI.		
		010: single-conversion standby mode. In single-conversion standby mode, the ADC runs one conversion with the selected filter, sampling and integrating over the full settling time of the filter before providing a single conversion result. After the conversion is complete, the ADC goes into standby. Initiating another single conversion from standby means that there is a start-up time to come out of standby before the ADC begins converting to produce the single conversion. This mode is recommended for use in the low-power mode.		
		011: duty cycled conversion standby mode. Low-power periodic conversion is a method of setting the single conversion to run in a timed loop. A separate register sets the ratio for the time spent in standby vs. converting. The ADC automatically comes out of standby periodically, performs a single conversion, and then returns to standby without the need to initiate the single conversion over the SPI.		
		100: standby.		
		101: standby.		
		110: standby.		
		111: standby.		

# **DIGITAL FILTER AND DECIMATION CONTROL REGISTER**

Register: 0x19, Reset: 0x00, Name: DIGITAL\_FILTER

Table 48. Bit Descriptions for DIGITAL FILTER

Bits	Bit Name	Description	Reset	Access
7	EN_60HZ_REJ	For use with sinc3 filter only. First, program the sinc3 filter to output at 50 Hz. Subsequently selecting the EN_60HZ_REJ bit allows one zero of the a sinc3 filter to fall at 60 Hz. This bit only enables rejection of both 50 Hz and 60 Hz if it is set in combination with programming the sinc3 filter for 50 Hz ODR.	0x0	R/W
		0: sinc3 filter optimized for single frequency rejection: 50 Hz or 60 Hz.		
		1: filter operation is modified to allow both 50 Hz and 60 Hz rejection.		
6:4]	FILTER	Selects the style of filter for use.	0x0	R/W
		000: sinc5 filter. Decimate ×32 to ×1024. Use DEC_RATE bits to select one of six available decimation rates from ×32 to ×1024.		
		001: sinc5 filter. Decimate ×8 only. Enables a maximum data rate of 1 MHz. This path allows viewing of a wider bandwidth. However, it is quantization noise limited; therefore, output data is reduced to 16 bits.		

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### **REGISTER DETAILS**

Table 48. Bit Descriptions for DIGITAL FILTER (Continued)

Bits	Bit Name	Description	Reset	Access
		010: sinc5 filter. Decimate ×16 only. Enables a maximum data rate of 512 kHz. This path allows viewing of a wider bandwidth.		
		011: sinc3 filter. Programmable decimation rate. Decimation rate is selected via the SINC3_DEC bits in the sinc3 decimation rate MSB and LSB registers (Register 0x1A and Register 0x1B). The sinc3 filter can be tuned to reject 50 Hz or 60 Hz. With the EN_60HZ_REJ bit set, it can allow rejection of both 50 Hz and 60 Hz when used with a 16.384 MHz MCLK.		
		100: wideband low ripple filter. FIR filter with low ripple pass band and sharp transition band. Use the DEC_RATE bits to select one of six available decimation rates from ×32 to ×1024.		
3	RESERVED	Reserved.	0x0	R
2:0]	DEC_RATE	Selects the decimation rate for the sinc5 filter and the wideband low ripple FIR filter.	0x0	R/W
		000: Decimate ×32.		
		001: Decimate ×64.		
		010: Decimate ×128.		
		011: Decimate ×256.		
		100: Decimate ×512.		
		101: Decimate ×1024.		
		110: Decimate ×1024.		
		111: Decimate ×1024.		

# SINC3 DECIMATION RATE (MSB) REGISTER

Register: 0x1A, Reset: 0x00, Name: SINC3\_DEC\_RATE\_MSB

Table 49. Bit Descriptions for SINC3\_DEC\_RATE\_MSB

Bits	Bit Name	Description	Reset	Access
[7:5]	RESERVED	Reserved.	0x0	R
[4:0]	SINC3_DEC[12:8]	Determines the decimation rate of used with the sinc3 filter. Value entered is incremented by 1 and multiplied by 32 to give actual decimation rate.	0x0	R/W

# SINC3 DECIMATION RATE (LSB) REGISTER

Register: 0x1B, Reset: 0x00, Name: SINC3\_DEC\_RATE\_LSB

Table 50. Bit Descriptions for SINC3\_DEC\_RATE\_LSB

Bits	Bit Name	Description	Reset	Access
[7:0]	SINC3_DEC[7:0]	Determines the decimation rate of used with the sinc3 filter. Value entered is incremented by 1 and multiplied by 32 to give actual decimation rate.	0x0	R/W

# PERIODIC CONVERSION RATE CONTROL REGISTER

Register: 0x1C, Reset: 0x00, Name: DUTY\_CYCLE\_RATIO

Table 51. Bit Descriptions for DUTY\_CYCLE\_RATIO

Description	Reset	Access
Sets idle time for periodic conversion when in standby. A 1 in this register corresponds to the time for one output from	0x0	R/W
	2000, p. 100	Sets idle time for periodic conversion when in standby. A 1 in this register corresponds to the time for one output from 0x0

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### **REGISTER DETAILS**

# SYNCHRONIZATION MODES AND RESET TRIGGERING REGISTER

Register: 0x1D, Reset: 0x80, Name: SYNC\_RESET

Table 52. Bit Descriptions for SYNC\_RESET

Bits	Bit Name	Description	Reset	Access
7	SPI_START	Triggers START signal. Initiates a SYNC_OUT pulse over the SPI. Setting this bit low drives a low pulse through SYNC_OUT, which can be used as a SYNC_IN signal to the same device and other ADAQ7767-1 devices where synchronized sampling is required. This bit clears itself after use.	0x1	R
6	SYNC_OUT_POS_EDGE	SYNC_OUT drive edge selected. Setting this bit causes SYNC_OUT to be driven low by the positive edge of MCLK. Device default is that SYNC_OUT is driven low on the negative edge of MCLK.	0x0	R/W
[5:4]	RESERVED	Reserved.	0x0	R
3	EN_GPIO_START	Enables START function on the GPIO input. Allows to use one of the GPIO pins as a START input pin. When enabled, a low pulse on the START input generates a low pulse through SYNC_OUT that can be used as a SYNC_IN signal to the same device and other ADAQ7767-1 devices where synchronized sampling is required. When enabled, GPIO3 becomes the START input. While the START function is enabled, the GPIO pins cannot be used for general-purpose input and output reading and writing. The remaining GPIOs are set to outputs.  0: disables.  1: enables.	0x0	R/W
2	RESERVED	Reserved.	0x0	R
[1:0]	SPI_RESET	Enables device reset over the SPI. Two writes to these bits are required to initiate the reset. First, set the bits to 11, then set the bits to 10. Once this sequence is detected on these two bits, the reset occurs. It is not dependent on other bits in this register being set or cleared.	0x0	R/W

# **GPIO PORT CONTROL REGISTER**

Register: 0x1E, Reset: 0x00, Name: GPIO\_CONTROL

Table 53. Bit Descriptions for GPIO CONTROL

Bits	Bit Name	Description	Reset	Acces
7	UGPIO_EN	Universal Enabling of GPIO Pins. This bit must be set high to change the GPIO settings.	0x0	R/W
ô	GPIO2_OPEN_DRAIN_EN	Change GPIO2 output from strong driver to open drain.	0x0	R/W
5	GPIO1_OPEN_DRAIN_EN	Change GPIO1 output from strong driver to open drain.	0x0	R/W
1	GPIO0_OPEN_DRAIN_EN	Change GPIO0 output from strong driver to open drain.	0x0	R/W
3	GPIO3_OP_EN	Output Enable for GPIO3 Pin.	0x0	R/W
		0: input.		
		1: output.		
2	GPIO2_OP_EN	Output Enable for GPIO2 Pin.	0x0	R/W
		0: input.	0x0	
		1: output.		
	GPIO1_OP_EN	Output Enable for GPIO1 Pin.	0x0	R/W
		0: input.		
		1: output.		
)	GPIO0_OP_EN	Output Enable for GPIO0 Pin.	0x0	R/W
		0: input.		
		1: output.		

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### **REGISTER DETAILS**

# **GPIO OUTPUT CONTROL REGISTER**

Register: 0x1F, Reset: 0x00, Name: GPIO\_WRITE

Table 54. Bit Descriptions for GPIO\_WRITE

Bits	Bit Name	Description	Reset	Access
[7:4]	RESERVED	Reserved.	0x0	R
3	GPIO_WRITE_3	Write to this bit to set GPIO3 high.	0x0	R/W
2	GPIO_WRITE_2	Write to this bit to set GPIO2 high.	0x0	R/W
1	GPIO_WRITE_1	Write to this bit to set GPIO1 high.	0x0	R/W
0	GPIO_WRITE_0	Write to this bit to set GPIO0 high.	0x0	R/W

# **GPIO INPUT READ REGISTER**

Register: 0x20, Reset: 0x00, Name: GPIO\_READ

Table 55. Bit Descriptions for GPIO\_READ

Bits	Bit Name	Description	Reset	Access
[7:4]	RESERVED	Reserved.	0x0	R
3	GPIO_READ_3	Read the value from GPIO3.	0x0	R
2	GPIO_READ_2	Read the value from GPIO2.	0x0	R
1	GPIO_READ_1	Read the value from GPIO1.	0x0	R
0	GPIO_READ_0	Read the value from GPIO0.	0x0	R

# **OFFSET CALIBRATION MSB REGISTER**

Register: 0x21, Reset: 0x00, Name: OFFSET\_HI

Table 56. Bit Descriptions for OFFSET\_HI

Bits	Bit Name	Description	Reset	Access
[7:0]	OFFSET[23:16]	User Offset Calibration Coefficient. The offset correction registers provide 24-bit, signed, twos-complement registers for channel offset adjustment. If the channel gain setting is at its ideal nominal value of 0x555555, an LSB of the offset register adjustment changes the digital output by -4/3 LSBs. For example, changing the offset register from 0 to 100 changes the digital output by -133 LSBs. The user offset calibration coefficient correction is applied to the digital filter output data before the gain calibration correction; therefore, the previous ratio changes linearly with any gain adjustment applied via the gain calibration registers.	0x0	R/W

# **OFFSET CALIBRATION MID REGISTER**

Register: 0x22, Reset: 0x00, Name: OFFSET\_MID

Table 57. Bit Descriptions for OFFSET MID

Bits	Bit Name	Description	Reset	Access
[7:0]	OFFSET[15:8]	User Offset Calibration Coefficient. The offset correction registers provide 24-bit, signed, twos-complement registers for channel offset adjustment. If the channel gain setting is at its ideal nominal value of 0x555555, an LSB of offset register adjustment changes the digital output by -4/3 LSBs. For example, changing the offset register from 0 to 100 changes the digital output by -133 LSBs. The user offset calibration coefficient correction is applied to the digital filter output data before the gain calibration correction; therefore, the previous ratio changes linearly with any gain adjustment applied via the gain calibration registers.	0x0	R/W

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### **REGISTER DETAILS**

### **OFFSET CALIBRATION LSB REGISTER**

Register: 0x23, Reset: 0x00, Name: OFFSET\_LO

Table 58. Bit Descriptions for OFFSET\_LO

Bits	Bit Name	Description	Reset	Access
[7:0]	OFFSET[7:0]	User Offset Calibration Coefficient. The offset correction registers provide 24-bit, signed, twos-complement registers for channel offset adjustment. If the channel gain setting is at its ideal nominal value of 0x555555, an LSB of offset register adjustment changes the digital output by -4/3 LSBs. For example, changing the offset register from 0 to 100 changes the digital output by -133 LSBs. The user offset calibration coefficient correction is applied to the digital filter output data before the gain calibration correction; therefore, the previous ratio changes linearly with any gain adjustment applied via the gain calibration registers.	0x0	R/W

### **GAIN CALIBRATION MSB REGISTER**

Register: 0x24, Reset: 0x00, Name: GAIN\_HI

Table 59. Bit Descriptions for GAIN\_HI

Bits	Bit Name	Description	Reset	Access
[7:0]	GAIN[23:16]	User Gain Calibration Coefficient. The ADC has an associated factory programmed gain calibration coefficient. The coefficient is stored in the ADC during factory programming, and the nominal value is around 0x555555. The user can read back the factory programmed value and can overwrite the gain register setting to apply their own calibration coefficient. The user offset calibration coefficient correction is applied to the digital filter output data before the gain calibration correction.	0x0	R/W

# **GAIN CALIBRATION MID REGISTER**

Register: 0x25, Reset: 0x00, Name: GAIN\_MID

Table 60. Bit Descriptions for GAIN MID

Bits	Bit Name	Description	Reset	Access
[7:0]	GAIN[15:8]			R/W

# **GAIN CALIBRATION LSB REGISTER**

Register: 0x26, Reset: 0x00, Name: GAIN\_LO

Table 61. Bit Descriptions for GAIN\_LO

Bits	Bit Name	Description	Reset	Access
[7:0]	GAIN[7:0]	User Gain Calibration Coefficient. The ADC has an associated factory programmed gain calibration coefficient. The coefficient is stored in the ADC during factory programming, and the nominal value is around 0x555555. The user can read back the factory programmed value and can overwrite the gain register setting to apply their own calibration coefficient. The user offset calibration coefficient correction is applied to the digital filter output data before the gain calibration correction.	0x0	R/W

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### **REGISTER DETAILS**

### SPI DIAGNOSTIC CONTROL REGISTER

Register: 0x28, Reset: 0x10, Name: SPI\_DIAG\_ENABLE

Table 62. Bit Descriptions for SPI\_DIAG\_ENABLE

Bits	Bit Name	Description	Reset	Access
[7:5]	RESERVED	Reserved.	0x0	R
4	EN_ERR_SPI_IGNORE	SPI Ignore Error Enable.	0x1	R/W
3	EN_ERR_SPI_CLK_CNT	SPI Clock Count Error Enable. The SPI clock count error is only valid for SPI transactions that use $\overline{\text{CS}}$ .	0x0	R/W
2	EN_ERR_SPI_RD	SPI Read Error Enable.	0x0	R/W
1	EN_ERR_SPI_WR	SPI Write Error Enable.	0x0	R/W
0	RESERVED	Reserved.	0x0	R

### ADC DIAGNOSTIC FEATURE CONTROL REGISTER

Register: 0x29, Reset: 0x07, Name: ADC\_DIAG\_ENABLE

Table 63. Bit Descriptions for ADC\_DIAG\_ENABLE

Bits	Bit Name	Description	Reset	Access
[7:6]	RESERVED	Reserved.	0x0	R
5	EN_ERR_DLDO_PSM	Digital LDO Power Saving Mode (PSM) Error Enable.	0x0	R/W
4	EN_ERR_ALDO_PSM	Analog LDO PSM Error Enable.	0x0	R/W
3	EN_ERR_REF_DET	Reference Detection Error Enable.	0x0	R/W
2	EN_ERR_FILTER_SATURATED	Filter Saturated Error Enable.	0x1	R/W
1	EN_ERR_FILTER_NOT_SETTLED	Filter Not Settled Error Enable.	0x1	R/W
0	EN_ERR_EXT_CLK_QUAL	Enables qualification check on the external clock.	0x1	R/W

# DIGITAL DIAGNOSTIC FEATURE CONTROL REGISTER

Register: 0x2A, Reset: 0x0D, Name: DIG\_DIAG\_ENABLE

Table 64. Bit Descriptions for DIG\_DIAG\_ENABLE

Bits	Bit Name	Description	Reset	Access
[7:5]	RESERVED	Reserved.	0x0	R
4	EN_ERR_MEMMAP_CRC	Memory Map CRC Error Enable.	0x0	R/W
3	EN_ERR_RAM_CRC	RAM CRC Error Enable.	0x1	R/W
2	EN_ERR_FUSE_CRC	Fuse CRC Error Enable.	0x1	R/W
1	RESERVED	Reserved.	0x0	R/W
0	EN_FREQ_COUNT	Enables MCLK counter.	0x1	R/W

### **CONVERSION RESULT REGISTER**

Register: 0x2C, Reset: 0x000000, Name: ADC\_DATA

Table 65. Bit Descriptions for ADC\_DATA

Bits	Bit Name	Description	Reset	Access
[23:0]	ADC_READ_DATA	ADC Read Data.	0x0	R

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### **REGISTER DETAILS**

### **DEVICE ERROR FLAGS MAIN REGISTER**

Register: 0x2D, Reset: 0x00, Name: MASTER\_STATUS

Table 66. Bit Descriptions for MASTER\_STATUS

Bits	Bit Name	Description	Reset	Access
7	MASTER_ERROR	Any Device Error. An OR of all other errors present.	0x0	R
6	ADC_ERROR	Any ADC Error (OR).	0x0	R
5	DIG_ERROR	Any Digital Error (OR).	0x0	R
4	ERR_EXT_CLK_QUAL	No Clock Error, Applied to MASTER_STATUS Register Only.	0x0	R
3	FILT_SATURATED	Filter Saturated.	0x0	R
2	FILT_NOT_SETTLED	Filter Not Settled.	0x0	R
1	SPI_ERROR	Any SPI Error (OR).	0x0	R
0	POR_FLAG	POR Flag.	0x0	R

### **SPI ERROR REGISTER**

Register: 0x2E, Reset: 0x00, Name: SPI\_DIAG\_STATUS

Table 67. Bit Descriptions for SPI\_DIAG\_STATUS

Bits	Bit Name	Description	Reset	Access <sup>1</sup>
[7:5]	RESERVED	Reserved.	0x0	R
4	ERR_SPI_IGNORE	SPI Ignore Error.	0x0	R/W1C
3	ERR_SPI_CLK_CNT	SPI Clock Count Error.	0x0	R
2	ERR_SPI_RD	SPI Read Error.	0x0	R/W1C
1	ERR_SPI_WR	SPI Write Error.	0x0	R/W1C
0	ERR_SPI_CRC	SPI CRC Error.	0x0	R/W1C

<sup>&</sup>lt;sup>1</sup> R/W1C is read/write 1 to clear.

# **ADC DIAGNOSTICS OUTPUT REGISTER**

Register: 0x2F, Reset: 0x00, Name: ADC\_DIAG\_STATUS

Table 68. Bit Descriptions for ADC\_DIAG\_STATUS

Bits	Bit Name	Description	Reset	Access
[7:6]	RESERVED	Reserved.	0x0	R
5	ERR_DLDO_PSM	DLDO PSM Error.	0x0	R
4	ERR_ALDO_PSM	ALDO PSM Error.	0x0	R
3	ERR_REF_DET	REF DET Error.	0x0	R
2	FILT_SATURATED	Filter Saturated.	0x0	R
1	FILT_NOT_SETTLED	Filter Not Settled.	0x0	R
0	ERR_EXT_CLK_QUAL	No Clock Error, Applied to MASTER_STATUS Register Only.	0x0	R

# **DIGITAL DIAGNOSTICS OUTPUT REGISTER**

Register: 0x30, Reset: 0x00, Name: DIG\_DIAG\_STATUS

Table 69. Bit Descriptions for DIG\_DIAG\_STATUS

Bits	Bit Name	Description	Reset	Access
[7:5]	RESERVED	Reserved.	0x0	R
4	ERR_MEMMAP_CRC	Memory Map CRC Error.	0x0	R

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### **REGISTER DETAILS**

### Table 69. Bit Descriptions for DIG\_DIAG\_STATUS (Continued)

Bits	Bit Name	Description	Reset	Access
3	ERR_RAM_CRC	RAM CRC Error.	0x0	R
2	ERR_FUSE_CRC	Fuse CRC Error.	0x0	R
[1:0]	RESERVED	Reserved.	0x0	R

# MCLK DIAGNOSTIC OUTPUT REGISTER

Register: 0x31, Reset: 0x00, Name: MCLK\_COUNTER

# Table 70. Bit Descriptions for MCLK\_COUNTER

Bits	Bit Name	Description	Reset	Access
[7:0]	MCLK_COUNTER	MCLK Counter. This register increments after every 64 MCLKs.	0x0	R

## **COEFFICIENT CONTROL REGISTER**

Register: 0x32, Reset: 0x00, Name: COEFF\_CONTROL

### Table 71. Bit Descriptions for COEFF\_CONTROL

Bits	Bit Name	Description	Reset	Access
7	COEFF_ACCESS_EN	Setting this bit to a 1 allows access to the coefficient memory.	0x0	R/W
6	COEFF_WRITE_EN	Enables write to the coefficient memory. Write a 1 to enable.	0x0	R/W
[5:0]	COEFF_ADDR	Address to be accessed for the coefficient memory. The address ranges from 0 to 55 for 56 coefficients that form one symmetrical half of the 112 coefficients.	0x00	R/W

### **COEFFICIENT DATA REGISTER**

Register: 0x33, Reset: 0x00, Name: COEFF\_DATA

### Table 72. Bit Descriptions for COEFF DATA

Bits	Bit Name	Description	Reset	Access
23	USER_COEFF_EN	Setting this bit to a 1 prevents the coefficients from read only memory (ROM) over writing the user-defined coefficients after a sync toggle. A sync pulse is required after every change to the digital filter configuration, including a customized filter upload.	0x0	R/W
[22:0]	COEFF_DATA	Data read from or to be written to coefficient memory. These bits are 23 bits wide.	0x000000	R/W

# **ACCESS KEY REGISTER**

Register: 0x34, Reset: 0x00, Name: ACCESS\_KEY

### Table 73. Bit Descriptions for ACCESS\_KEY

Bits	Bit Name	Description	Reset	Access
[7:1]	RESERVED	Reserved.	0x0	R
0	KEY	A specific key must be written to the ACCESS_KEY register prior to any filter upload. If written correctly, the KEY bit reads back as 1.	0x0	R/W

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### **OUTLINE DIMENSIONS**

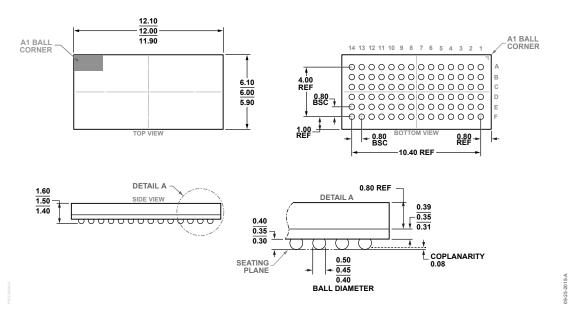


Figure 118. 84-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]
(BC-84-4)
Dimensions shown in millimeters

Updated: January 19, 2024

### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
ADAQ7767-1BBCZ	-40°C to +105°C	84-Ball CSP_BGA	BC-84-4

<sup>&</sup>lt;sup>1</sup> Z = RoHS Compliant Part.

### **EVALUATION BOARDS**

Table 74. Evaluation Boards

Model <sup>1</sup>	Description
EV-ADAQ7767-1FMC1Z	Evaluation Board

<sup>&</sup>lt;sup>1</sup> Z = RoHS-Compliant Part.



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